

### 16 MBit Synchronous DRAM (second generation)

#### Advanced Information

- High Performance:

|                                     |     |     |       |
|-------------------------------------|-----|-----|-------|
| $\overline{\text{CAS}}$ latency = 3 | -8  | -10 | Units |
| fCK                                 | 125 | 100 | MHz   |
| tCK3                                | 8   | 10  | ns    |
| tAC3                                | 7   | 8   | ns    |

- Single Pulsed  $\overline{\text{RAS}}$  Interface
- Fully Synchronous to Positive Clock Edge
- 0 to 70 °C operating temperature
- Dual Banks controlled by A11 ( Bank Select)
- Programmable  $\overline{\text{CAS}}$  Latency : 1, 2, 3
- Programmable Wrap Sequence : Sequential or Interleave
- Programmable Burst Length:  
1, 2, 4, 8 and full page for Sequential type  
1, 2, 4, 8 for Interleave Type
- Multiple Burst Read with Single Write Operation
- Automatic and Controlled Precharge Command
- Data Mask for Read / Write control (x4, x8)
- Dual Data Mask for byte control ( x16)
- Auto Refresh (CBR) and Self Refresh
- Suspend Mode and Power Down Mode
- 4096 refresh cycles / 64 ms
- Random Column Address every CLK ( 1-N Rule)
- Single 3.3V +/- 0.3V Power Supply
- LVTTL and SSTL\_3 (Class II) Interface versions
- Plastic Packages:  
P-TSOPI-44 400mil width ( x4, x8 )  
P-TSOPII -50 400 mil width ( x 16 )

The HYB39S1640x/80x/16xAT are dual bank Synchronous DRAMs based on the die revisions „B“ and „C“ and organized as 2 banks x 2MBit x4, 2 banks x 1MBit x8 and 2 banks x 512kbit x16 respectively. These synchronous devices achieve high speed data transfer rates up to 125 MHz by employing a chip architecture that prefetches multiple bits and then synchronizes the output data to a system clock. The chip is fabricated with SIEMENS'advanced 16MBit DRAM process technology. The device is designed to comply with all JEDEC standards set for synchronous DRAM products, both electrically and mechanically. All of the control, address, data input and output circuits are synchronized with the positive edge of an externally supplied clock.

Operating the two memory banks in an interleaved fashion allows random access operation to occur at higher rate than is possible with standard DRAMs. A sequential and gapless data rate of up to 125 MHz is possible depending on burst length,  $\overline{\text{CAS}}$  latency and speed grade of the device.

Auto Refresh (CBR) and Self Refresh operation are supported. These devices operate with a single 3.3V +/- 0.3V power supply and are available in TSOPII packages.

These Synchronous DRAM devices are available with either LV-TTL or SSTL-3 interfaces.

### Ordering Information

| Type                             | Ordering Code | Package              | Description                 |
|----------------------------------|---------------|----------------------|-----------------------------|
| <b>LVTTTL-version:</b>           |               |                      |                             |
| HYB 39S16400AT-8                 | Q67100-Q1333  | P-TSOPII-44 (400mil) | 125MHz 2B x 2M x 4 SDRAM    |
| HYB 39S16400AT-10                | Q67100-Q1323  | P-TSOPII-44-(400mil) | 100MHz 2B x 2M x 4 SDRAM    |
| HYB 39S16800AT-8                 | Q67100-Q1335  | P-TSOPII-44-(400mil) | 125MHz 2B x 1M x 8 SDRAM    |
| HYB 39S16800AT-10                | Q67100-Q1327  | P-TSOPII-44 (400mil) | 100MHz 2B x 1M x 8 SDRAM    |
| HYB 39S16160AT-8                 | Q67100-Q1337  | P-TSOPII-50 (400mil) | 125MHz 2B x 512k x 16 SDRAM |
| HYB 39S16160AT-10                | Q67100-Q1331  | P-TSOPII-50-(400mil) | 100MHz 2B x 512k x 16 SDRAM |
| <b>SSTL (Class II) -version:</b> |               |                      |                             |
| HYB 39S16402T-8                  | Q67100-Q1277  | P-TSOPII-44 (400mil) | 125MHz 2B x 2M x 4 SDRAM    |
| HYB 39S16402AT-10                | Q67100-Q1283  | P-TSOPII-44 (400mil) | 100MHz 2B x 2M x 4 SDRAM    |
| HYB 39S16802AT-8                 | Q67100-Q1279  | P-TSOPII-44 (400mil) | 125MHz 2B x 1M x 8 SDRAM    |
| HYB 39S16802AT-10                | Q67100-Q1284  | P-TSOPII-44 (400mil) | 100MHz 2B x 1M x 8 SDRAM    |
| HYB 39S16162AT-8                 | Q67100-Q1280  | P-TSOPII-50 (400mil) | 125MHz 2B x 512k x 16 SDRAM |
| HYB 39S16162AT-10                | Q67100-Q1286  | P-TSOPII-50 (400mil) | 100MHz 2B x 512k x 16 SDRAM |

### Pin Description and Pinouts:

|                                           |                       |                        |                                       |
|-------------------------------------------|-----------------------|------------------------|---------------------------------------|
| <b>CLK</b>                                | Clock Input           | <b>DQ</b>              | Data Input /Output                    |
| <b>CKE</b>                                | Clock Enable          | <b>DQM, LDQM, UDQM</b> | Data Mask                             |
| <b><math>\overline{\text{CS}}</math></b>  | Chip Select           | <b>Vdd</b>             | Power (+3.3V)                         |
| <b><math>\overline{\text{RAS}}</math></b> | Row Address Strobe    | <b>Vss</b>             | Ground                                |
| <b><math>\overline{\text{CAS}}</math></b> | Column Address Strobe | <b>Vddq</b>            | Power for DQs (+ 3.3V)                |
| <b><math>\overline{\text{WE}}</math></b>  | Write Enable          | <b>Vssq</b>            | Ground for DQs                        |
| <b>A0-A10</b>                             | Address Inputs        | <b>NC</b>              | not connected                         |
| <b>A11 (BS)</b>                           | Bank Select           | <b>Vref</b>            | Reference Voltage (SSTL version only) |

|            |    |    |            |
|------------|----|----|------------|
| Vdd        | 1  | 44 | Vss        |
| NC         | 2  | 43 | NC         |
| Vssq       | 3  | 42 | Vssq       |
| DQ0        | 4  | 41 | DQ3        |
| Vddq       | 5  | 40 | Vddq       |
| NC         | 6  | 39 | NC         |
| Vssq       | 7  | 38 | Vssq       |
| DQ1        | 8  | 37 | DQ2        |
| Vddq       | 9  | 36 | Vddq       |
| NC         | 10 | 35 | NC/Vref *) |
| NC         | 11 | 34 | NC         |
| <u>WE</u>  | 12 | 33 | DQM        |
| <u>CAS</u> | 13 | 32 | CLK        |
| <u>RAS</u> | 14 | 31 | CKE        |
| <u>CS</u>  | 15 | 30 | NC         |
| A11        | 16 | 29 | A9         |
| A10        | 17 | 28 | A8         |
| A0         | 18 | 27 | A7         |
| A1         | 19 | 26 | A6         |
| A2         | 20 | 25 | A5         |
| A3         | 21 | 24 | A4         |
| Vdd        | 22 | 23 | Vss        |

**HYB39S16400AT / HYB39S16402AT**  
2 Bank x 2MBit x 4  
TSOPII-44  
( 400 mil x 725 mil )

|            |    |    |          |
|------------|----|----|----------|
| Vdd        | 1  | 44 | Vss      |
| DQ0        | 2  | 43 | DQ7      |
| Vssq       | 3  | 42 | Vssq     |
| DQ1        | 4  | 41 | DQ6      |
| Vddq       | 5  | 40 | Vddq     |
| DQ2        | 6  | 39 | DQ5      |
| Vssq       | 7  | 38 | Vssq     |
| DQ3        | 8  | 37 | DQ4      |
| Vddq       | 9  | 36 | Vddq     |
| NC         | 10 | 35 | NC/Vref* |
| NC         | 11 | 34 | NC       |
| <u>WE</u>  | 12 | 33 | DQM      |
| <u>CAS</u> | 13 | 32 | CLK      |
| <u>RAS</u> | 14 | 31 | CKE      |
| <u>CS</u>  | 15 | 30 | NC       |
| A11        | 16 | 29 | A9       |
| A10        | 17 | 28 | A8       |
| A0         | 18 | 27 | A7       |
| A1         | 19 | 26 | A6       |
| A2         | 20 | 25 | A5       |
| A3         | 21 | 24 | A4       |
| Vdd        | 22 | 23 | Vss      |

**HYB39S16800AT / HYB39S16802AT**  
2 Bank x 1MBit x 8  
TSOPII-44  
( 400 mil x 725 mil )

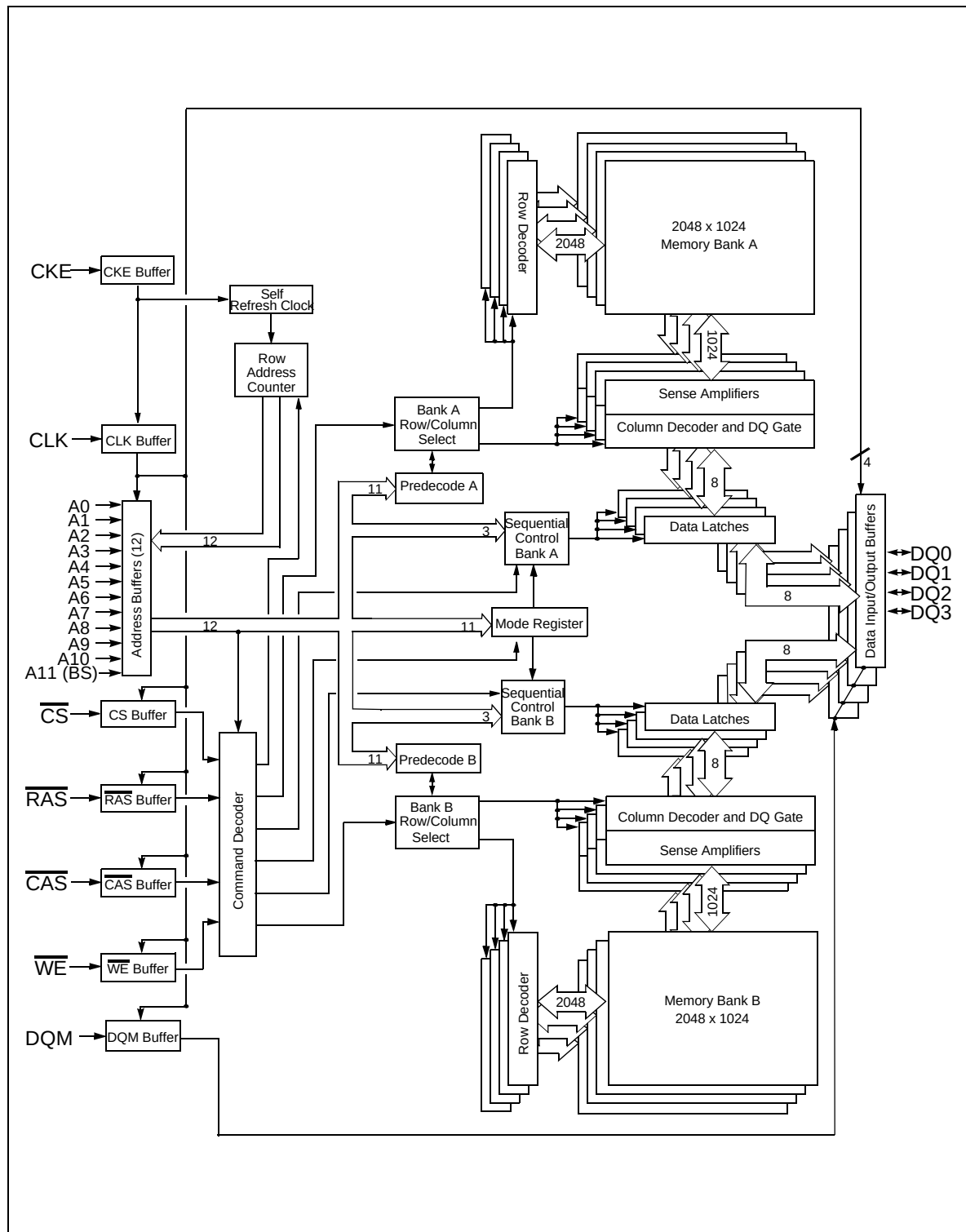
|            |    |    |              |
|------------|----|----|--------------|
| Vdd        | 1  | 50 | Vss          |
| DQ0        | 2  | 49 | DQ15         |
| DQ1        | 3  | 48 | DQ14         |
| Vssq       | 4  | 47 | Vssq         |
| DQ2        | 5  | 46 | DQ13         |
| DQ3        | 6  | 45 | DQ12         |
| Vddq       | 7  | 44 | Vddq         |
| DQ4        | 8  | 43 | DQ11         |
| DQ5        | 9  | 42 | DQ10         |
| Vssq       | 10 | 41 | Vssq         |
| DQ6        | 11 | 40 | DQ9          |
| DQ7        | 12 | 39 | DQ8          |
| Vddq       | 13 | 38 | Vddq         |
| LDQM       | 14 | 37 | NC / Vref *) |
| <u>WE</u>  | 15 | 36 | UDQM         |
| <u>CAS</u> | 16 | 35 | CLK          |
| <u>RAS</u> | 17 | 34 | CKE          |
| <u>CS</u>  | 18 | 33 | NC           |
| A11        | 19 | 32 | A9           |
| A10        | 20 | 31 | A8           |
| A0         | 21 | 30 | A7           |
| A1         | 22 | 29 | A6           |
| A2         | 23 | 28 | A5           |
| A3         | 24 | 27 | A4           |
| Vdd        | 25 | 26 | Vss          |

**HYB39S16160AT / HYB39S16162AT**  
2 Bank x 512kbit x 16  
TSOPII-50  
( 400 mil x 825 mil )

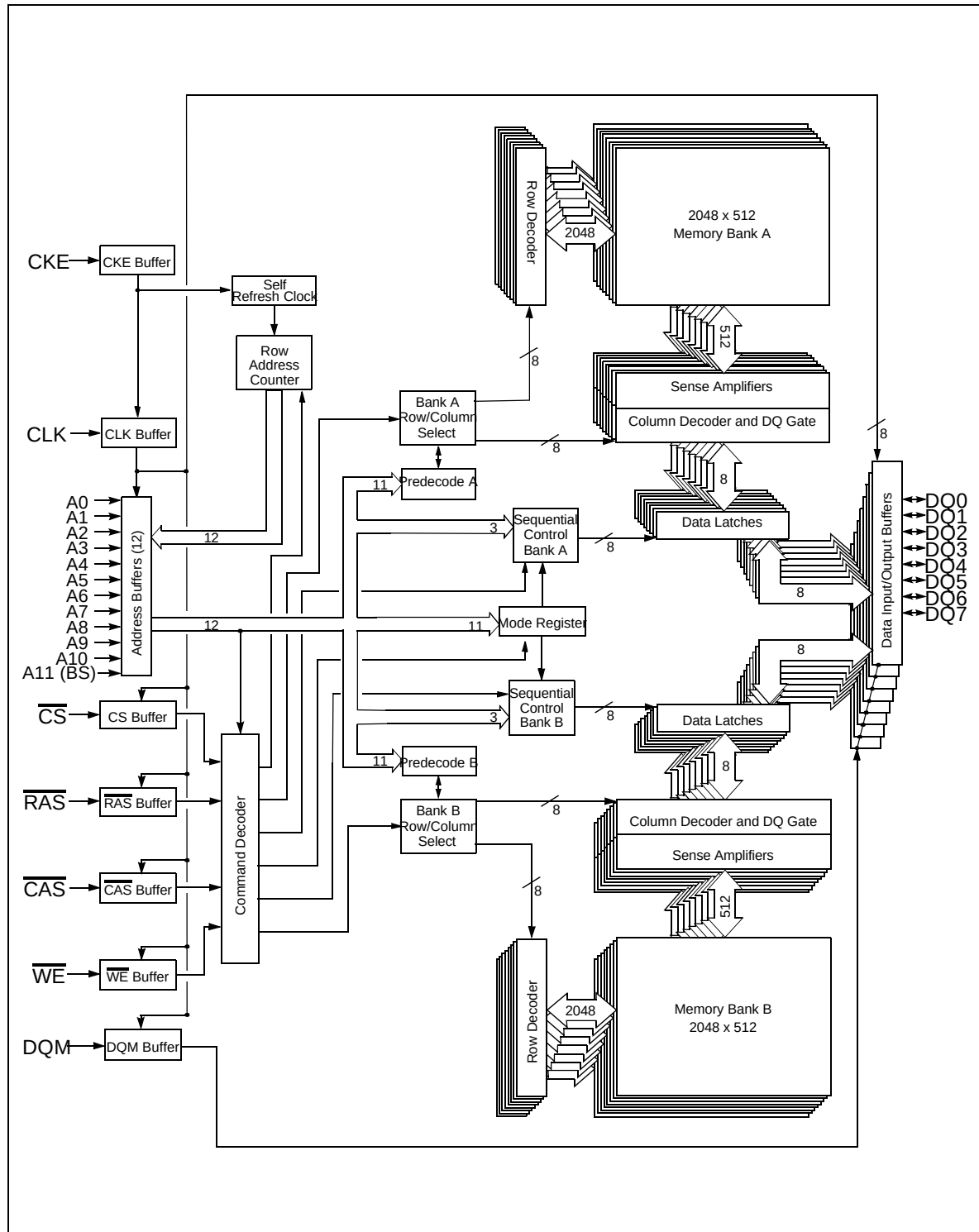
\*) This pin is NC for the LV-TTL versions and Vref for the SSTL versions

### Signal Pin Description

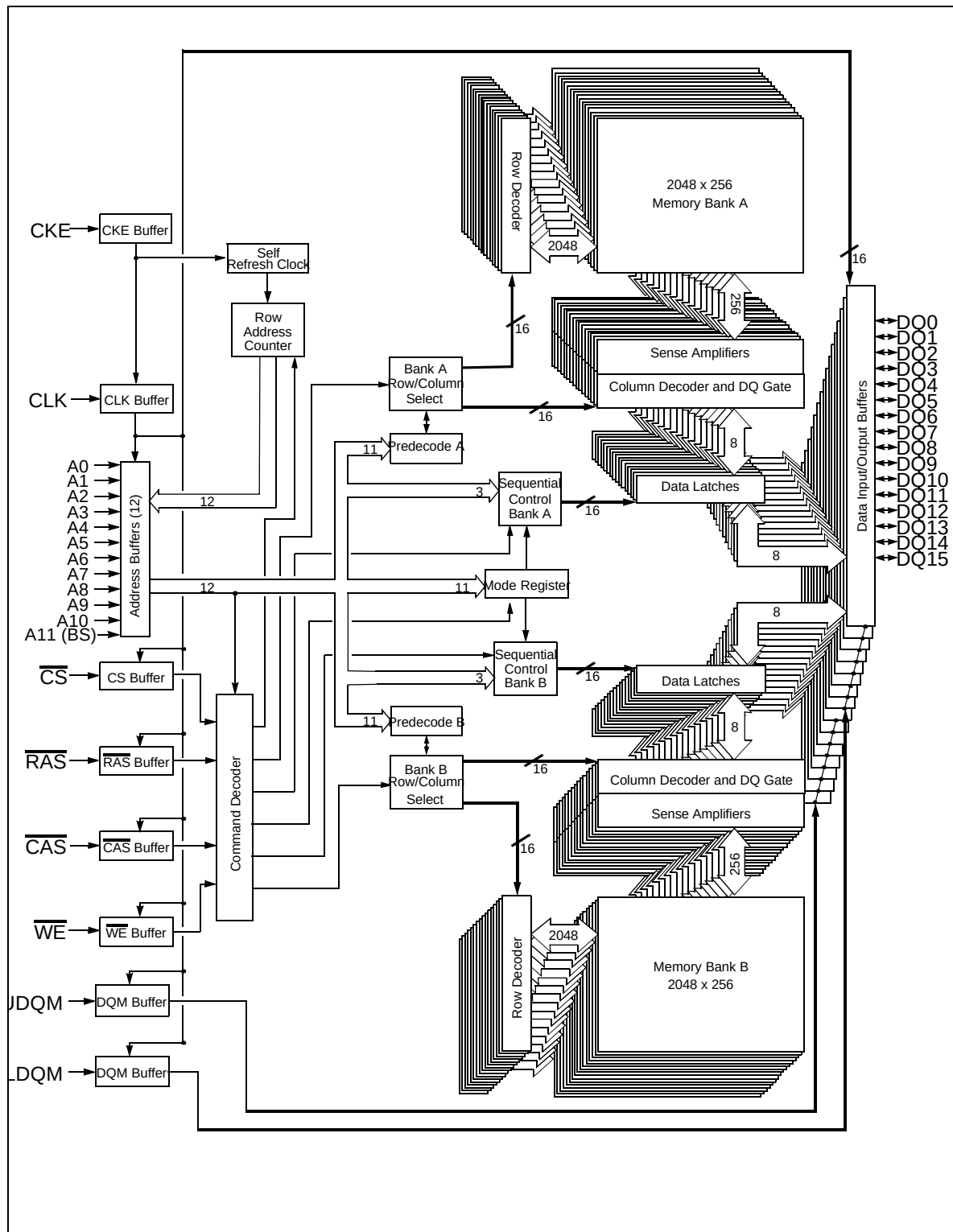
| Pin                                                         | Type         | Signal | Polarity      | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-------------------------------------------------------------|--------------|--------|---------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CLK                                                         | Input        | Pulse  | Positive Edge | The system clock input. All of the SDRAM inputs are sampled on the rising edge of the clock.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| CKE                                                         | Input        | Level  | Active High   | Activates the CLK signal when high and deactivates the CLK signal when low, thereby initiates either the Power Down mode, Suspend mode or the Self Refresh mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| $\overline{CS}$                                             | Input        | Pulse  | Active Low    | $\overline{CS}$ enables the command decoder when low and disables the command decoder when high. When the command decoder is disabled, new commands are ignored but previous operations continue.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| $\overline{RAS}$ ,<br>$\overline{CAS}$ ,<br>$\overline{WE}$ | Input        | Pulse  | Active Low    | When sampled at the positive rising edge of the clock, $\overline{CAS}$ , $\overline{RAS}$ , and $\overline{WE}$ define the command to be executed by the SDRAM.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| A0 - A10                                                    | Input        | Level  | —             | <p>During a Bank Activate command cycle, A0-A10 defines the row address (RA0-RA10) when sampled at the rising clock edge.</p> <p>During a Read or Write command cycle, A0-A9 defines the column address (CA0-CAn) when sampled at the rising clock edge. CAn depends from the SDRAM organisation.</p> <p>4M x 4 SDRAM CAn = CA9<br/>2M x 8 SDRAM CAn = CA8<br/>1M x 16 SDRAM CAn = CA7</p> <p>In addition to the column address, A10 is used to invoke autoprecharge operation at the end of the burst read or write cycle. If A10 is high, autoprecharge is selected and A11 defines the bank to be precharged (low=bank A, high=bank B). If A10 is low, autoprecharge is disabled.</p> <p>During a Precharge command cycle, A10 is used in conjunction with A11 to control which bank(s) to precharge. If A10 is high, both bank A and bank B will be precharged regardless of the state of A11. If A10 is low, then A11 is used to define which bank to precharge.</p> |
| A11 (BS)                                                    | Input        | Level  | —             | Selects which bank is to be active. A11 low selects bank A and A11 high selects bank B.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| DQx                                                         | Input Output | Level  | —             | Data Input/Output pins operate in the same manner as on conventional DRAMs.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| DQM<br>LDQM<br>UDQM                                         | Input        | Pulse  | Active High   | The Data Input/Output mask places the DQ buffers in a high impedance state when sampled high. In Read mode, DQM has a latency of two clock cycles and controls the output buffers like an output enable. In Write mode, DQM has a latency of zero and operates as a word mask by allowing input data to be written if it is low but blocks the write operation if DQM is high.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| VDD,<br>VSS                                                 | Supply       |        |               | Power and ground for the input buffers and the core logic.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| VDDQ<br>VSSQ                                                | Supply       | —      | —             | Isolated power supply and ground for the output buffers to provide improved noise immunity.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| Vref                                                        | Input        | Level  | —             | Reference voltage for SDRAM versions supporting SSTL interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |



Block Diagram for HYB39S16400AT (2 banks x 4M x 4 SDRAM)



Block Diagram for HYB39S16800AT (2 banks x 1M x 8 SDRAM)



Block Diagram for HYB39S16160AT (2 banks x 512k x 16 SDRAM)

### Operation Definition

All of SDRAM operations are defined by states of control signals  $\overline{CS}$ ,  $\overline{RAS}$ ,  $\overline{CAS}$ ,  $\overline{WE}$ , and DQM at the positive edge of the clock. The following list shows the most important operation commands.

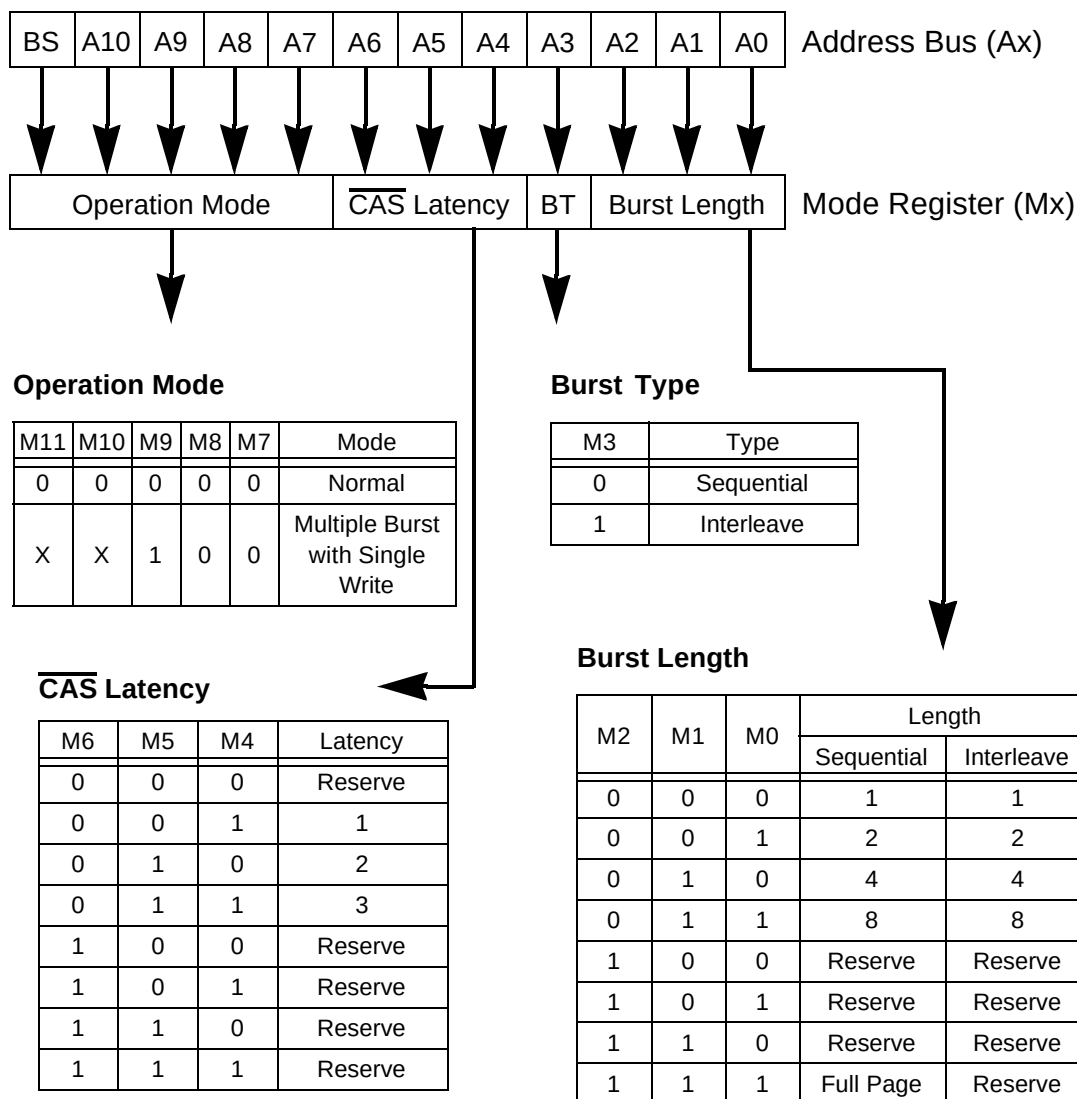
| Operation                                                                         | $\overline{CS}$ | $\overline{RAS}$ | $\overline{CAS}$ | $\overline{WE}$ | (L/U)DQM |
|-----------------------------------------------------------------------------------|-----------------|------------------|------------------|-----------------|----------|
| Standby, Ignore $\overline{RAS}$ , $\overline{CAS}$ , $\overline{WE}$ and Address | H               | X                | X                | X               | X        |
| Row Address Strobe and Activating a Bank                                          | L               | L                | H                | H               | X        |
| Column Address Strobe and Read Command                                            | L               | H                | L                | H               | X        |
| Column Address Strobe and Write Command                                           | L               | H                | L                | L               | X        |
| Precharge Command                                                                 | L               | L                | H                | L               | X        |
| Burst Stop Command                                                                | L               | H                | H                | L               | X        |
| Self Refresh Entry                                                                | L               | L                | L                | H               | X        |
| Mode Register Set Command                                                         | L               | L                | L                | L               | X        |
| Write Enable/Output Enable                                                        | X               | X                | X                | X               | L        |
| Write Inhibit/Output Disable                                                      | X               | X                | X                | X               | H        |
| No Operation (NOP)                                                                | L               | H                | H                | H               | X        |

### Mode Register

For application flexibility, a  $\overline{CAS}$  latency, a burst length, and a burst sequence can be programmed in the SDRAM mode register. The mode set operation must be done before any activate command after the initial power up. Any content of the mode register can be altered by re-executing the mode set command. Both banks must be in precharged state and CKE must be high at least one clock before the mode set operation. After the mode register is set, a Standby or NOP command is required. Low signals of  $\overline{RAS}$ ,  $\overline{CAS}$ , and  $\overline{WE}$  at the positive edge of the clock activate the mode set operation. Address input data at this timing defines parameters to be set as shown in the following table.



### Address Input for Mode Set (Mode Register Operation)



| Sequential Burst Addressing |   |   |   |   |   |   |   | Interleave Burst Addressing |   |   |   |   |   |   |   |
|-----------------------------|---|---|---|---|---|---|---|-----------------------------|---|---|---|---|---|---|---|
| 0                           | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 0                           | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| 1                           | 2 | 3 | 4 | 5 | 6 | 7 | 0 | 1                           | 0 | 3 | 2 | 5 | 4 | 7 | 6 |
| 2                           | 3 | 4 | 5 | 6 | 7 | 0 | 1 | 2                           | 3 | 0 | 1 | 6 | 7 | 4 | 5 |
| 3                           | 4 | 5 | 6 | 7 | 0 | 1 | 2 | 3                           | 2 | 1 | 0 | 7 | 6 | 5 | 4 |
| 4                           | 5 | 6 | 7 | 0 | 1 | 2 | 3 | 4                           | 5 | 6 | 7 | 0 | 1 | 2 | 3 |
| 5                           | 6 | 7 | 0 | 1 | 2 | 3 | 4 | 5                           | 4 | 7 | 6 | 1 | 0 | 3 | 2 |
| 6                           | 7 | 0 | 1 | 2 | 3 | 4 | 5 | 6                           | 7 | 4 | 5 | 2 | 3 | 0 | 1 |
| 7                           | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7                           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

### Read and Write Access Mode

When  $\overline{RAS}$  is low and both  $\overline{CAS}$  and  $\overline{WE}$  are high at the positive edge of the clock, a RAS cycle starts. According to address data, a word line of the selected bank is activated and all of sense amplifiers associated to the word line are fired. A CAS cycle is triggered by setting  $\overline{RAS}$  high and  $\overline{CAS}$  low at a clock timing after a necessary delay,  $t_{RCD}$ , from the RAS timing.  $\overline{WE}$  is used to define either a read ( $\overline{WE} = H$ ) or a write ( $\overline{WE} = L$ ) at this stage.

SDRAM provides a wide variety of fast access modes. In a single CAS cycle, serial data read or write operations are allowed at up to a 125 MHz data rate. The numbers of serial data bits are the burst length programmed at the mode set operation, i.e., one of 1, 2, 4, 8 and full page. Column addresses are segmented by the burst length and serial data accesses are done within this boundary. The first column address to be accessed is supplied at the CAS timing and the subsequent addresses are generated automatically by the programmed burst length and its sequence. For example, in a burst length of 8 with interleave sequence, if the first address is 2, then the rest of the burst sequence is 3, 0, 1, 6, 7, 4, and 5.

Full page burst operation is only possible using the sequential burst type and page length is a function of the I/O organisation and column addressing. Full page burst operation do not self terminate once the burst length has been reached. In other words, unlike burst length of 2, 3 or 8, full page burst continues until it is terminated using another command.

Similar to the page mode of conventional DRAMs, burst read or write accesses on any column address are possible once the  $\overline{RAS}$  cycle latches sense amplifiers. The maximum  $t_{RAS}$  or the refresh interval time limits the number of random column accesses. A new burst access can be done even before the previous burst ends. The interrupt operation at every clock cycles is supported. When the previous burst is interrupted, the remaining addresses are overridden by the new address with the full burst length. An interrupt which accompanies with an operation change from a read to a write is possible by exploiting DQM to avoid bus contention.

When two banks are activated sequentially, interleaved bank read or write operations are possible. With the programmed burst length, alternate access and precharge operations on two banks can realize fast serial data access modes among many different pages. Once two banks are activated, column to column interleave operation can be done between two different pages.

### Refresh Mode

SDRAM has two refresh modes, a  $\overline{CAS}$  before  $\overline{RAS}$  (CBR) automatic refresh and a self refresh. All of banks must be precharged before applying any refresh mode. An on-chip address counter increments the word and the bank addresses and no bank information is required for both refresh modes. The chip enters the automatic refresh mode, when  $\overline{RAS}$  and  $\overline{CAS}$  are held low and CKE and  $\overline{WE}$  are held high at a clock timing. The mode restores word line after the refresh and no external precharge command is necessary. A minimum  $t_{RC}$  time is required between two automatic refreshes in a burst refresh mode. The same rule applies to any access command after the automatic refresh operation.

The chip has an on-chip timer and the self refresh mode is available. It enters the mode when  $\overline{RAS}$ ,  $\overline{CAS}$ , and CKE are low and  $\overline{WE}$  is high at a clock timing. All of external control signals including the clock are disabled. Returning CKE to high enables the clock and initiates the refresh exit operation. After the exit command, at least one  $t_{RC}$  delay is required prior to any access command.

### DQM Function

DQM has two functions for data I/O read write operations. During reads, when it turns to high at a clock timing, data outputs are disabled and become high impedance after two clock delay (DQM Data Disable Latency  $t_{DQZ}$ ). It also provides a data mask function for writes. When DQM is activated, the write operation at the next clock is prohibited (DQM Write Mask Latency  $t_{DQW}$  = zero clocks).

### Suspend Mode

During normal access mode, CKE is held high and CLK is enabled. When CKE is low, it freezes the internal clock and extends data read and write operations. One clock delay is required for mode entry and exit (Clock Suspend Latency  $t_{CSL}$ ).

### Power Down

In order to reduce standby power consumption, a power down mode is available. Bringing CKE low enters the power down mode and all of receiver circuits are gated. All banks must be precharged before entering this mode. One clock delay is required for mode entry and exit. The Power Down mode does not perform any refresh operation.

### Auto Precharge

Two methods are available to precharge SDRAMs. In an automatic precharge mode, the CAS timing accepts one extra address, CA10, to determine whether the chip restores or not after the operation. If CA10 is high when a Read Command is issued, the **Read with Auto-Precharge** function is initiated. The SDRAM automatically enters the precharge operation one clock after the Read Command is registered for  $\overline{CAS}$  latencies of 1 and 2, and two clocks for  $\overline{CAS}$  latencies of 3. If CA10 is high when a Write Command is issued, the **Write with Auto-Precharge** function is initiated. The SDRAM automatically enters the precharge operation one clock delay from the last data-in for  $\overline{CAS}$  latencies of 1 and 2 and two clocks for  $\overline{CAS}$  latencies of 3. This delay is referenced as  $t_{DPL}$ .

### Precharge Command

If CA10 is low, the chip needs another way to precharge. In this mode, a separate precharge command is necessary. When  $\overline{RAS}$  and  $\overline{WE}$  are low and  $\overline{CAS}$  is high at a clock timing, it triggers the precharge operation. Two address bits, A10 and A11, are used to define banks as shown in the following list. The precharge command may be applied coincident with the last of burst reads for CAS Latency = 1 and with the second to the last read data for CAS Latencies = 2 & 3. Writes require a time  $t_{DPL}$  from the last burst data to apply the precharge command.

Bank Selection by Address Bits

|              | A10  | A11       |
|--------------|------|-----------|
| Bank A Only  | Low  | Low       |
| Bank B Only  | Low  | High      |
| Both A and B | High | Dont Care |

**Burst Termination**

Once a burst read or write operation has been initiated, there are several methods in which to terminate the burst operation prematurely. These methods include using another Read or Write Command to interrupt an existing burst operation, use a Precharge Command to interrupt a burst cycle and close the active bank, or using the Burst Stop Command to terminate the existing burst operation but leave the bank open for future Read or Write Commands to the same page of the active bank. When interrupting a burst with another Read or Write Command care must be taken to avoid DQ contention. The Burst Stop Command, however, has the fewest restrictions making it the easiest method to use when terminating a burst operation before it has been completed. If a Burst Stop command is issued during a burst write operation, then any residual data from the burst write cycle will be ignored. Data that is presented on the DQ pins before the Burst Stop Command is registered will be written to the memory.

**Power Up Procedure**

All Vdd and Vddq must reach the specified voltage no later than any of input signal voltages. An initial pause of 200  $\mu$ sec is required after power on. All banks have to be precharged and a minimum of 2 auto-refresh cycles are required prior to the mode register set operation.

### Absolute Maximum Ratings

Operating temperature range ..... 0 to + 70 °C  
 Storage temperature range ..... – 55 to + 150 °C  
 Input/output voltage ..... – 0.5 to min(V<sub>CC</sub>+0.5, 4.6) V  
 Power supply voltage V<sub>DD</sub> / V<sub>DDQ</sub> ..... – 1.0 to + 4.6 V  
 Power Dissipation ..... 1 W  
 Data out current (short circuit) ..... 50 mA

**Note:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage of the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Recommended Operation and Characteristics for LV-TTL versions:

T<sub>A</sub> = 0 to 70 °C; V<sub>SS</sub> = 0 V; V<sub>DD</sub>, V<sub>DDQ</sub> = 3.3 V ± 0.3 V

| Parameter                                                                                               | Symbol            | Limit Values |                      | Unit | Notes |
|---------------------------------------------------------------------------------------------------------|-------------------|--------------|----------------------|------|-------|
|                                                                                                         |                   | min.         | max.                 |      |       |
| Input high voltage                                                                                      | V <sub>IH</sub>   | 2.0          | V <sub>CC</sub> +0.3 | V    | 1, 2  |
| Input low voltage                                                                                       | V <sub>IL</sub>   | – 0.3        | 0.8                  | V    | 1, 2  |
| Output high voltage (I <sub>OUT</sub> = – 2.0 mA)                                                       | V <sub>OH</sub>   | 2.4          | –                    | V    |       |
| Output low voltage (I <sub>OUT</sub> = 2.0 mA)                                                          | V <sub>OL</sub>   | –            | 0.4                  | V    |       |
| Input leakage current, any input<br>(0 V < V <sub>IN</sub> < V <sub>DDQ</sub> , all other inputs = 0 V) | I <sub>I(L)</sub> | – 10         | 10                   | µA   |       |
| Output leakage current<br>(DQ is disabled, 0 V < V <sub>OUT</sub> < V <sub>CC</sub> )                   | I <sub>O(L)</sub> | – 10         | 10                   | µA   |       |

### Notes:

1. All voltages are referenced to V<sub>SS</sub>.
2. V<sub>IH</sub> may overshoot to V<sub>CC</sub> + 2.0 V for pulse width of < 4ns with 3.3V. V<sub>IL</sub> may undershoot to –2.0 V for pulse width < 4.0 ns with 3.3V. Pulse width measured at 50% points with amplitude measured peak to DC reference.

### Capacitance

T<sub>A</sub> = 0 to 70 °C; V<sub>DD</sub> = 3.3 V ± 0.3 V, f = 1 MHz

| Parameter                                                                               | Symbol           | max. Values | Unit |
|-----------------------------------------------------------------------------------------|------------------|-------------|------|
| Input capacitance (A0 to A11)                                                           | C <sub>I1</sub>  | 4           | pF   |
| Input capacitance<br>( <u>RAS</u> , <u>CAS</u> , <u>WE</u> , <u>CS</u> , CLK, CKE, DQM) | C <sub>I2</sub>  | 4           | pF   |
| Output capacitance (DQ)                                                                 | C <sub>IO</sub>  | 5           | pF   |
| Vref                                                                                    | C <sub>Ref</sub> | 8           | pF   |

### Recommended Operation and DC Characteristics for SSTL versions:

$T_A = 0$  to  $70\text{ }^{\circ}\text{C}$ ;  $V_{SS} = 0\text{ V}$ ;

| Parameter               | Symbol    | Limit Values |      |      | Unit | Notes |
|-------------------------|-----------|--------------|------|------|------|-------|
|                         |           | min.         | nom. | max. |      |       |
| Device supply voltage   | $V_{DD}$  | 3.0          | 3.3  | 3.6  | V    |       |
| Output supply voltage   | $V_{DDQ}$ | 3.0          | 3.3  | 3.6  | V    | 3     |
| Input reference voltage | $V_{REF}$ | 1.3          | 1.5  | 1.7  | V    | 4     |

### Input logic levels and output current drives conditions for SSTL versions:

$T_A = 0$  to  $70\text{ }^{\circ}\text{C}$ ;  $V_{SS} = 0\text{ V}$ ;

| Parameter                        | Symbol       | Limit Values    |                 | Unit | Notes |
|----------------------------------|--------------|-----------------|-----------------|------|-------|
|                                  |              | min.            | max.            |      |       |
| DC input logic high levels       | $V_{IH(DC)}$ | $V_{ref} + 0.2$ | $V_{DDQ} + 0.3$ | V    |       |
| AC input logic high levels       | $V_{IH(AC)}$ | $V_{ref} + 0.4$ |                 | V    | 5     |
| DC input logic low levels        | $V_{IL(DC)}$ | -0.3            | $V_{ref} - 0.2$ | V    |       |
| AC input logic low levels        | $V_{IL(AC)}$ |                 | $V_{ref} - 0.4$ | V    | 5     |
| Output minimum source dc current | $I_{OH(DC)}$ | 16              |                 | mA   |       |
| Output minimum sink dc current   | $I_{OL(DC)}$ | 16              |                 | mA   |       |

### Notes:

- Under all conditions  $V_{DDQ}$  must be less than or equal to  $V_{DD}$
- The value of  $V_{ref}$  may be selected by the user to provide optimum noise margin in the system.  $V_{ref}$  has to be in the range between  $0.43 * V_{DDQ}$  and  $0.47 * V_{DDQ}$  and is expected to track variations in  $V_{DDQ}$
- $V_{IH}$  may overshoot to  $V_{DD}$ ,  $V_{DDQ} + 1.2\text{ V}$  for pulse width  $< 5\text{ ns}$  and  $V_{IL}$  may undershoot to  $V_{SS}$ ,  $V_{SSQ} - 1.2\text{ V}$  for pulse width  $< 5\text{ ns}$ .

**Operating Currents** ( $T_A = 0$  to  $70^\circ\text{C}$ ,  $V_{CC} = 3.3\text{V} \pm 0.3\text{V}$ )

(Recommended Operating Conditions unless otherwise noted)

| Parameter                                        | Symbol | Test Condition                                                                                     | $\overline{\text{CAS}}$ | -8   | -10  |    | Note                                   |
|--------------------------------------------------|--------|----------------------------------------------------------------------------------------------------|-------------------------|------|------|----|----------------------------------------|
|                                                  |        |                                                                                                    | Latency                 | max. | max. |    |                                        |
| Operating Current                                | Icc1   | Burst Length = 4<br>trc >= trc (min.)<br>tck >= tck(min.), Io = 0mA<br>2 bank interleave operation | 1                       | 80   | 65   | mA | 1, 2                                   |
|                                                  |        |                                                                                                    | 2                       | 115  | 90   | mA |                                        |
|                                                  |        |                                                                                                    | 3                       | 125  | 100  | mA |                                        |
| Precharge Standby Current in Power Down Mode     | Icc2P  | CKE <= VIL(max),<br>tck >= tck(min.)                                                               |                         | 3    | 3    | mA |                                        |
|                                                  | Icc2PS | CKE <= VIL(max),<br>tCK=infinite                                                                   |                         | 2    | 2    | mA |                                        |
| Precharge Standby Current in Non-power down Mode | Icc2N  | CKE >= VIH(min),<br>tck >= tck(min.) input signals<br>changed once in 3 cycles                     |                         | 20   | 20   | mA | $\overline{\text{CS}}$ =<br>High       |
|                                                  | Icc2NS | CKE >= VIH(min),<br>tCK=infinite, input signals<br>are stable                                      |                         | 10   | 10   | mA |                                        |
| Active Standby Current in Power Down Mode        | Icc3P  | CKE <= VIL(max),<br>tck >= tck(min.)                                                               |                         | 3    | 3    | mA |                                        |
|                                                  | Icc3PS | CKE <= VIL(max),<br>tCK=infinite, input signals<br>are stable                                      |                         | 2    | 2    | mA |                                        |
| Active Standby Current in Non-power Down Mode    | Icc3N  | CKE >= VIH(min),<br>tck >= tck(min.),<br>changed once in 3 cycles                                  |                         | 25   | 25   | mA | $\overline{\text{CS}}$ =<br>High,<br>1 |
|                                                  | Icc3NS | CKE >= VIH(min),<br>tCK=infinite, input signals<br>are stable                                      |                         | 15   | 15   | mA |                                        |
| Burst Operating Current                          | Icc4   | Burst Length = full page<br>trc = infinite<br>tck >= tck (min.), IO = 0 mA<br>2 banks activated    | 1                       | 50   | 40   | mA | 1, 2                                   |
|                                                  |        |                                                                                                    | 2                       | 80   | 65   |    |                                        |
|                                                  |        |                                                                                                    | 3                       | 120  | 95   |    |                                        |
| Auto (CBR) Refresh Current                       | Icc5   | trc >= trc(min)                                                                                    | 1                       | 75   | 60   | mA | 1, 2                                   |
|                                                  |        |                                                                                                    | 2                       | 95   | 75   | mA |                                        |
|                                                  |        |                                                                                                    | 3                       | 115  | 90   | mA |                                        |
| Self Refresh                                     | Icc6   | CKE < 0.2V                                                                                         |                         | 2    | 2    | mA | 1, 2                                   |

### Notes:

1. The specified values are valid when addresses are changed no more than three times during trc(min.) and when No Operation commands are registered on every rising clock edge during tRC(min.).
2. The specified values are valid when data inputs (DQs) are stable during tRC(min.).

### AC Characteristics 1)2)

$T_A = 0$  to  $70\text{ }^{\circ}\text{C}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $t_T = 1\text{ ns}$

| Parameter | Symbol | Limit Values |     |     |     | Unit | Note |
|-----------|--------|--------------|-----|-----|-----|------|------|
|           |        | -8           |     | -10 |     |      |      |
|           |        | min          | max | min | max |      |      |

### Clock and Clock Enable

|                                 |          |    |     |     |     |     |   |
|---------------------------------|----------|----|-----|-----|-----|-----|---|
| Clock Cycle Time                | $t_{CK}$ |    |     |     |     |     |   |
| $\overline{CAS}$ Latency = 3    |          | 8  |     | 10  |     | ns  |   |
| $\overline{CAS}$ Latency = 2    |          | 12 |     | 15  |     | ns  |   |
| $\overline{CAS}$ Latency = 1    |          | 24 |     | 30  |     | ns  |   |
| System frequency                | $t_{CK}$ |    |     |     |     |     |   |
| $\overline{CAS}$ Latency = 3    |          |    | 125 |     | 100 | MHz |   |
| $\overline{CAS}$ Latency = 2    |          |    | 83  |     | 66  | MHz |   |
| $\overline{CAS}$ Latency = 1    |          |    | 41  |     | 33  | MHz |   |
| Clock Access Time               | $t_{AC}$ |    |     |     |     |     |   |
| $\overline{CAS}$ Latency = 3    |          | –  | 7   | –   | 8   | ns  | 3 |
| $\overline{CAS}$ Latency = 2    |          | –  | 8   | –   | 9   | ns  |   |
| $\overline{CAS}$ Latency = 1    |          |    | 21  | –   | 27  | ns  |   |
| Clock High Pulse Width          | $t_{CH}$ | 3  | –   | 3.5 | –   | ns  |   |
| Clock Low Pulse Width           | $t_{CL}$ | 3  | –   | 3.5 | –   | ns  |   |
| Transition time (rise and fall) | $t_T$    | 1  | 30  | 1   | 30  | ns  |   |

### Setup and Hold Times

|                                     |            |     |   |   |   |    |   |
|-------------------------------------|------------|-----|---|---|---|----|---|
| Command Setup time                  | $t_{CS}$   | 2.5 | – | 3 | – | ns | 4 |
| Address Setup Time                  | $t_{AS}$   | 2.5 | – | 3 | – | ns | 4 |
| Data In Setup Time                  | $t_{DS}$   | 2.5 | – | 3 | – | ns | 4 |
| CKE Setup Time                      | $t_{CKS}$  | 2.5 | – | 3 | – | ns | 4 |
| CKE Set-up Time (Power down mode)   | $t_{CKSP}$ | 2.5 | – | 3 | – | ns | 4 |
| CKE Set-up Time (Self Refresh Exit) | $t_{CKSR}$ | 8   | – | 8 | – | ns |   |
| Command Hold Time                   | $t_{CH}$   | 1   | – | 1 | – | ns | 4 |
| Address Hold Time                   | $t_{AH}$   | 1   | – | 1 | – | ns | 4 |
| Data In Hold Time                   | $t_{DH}$   | 1   | – | 1 | – | ns | 4 |
| CKE Hold Time                       | $t_{CKH}$  | 1   | – | 1 | – | ns | 4 |



| Parameter | Symbol | Limit Values |     |     |     | Unit | Note |
|-----------|--------|--------------|-----|-----|-----|------|------|
|           |        | -8           |     | -10 |     |      |      |
|           |        | min          | max | min | max |      |      |

### Common Parameters

|                                                                           |                  |    |      |    |      |     |  |
|---------------------------------------------------------------------------|------------------|----|------|----|------|-----|--|
| Row to Column Delay Time                                                  | $t_{\text{RCD}}$ | 24 | –    | 30 | –    | ns  |  |
| Row Active Time                                                           | $t_{\text{RAS}}$ | 36 | 120k | 45 | 120k | ns  |  |
| Precharge Time                                                            | $t_{\text{RP}}$  | 24 | –    | 30 | –    | ns  |  |
| Row Cycle Time                                                            | $t_{\text{RC}}$  | 60 | 120k | 75 | 120k | ns  |  |
| Bank to Bank Delay Time                                                   | $t_{\text{RRD}}$ | 16 | –    | 20 | –    | ns  |  |
| $\overline{\text{CAS}}$ to $\overline{\text{CAS}}$ delay time (same bank) | $t_{\text{CCD}}$ | 1  | –    | 1  | –    | CLK |  |

### Refresh Cycle

|                              |                   |                               |    |   |    |    |   |
|------------------------------|-------------------|-------------------------------|----|---|----|----|---|
| Self Refresh Exit Time       | $t_{\text{SREX}}$ | $2\text{CLK} + t_{\text{RC}}$ |    |   |    | ns | 6 |
| Refresh Period (4096 cycles) | $t_{\text{REF}}$  | –                             | 64 | – | 64 | ms | 5 |

### Read Cycle

|                                     |                  |   |    |   |    |     |   |
|-------------------------------------|------------------|---|----|---|----|-----|---|
| Data Out Hold Time                  | $t_{\text{OH}}$  | 3 | –  | 3 | –  | ns  |   |
| Data Out to Low Impedance Time      | $t_{\text{LZ}}$  | 0 | –  | 0 | –  | ns  |   |
| Data Out to High Impedance Time     | $t_{\text{HZ}}$  |   |    |   |    |     | 7 |
| $\overline{\text{CAS}}$ Latency = 3 |                  | – | 5  | – | 6  | ns  |   |
| $\overline{\text{CAS}}$ Latency = 2 |                  | – | 7  | – | 8  | ns  |   |
| $\overline{\text{CAS}}$ Latency = 1 |                  | – | 19 | – | 25 | ns  |   |
| DQM Data Out Disable Latency        | $t_{\text{DQZ}}$ | 2 | –  | 2 | –  | CLK |   |

### Write Cycle

|                                                          |                  |   |   |   |   |     |  |
|----------------------------------------------------------|------------------|---|---|---|---|-----|--|
| Last Data-Input to Precharge<br>(Write Recovery Latency) |                  |   |   |   |   |     |  |
| CL = 1, 2                                                | $t_{\text{DPL}}$ | 1 | – | 1 | – | CLK |  |
| CL = 3                                                   |                  | 2 | – | 2 | – | CLK |  |
| DQM Write Mask Latency                                   | $t_{\text{DQW}}$ | 0 | – | 0 | – | CLK |  |

### Notes:

1. An initial pause of 200 $\mu$ s is required after power-up, then a Precharge All Banks command must be given followed by 8 Auto Refresh (CBR) cycles before the Mode Register Set Operation can begin.
2. AC timing tests for LV-TTL versions have  $V_{il} = 0.4V$  and  $V_{ih} = 2.4V$  with the timing referenced to the 1.4 V crossover point. The transition time is measured between  $V_{ih}$  and  $V_{il}$ . All AC measurements assume  $t_T=1ns$  with the AC output load circuit shown in fig.1.  
AC timing tests for SSTL versions have to be performed according to the JEDEC standard for „Stub Series Terminated Logic for 3.3Volts (SSTL\_3).“
3. If clock rising time is longer than 1ns,  $(t_T/2 - 0.5)$  ns has to be added to this parameter.
4. If  $t_T$  is longer than 1 ns, a time  $(t_T-1)$  ns has to be added to this parameter.
5. Any time that the refresh Period has been exceeded, a minimum of two Auto (CBR) Refresh commands must be given to "wake-up" the device.
6. Self Refresh Exit is a synchronous operation and begins on the 2nd positive clock edge after CKE returns high. Self Refresh Exit is not complete until a time period equal to  $t_{RC}$  is satisfied once the Self Refresh Exit command is registered.
7. Referenced to the time which the output achieves the open circuit condition, not to output voltage levels..

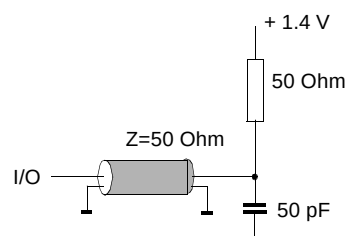
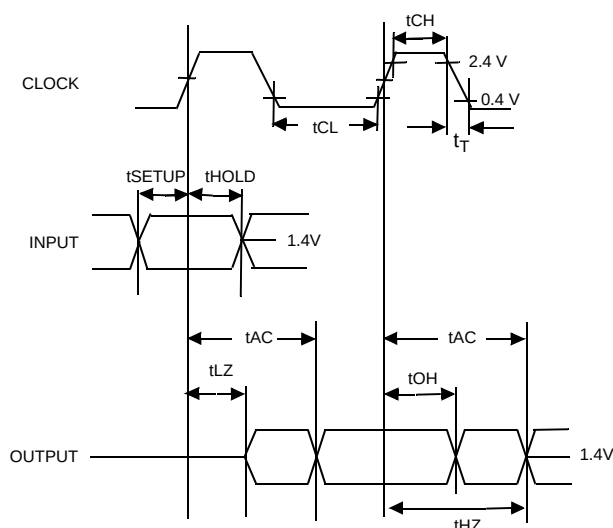


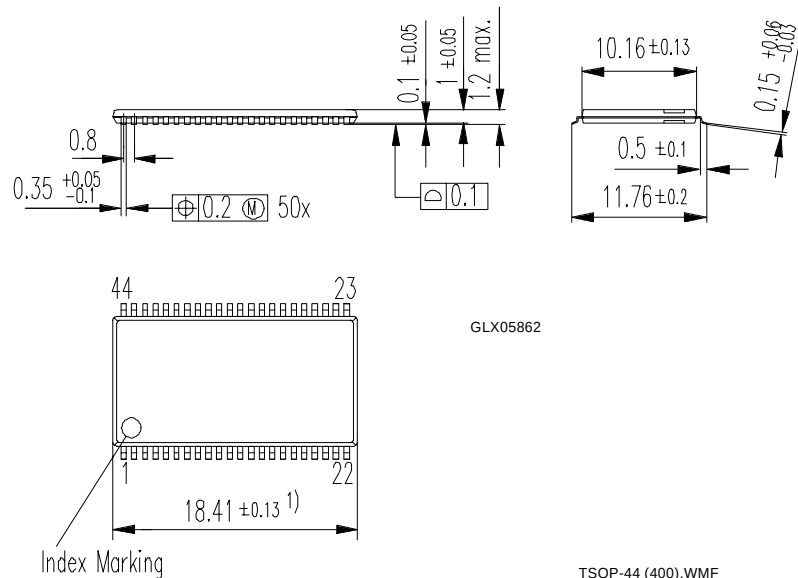
fig.1

### Clock Frequency and Latency

| Parameter                                       |       | Symbol             | Speed Sort |     |     |     | Unit    |
|-------------------------------------------------|-------|--------------------|------------|-----|-----|-----|---------|
|                                                 |       |                    | -8         |     | -10 |     |         |
| Clock Frequency                                 | max.  | $t_{CK}$           | 125        | 83  | 100 | 66  | MHz     |
| Clock Cycle Time                                | min.  | $t_{CK}$           | 8          | 12  | 10  | 15  | ns      |
| $\overline{CAS}$ Latency                        | min.  | $t_{AA}$           | 3          | 2   | 3   | 2   | CLK     |
| Row to Column Delay                             | min.  | $t_{RCD}$          | 3          | 2   | 3   | 2   | CLK     |
| $\overline{RAS}$ Latency                        | min.  | $t_{RL}$           | 6          | 4   | 6   | 4   | CLK     |
| Row Active Time                                 | min.  | $t_{RAS}$          | 5          | 3   | 5   | 3   | CLK     |
|                                                 | max.  | $t_{RAS}$          | 120        | 120 | 120 | 120 | $\mu s$ |
| Row Precharge Time                              | min.  | $t_{RP}$           | 3          | 2   | 3   | 2   | CLK     |
| Row Cycle time                                  | min.  | $t_{RC}$           | 8          | 5   | 8   | 5   | CLK     |
| Last Data-In to Precharge (Write Recovery)      | min.  | $t_{DPL}$          | 2          | 1   | 2   | 1   | CLK     |
| Last Data-In to Active / Refresh                | min.  | $t_{DPL} + t_{RP}$ | 5          | 3   | 5   | 3   | CLK     |
| Bank to Bank Delay Time                         | min.  | $t_{RRD}$          | 2          | 2   | 2   | 2   | CLK     |
| $\overline{CAS}$ to $\overline{CAS}$ delay time | min.  | $t_{CCD}$          | 1          | 1   | 1   | 1   | CLK     |
| Write Latency                                   | fixed | $t_{WL}$           | 0          | 0   | 0   | 0   | CLK     |
| DQM Write Mask Latency                          | fixed | $t_{DQW}$          | 0          | 0   | 0   | 0   | CLK     |
| DQM Data Disable Latency                        | fixed | $t_{DQZ}$          | 2          | 2   | 2   | 2   | CLK     |
| Clock Suspend Latency                           | fixed | $t_{CSL}$          | 1          | 1   | 1   | 1   | CLK     |

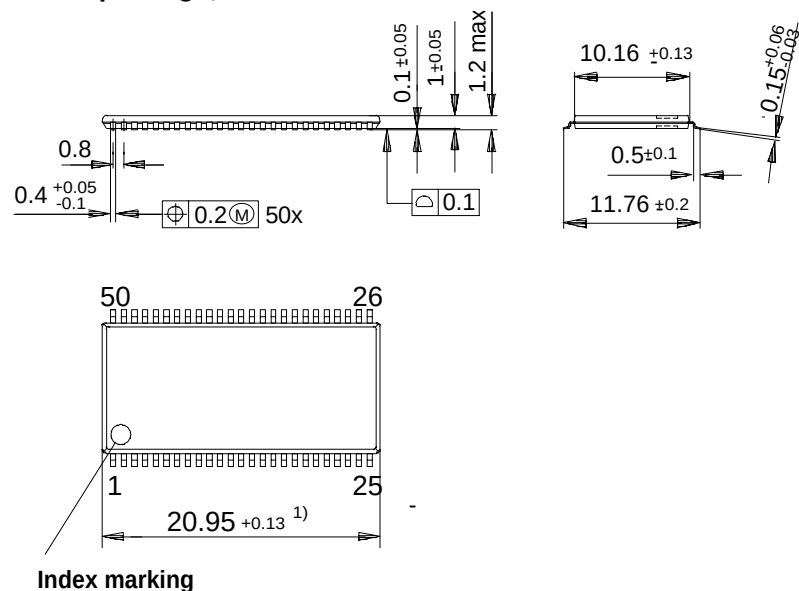
### Package Outlines:

#### Plastic Package P-TSOPII-44 (400mil, 0.8mm lead pitch) Thin small outline package, SMD



1) Does not include plastic or metal protrusion of 0.15 max. per side

#### Plastic Package P-TSOPII-50 (400mil, 0.8mm lead pitch) Thin small outline package, SMD



1) Does not include plastic or metal protrusion of 0.25 max. per side

## Timing Diagrams

1. Bank Activate Command Cycle
2. Burst Read Operation
3. Read Interrupted by a Read
4. Read to Write Interval
  - 4.1 Read to Write Interval
  - 4.2 Minimum Read to Write Interval
  - 4.3 Non-Minimum Read to Write Interval
5. Burst Write Operation
6. Write and Read Interrupt
  - 6.1 Write Interrupted by a Write
  - 6.2 Write Interrupted by Read
7. Burst Read & Write with Auto-Precharge
  - 7.1 Burst Write with Auto Precharge
  - 7.2 Burst Read with Auto Precharge
8. Burst Termination
  - 8.1 Termination of a Burst Read Operation
  - 8.2 Termination of a Burst Write Operation
9. AC- Parameters
  - 9.1 AC Parameters for a Write Timing
  - 9.2 AC Parameters for a Read Timing
10. Mode Register Set
11. Power on Sequence and Auto Refresh (CBR)
12. Clock Suspension (using CKE)
  - 12.1 Clock Suspension During Burst Read  $\overline{\text{CAS}}$  Latency = 1
  12. 2 Clock Suspension During Burst Read  $\overline{\text{CAS}}$  Latency = 2
  12. 3 Clock Suspension During Burst Read  $\overline{\text{CAS}}$  Latency = 3
  12. 4 Clock Suspension During Burst Write  $\overline{\text{CAS}}$  Latency = 1
  12. 5 Clock Suspension During Burst Write  $\overline{\text{CAS}}$  Latency = 2
  12. 6 Clock Suspension During Burst Write  $\overline{\text{CAS}}$  Latency = 3
13. Power Down Mode and Clock Suspend
14. Auto Refresh (CBR)
15. Self Refresh ( Entry and Exit)
16. Random Column Read ( Page within same Bank)
  - 16.1  $\overline{\text{CAS}}$  Latency = 1
  - 16.2  $\overline{\text{CAS}}$  Latency = 2
  - 16.3  $\overline{\text{CAS}}$  Latency = 3
17. Random Column Write ( Page within same Bank)
  - 17.1  $\overline{\text{CAS}}$  Latency = 1
  - 17.2  $\overline{\text{CAS}}$  Latency = 2
  - 17.3  $\overline{\text{CAS}}$  Latency = 3

## Timing Diagrams (cont'd)

### 18. Random Row Read ( Interleaving Banks)

18.1  $\overline{\text{CAS}}$  Latency = 1

18.2  $\overline{\text{CAS}}$  Latency = 2

18.3  $\overline{\text{CAS}}$  Latency = 3

### 19. Random Row Write ( Interleaving Banks)

19.1  $\overline{\text{CAS}}$  Latency = 1

19.2  $\overline{\text{CAS}}$  Latency = 2

19.3  $\overline{\text{CAS}}$  Latency = 3

### 20. Full Page Read Cycle (optional feature)

20.1  $\overline{\text{CAS}}$  Latency = 1

20.2  $\overline{\text{CAS}}$  Latency = 2

20.3  $\overline{\text{CAS}}$  Latency = 3

### 21. Full Page Write Cycle (optional feature)

21.1  $\overline{\text{CAS}}$  Latency = 1

21.2  $\overline{\text{CAS}}$  Latency = 2

21.3  $\overline{\text{CAS}}$  Latency = 3

### 22. Precharge Termination of a Burst

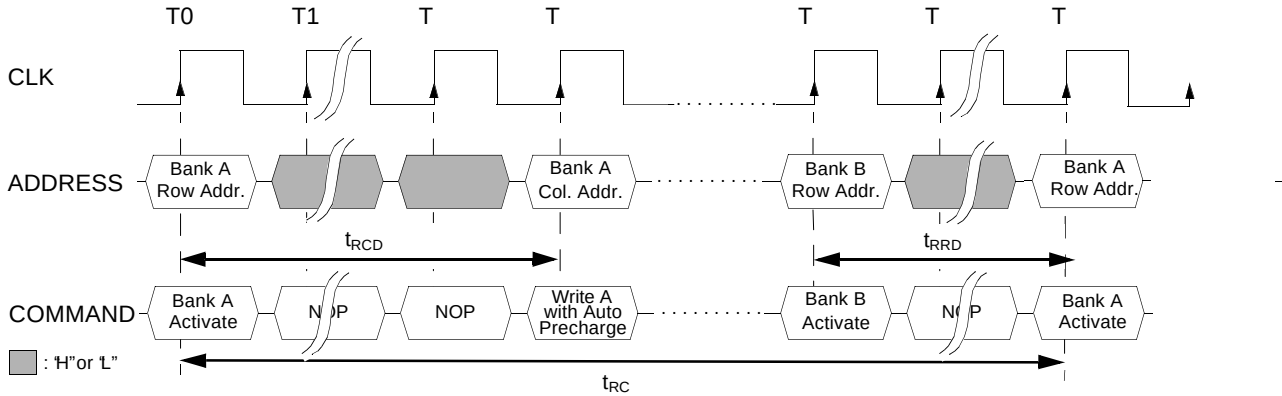
22.1  $\overline{\text{CAS}}$  Latency = 1

22.2  $\overline{\text{CAS}}$  Latency = 2

22.3  $\overline{\text{CAS}}$  Latency = 3

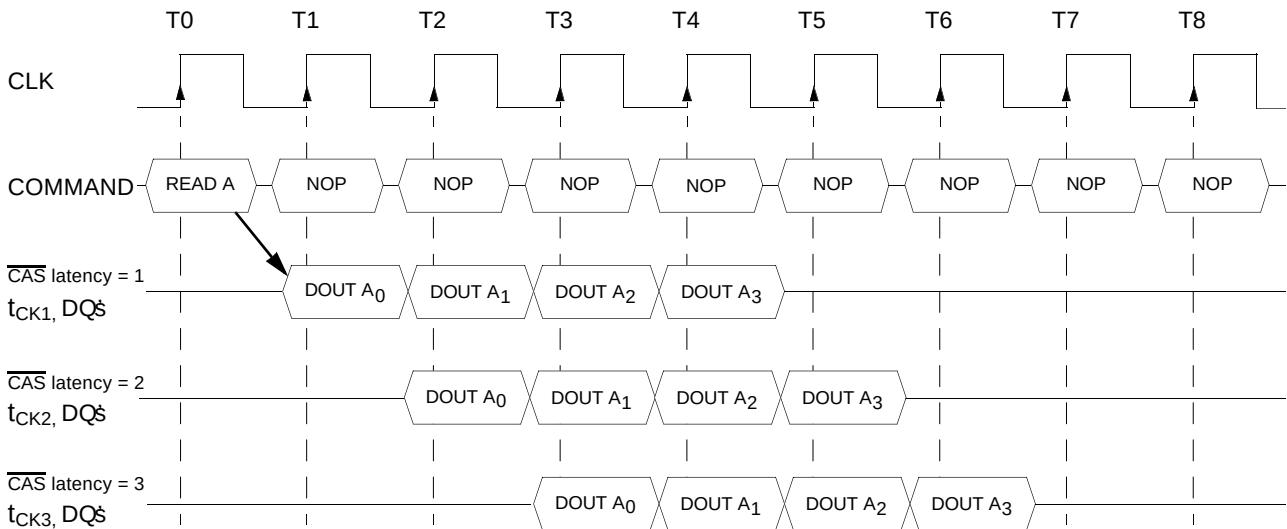
## 1. Bank Activate Command Cycle

( $\overline{\text{CAS}}$  latency = 3)



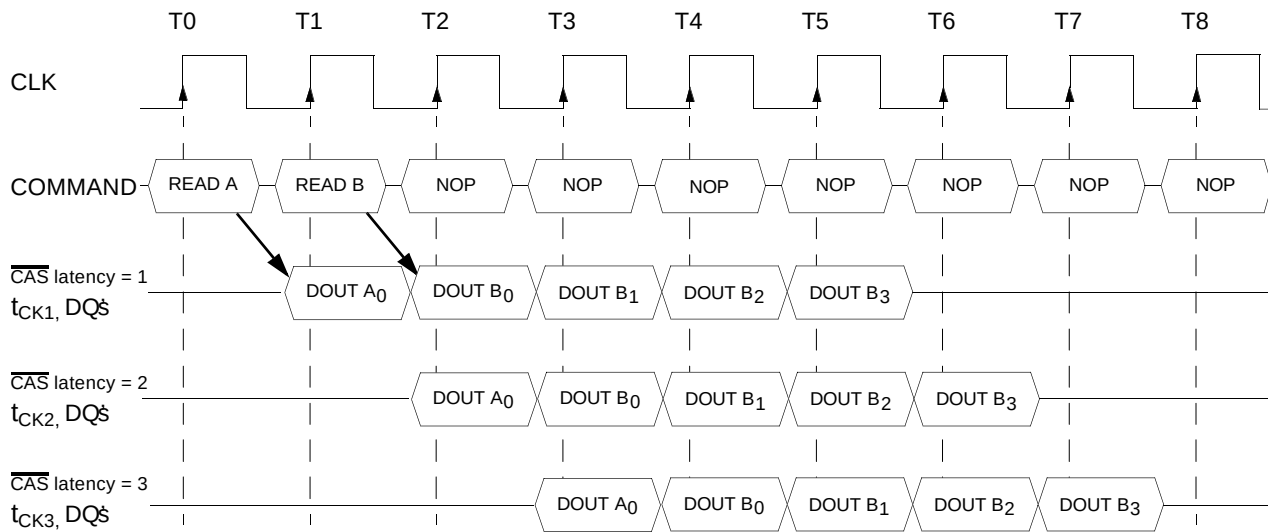
## 2. Burst Read Operation

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, 3)



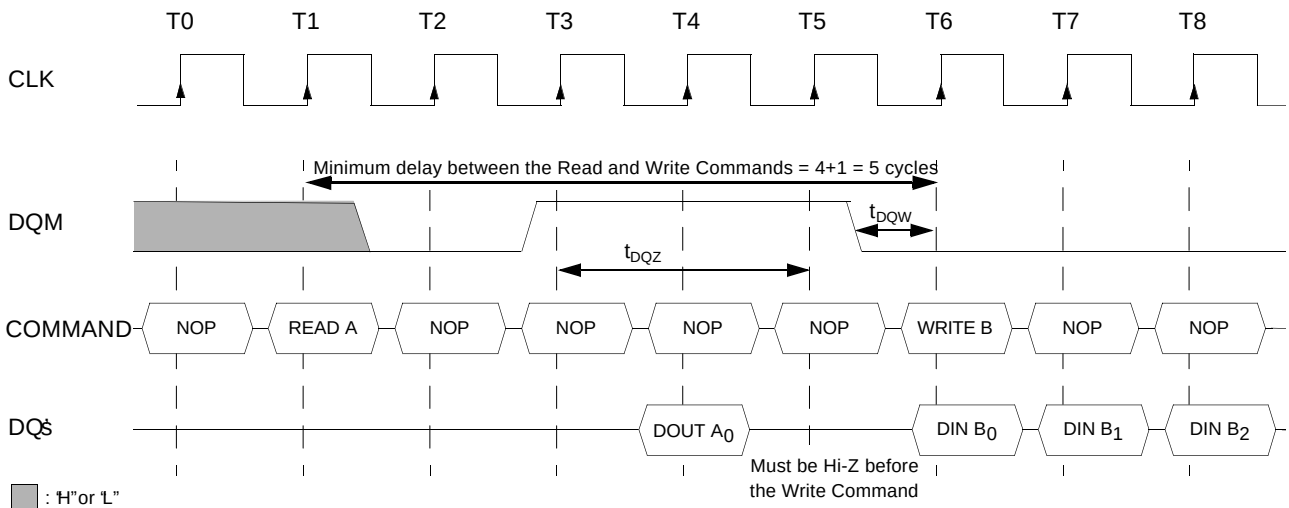
## 3. Read Interrupted by a Read

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, 3)



## 4.1 Read to Write Interval

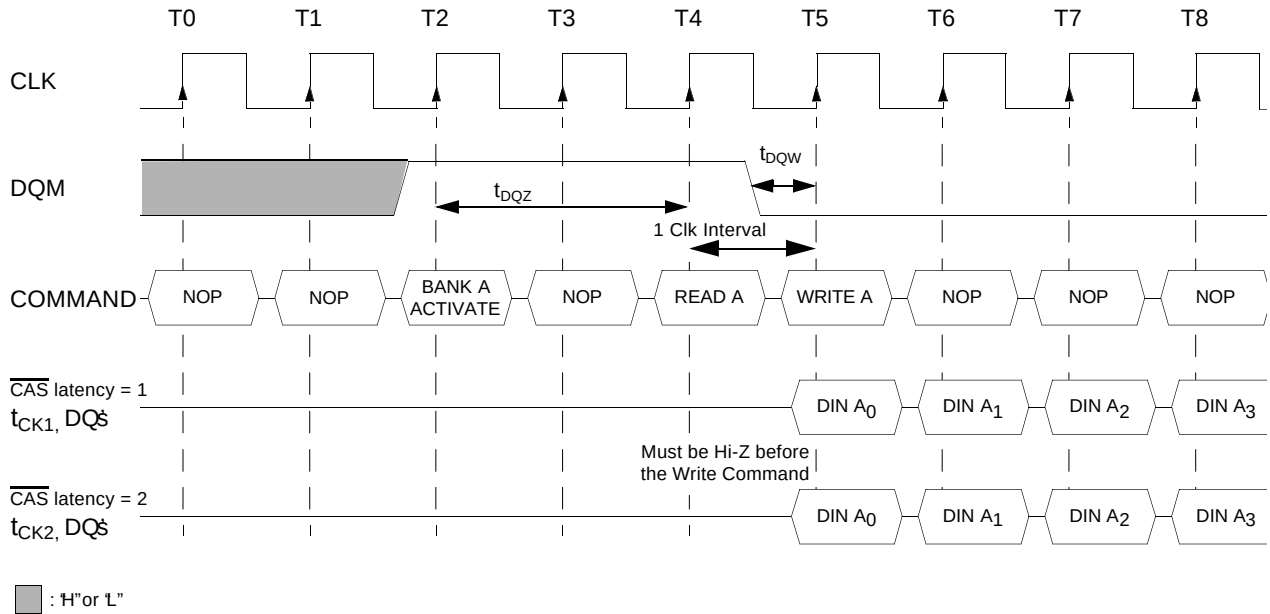
(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 3)





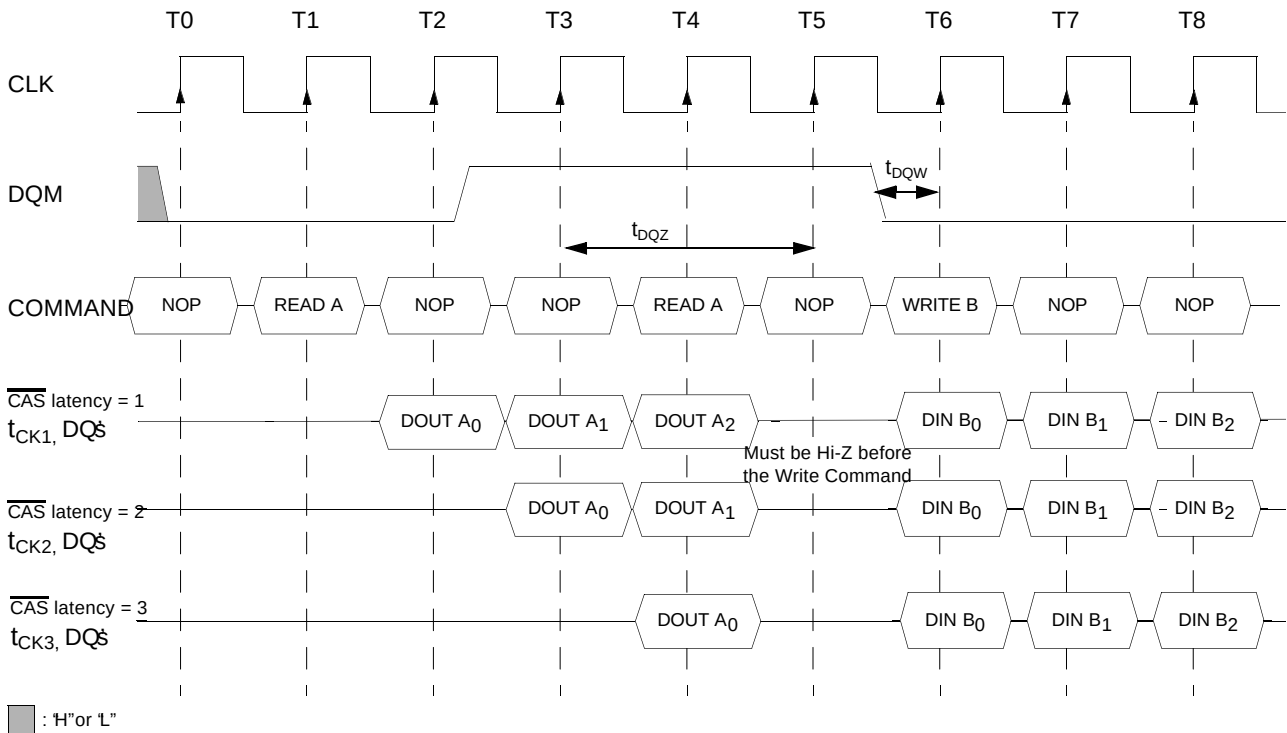
## 4 2. Minimum Read to Write Interval

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2)



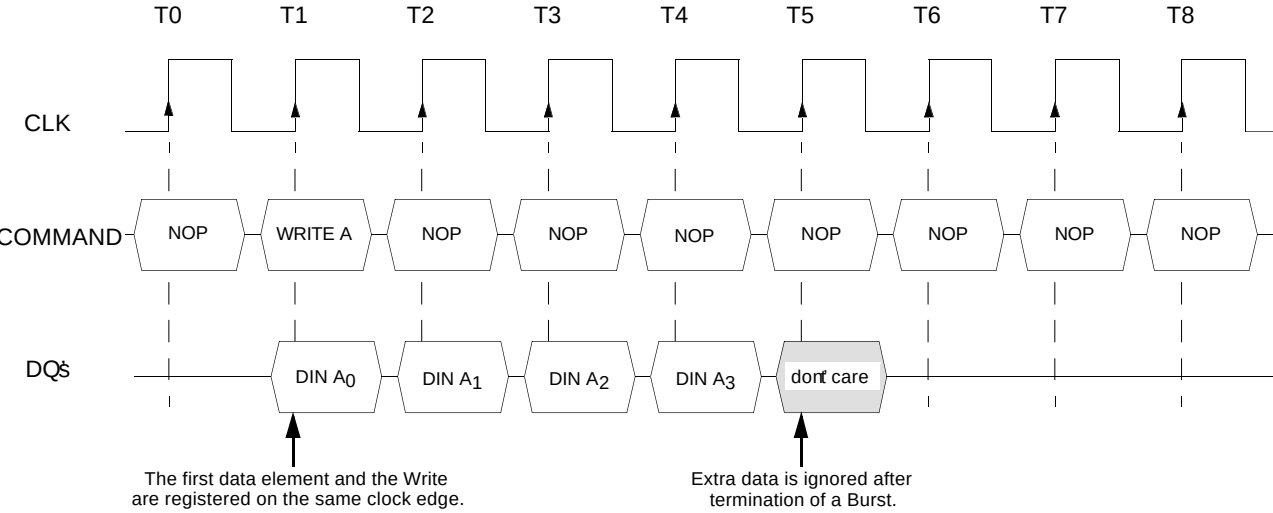
## 4. 3. Non-Minimum Read to Write Interval

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 3)



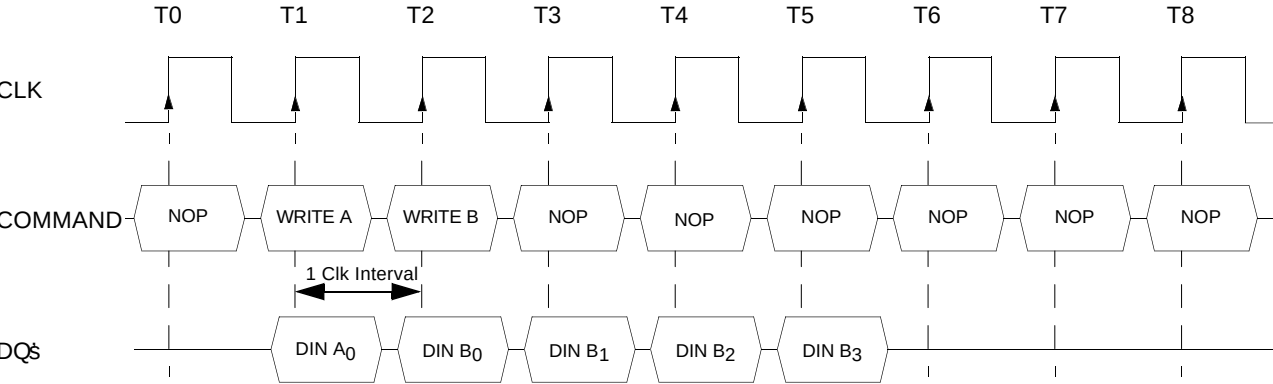
5. Burst Write Operation

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, or 3)



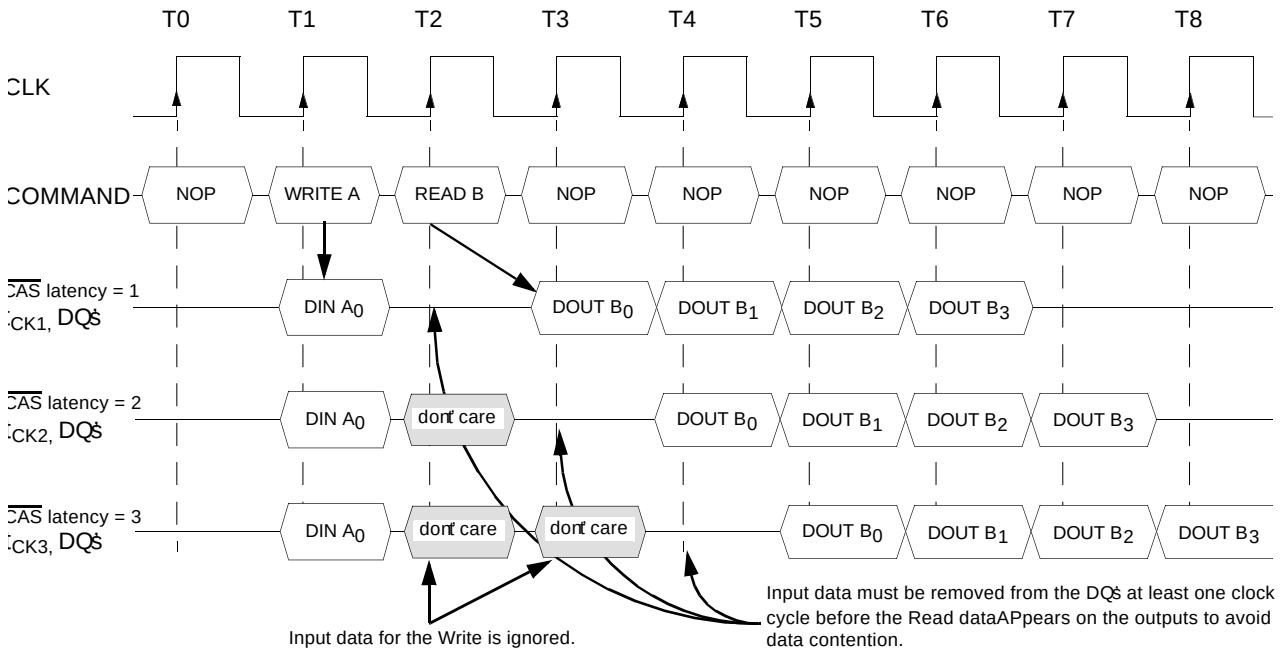
6.1 Write Interrupted by a Write

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, or 3)



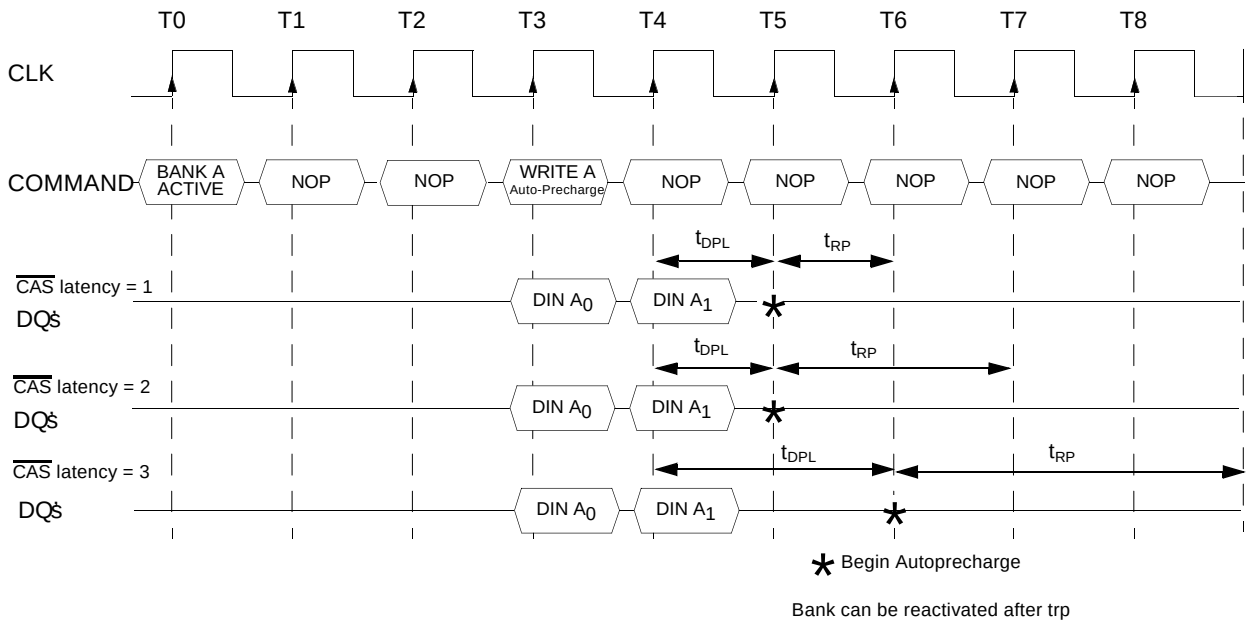
## 6.2 Write Interrupted by a Read

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, 3)



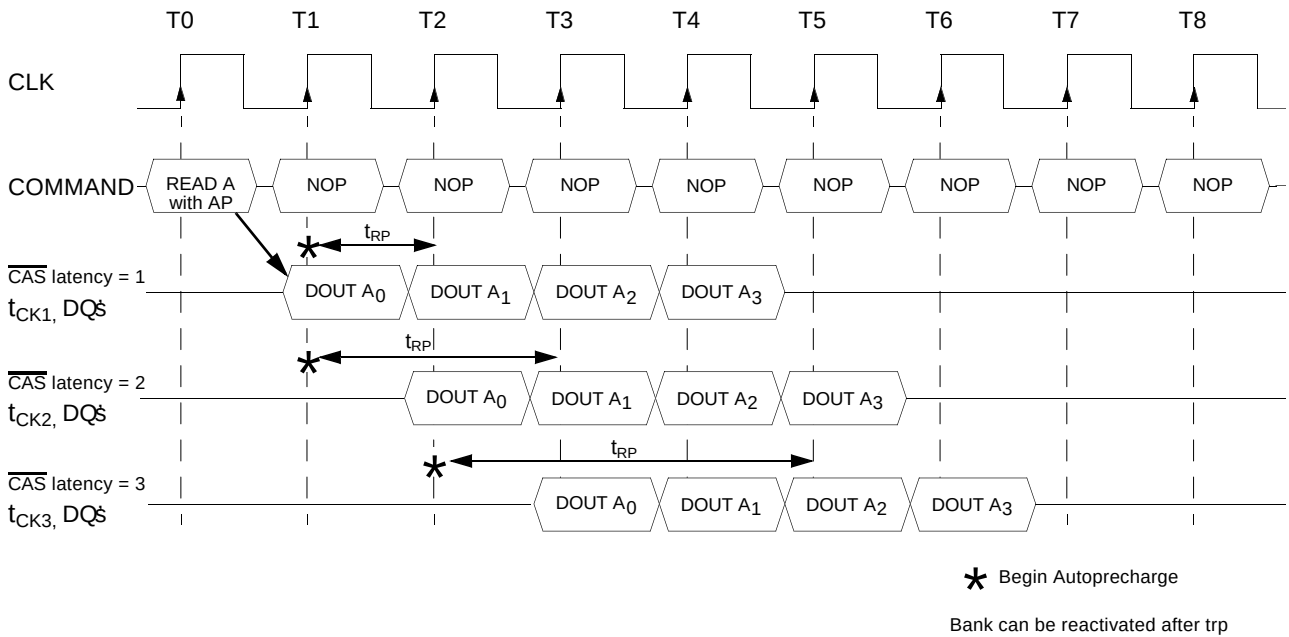
## 7.1 Burst Write with Auto-Precharge

Burst Length = 2,  $\overline{\text{CAS}}$  latency = 1, 2, 3)



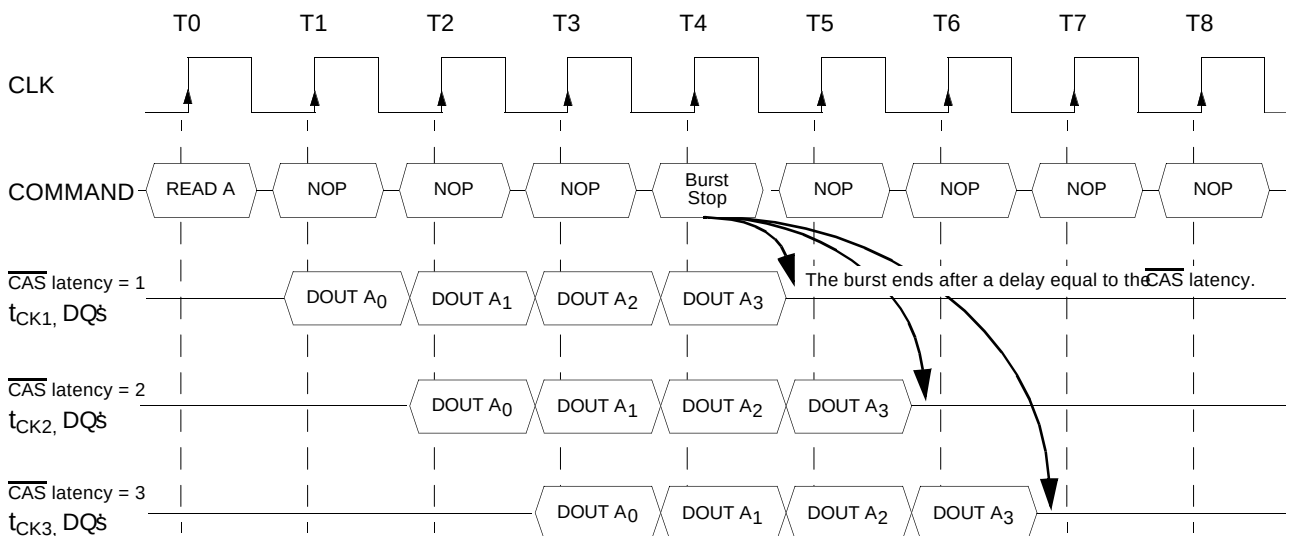
## 7.2 Burst Read with Auto-Precharge

(Burst Length = 4,  $\overline{\text{CAS}}$  latency = 1, 2, 3)



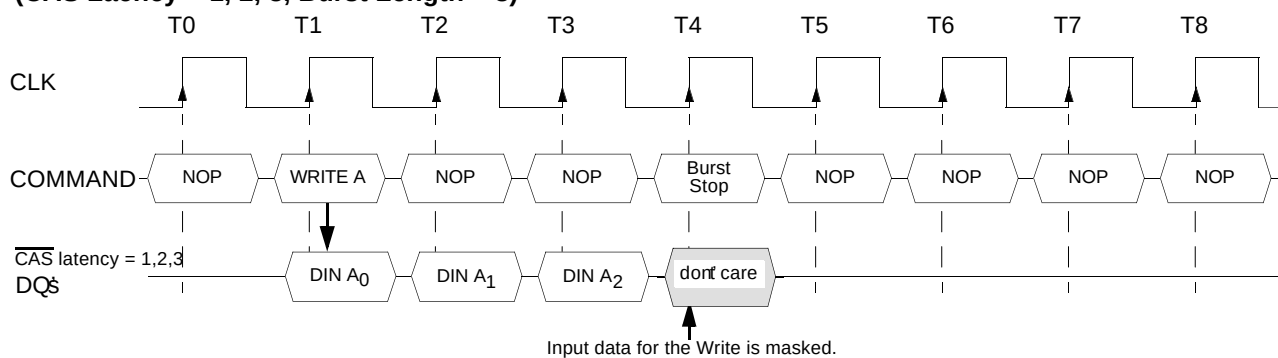
## 8.1 Termination of a Burst Read Operation

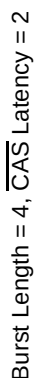
( $\overline{\text{CAS}}$  latency = 1, 2, 3 / Burst Length = 8)



## 8.2 Termination of a Burst Write Operation

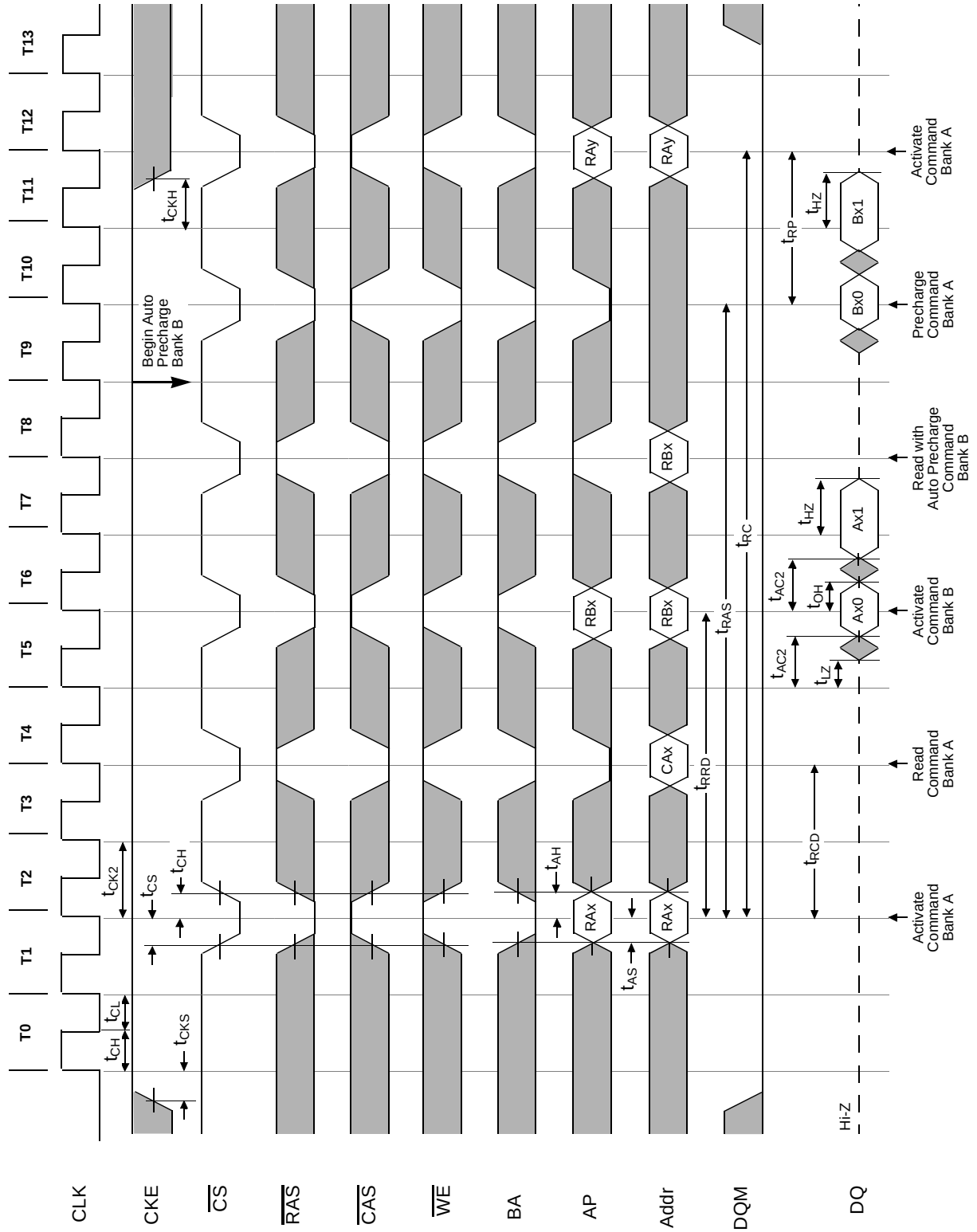
(CAS Latency = 1, 2, 3, Burst Length = 8)



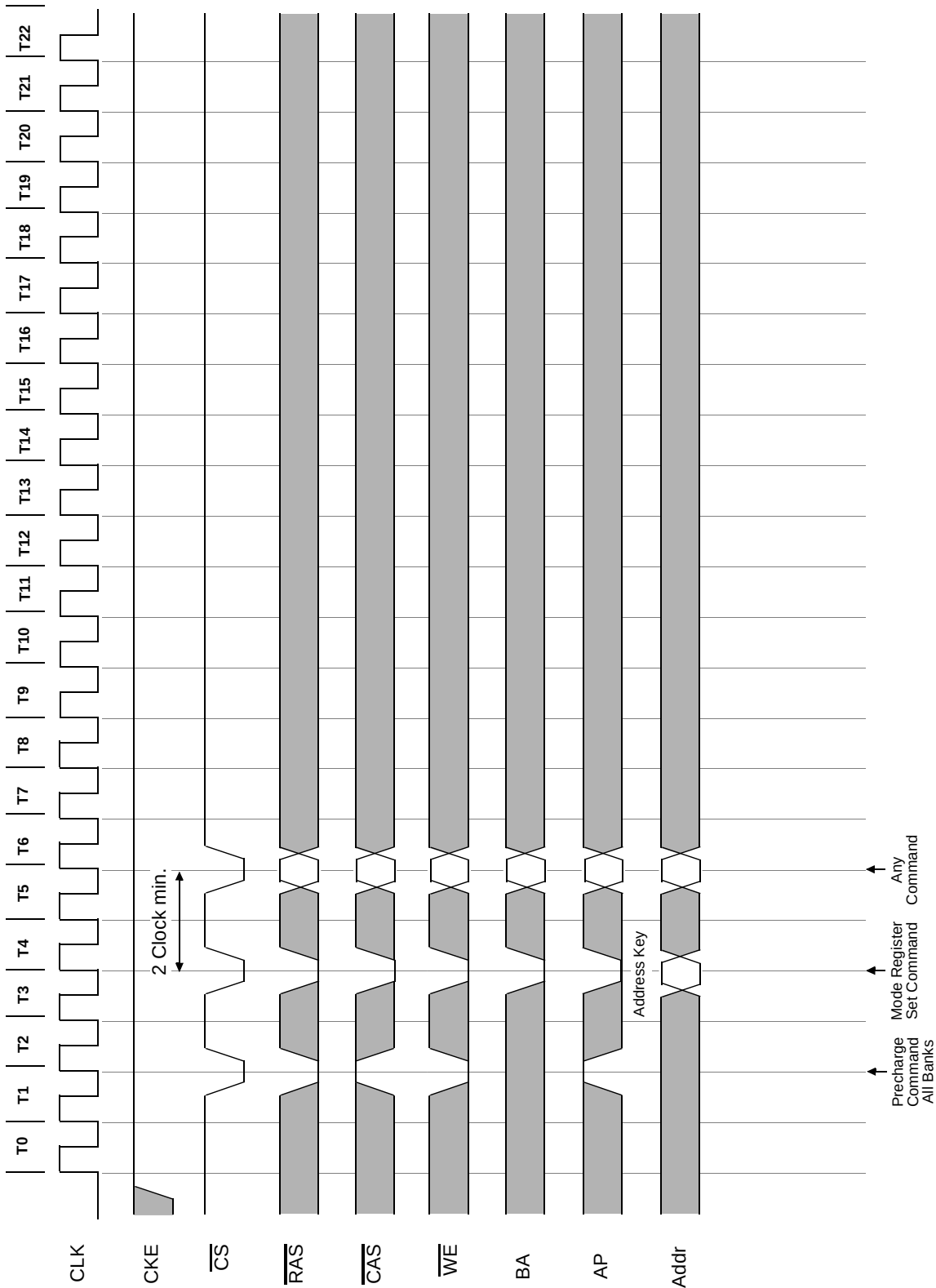
Burst Length = 4,  $\overline{\text{CAS Latency}} = 2$ 

## 9.2 AC Parameters for Read Timing

Burst Length = 2, CAS Latency = 2

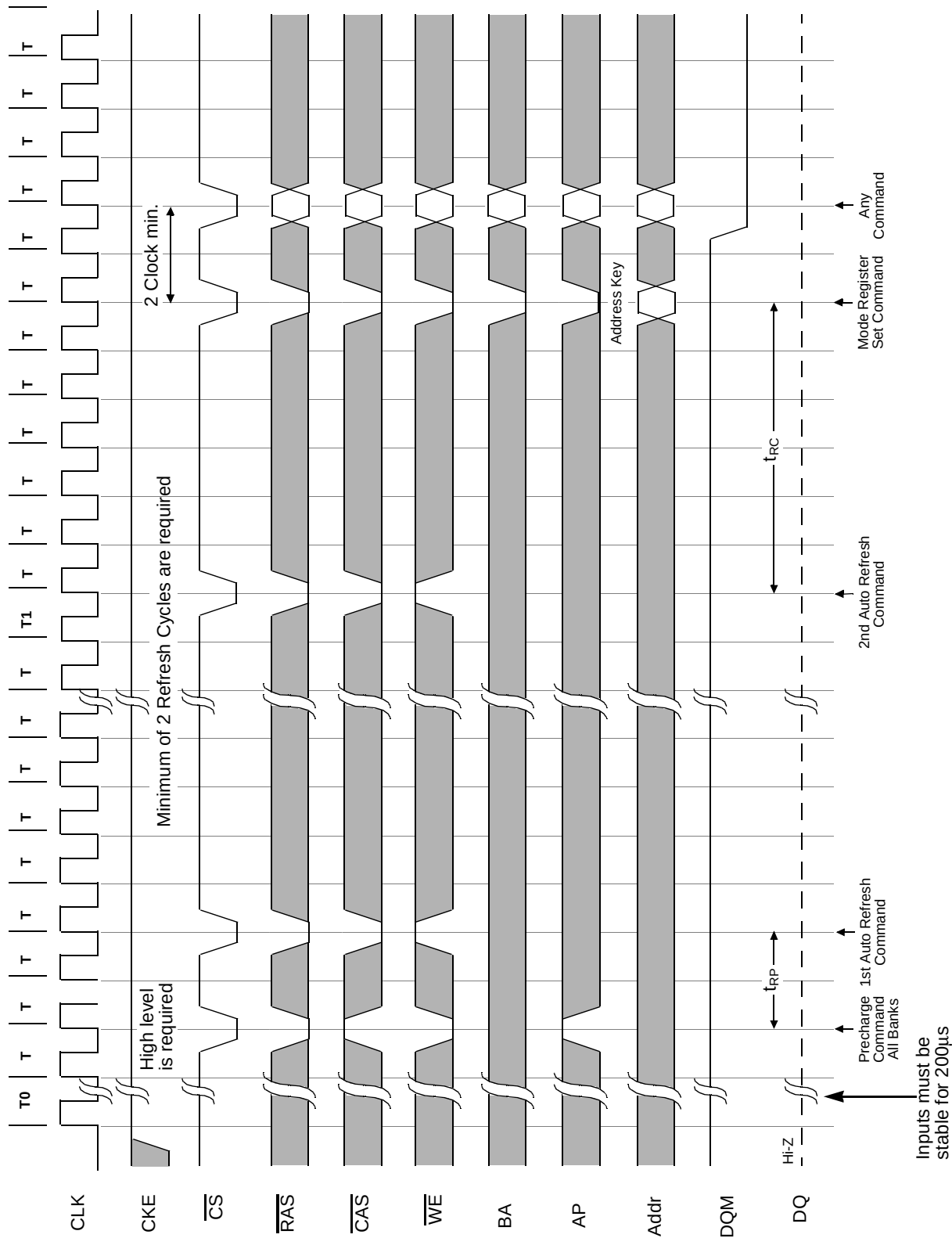


10. Mode Register Set

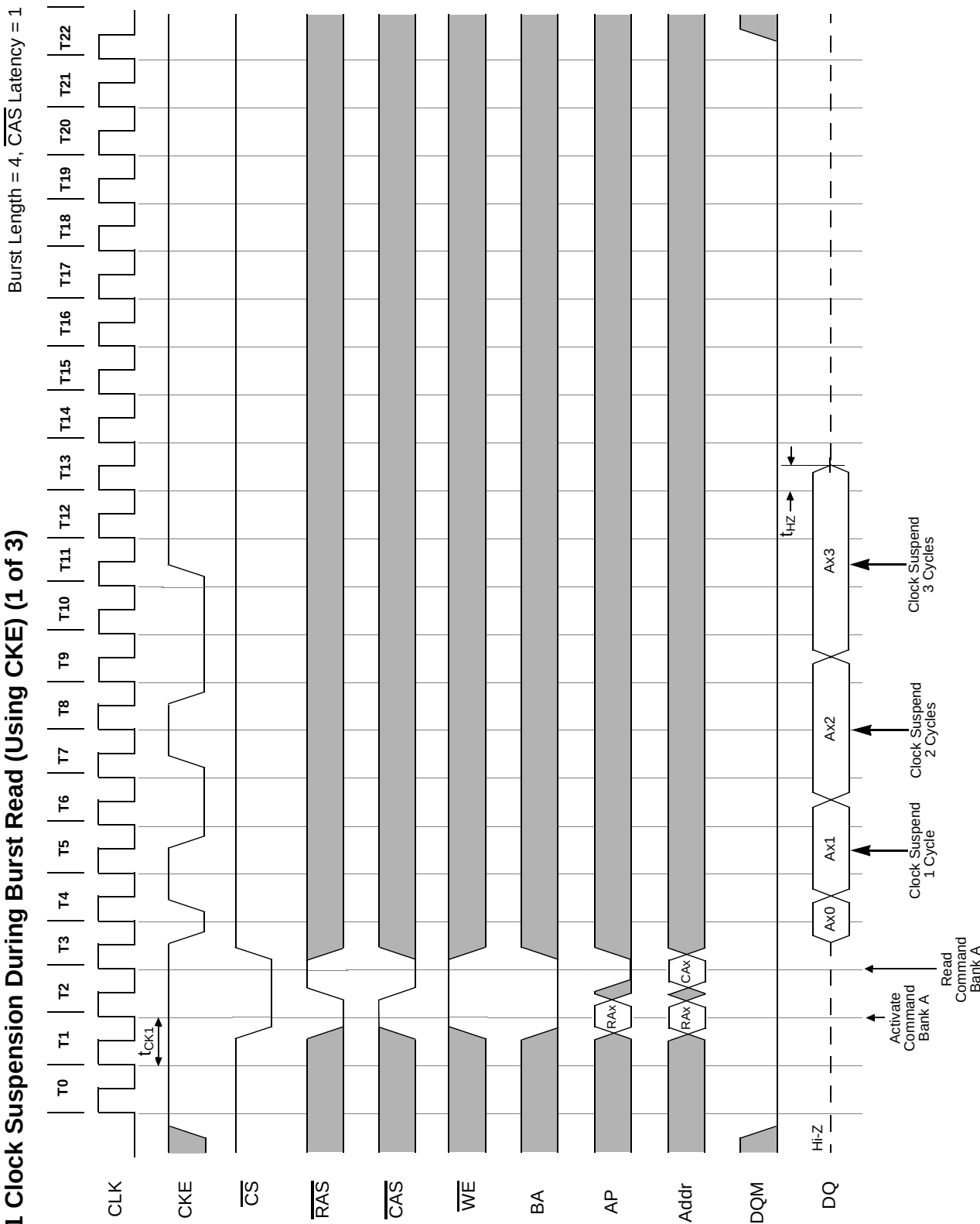


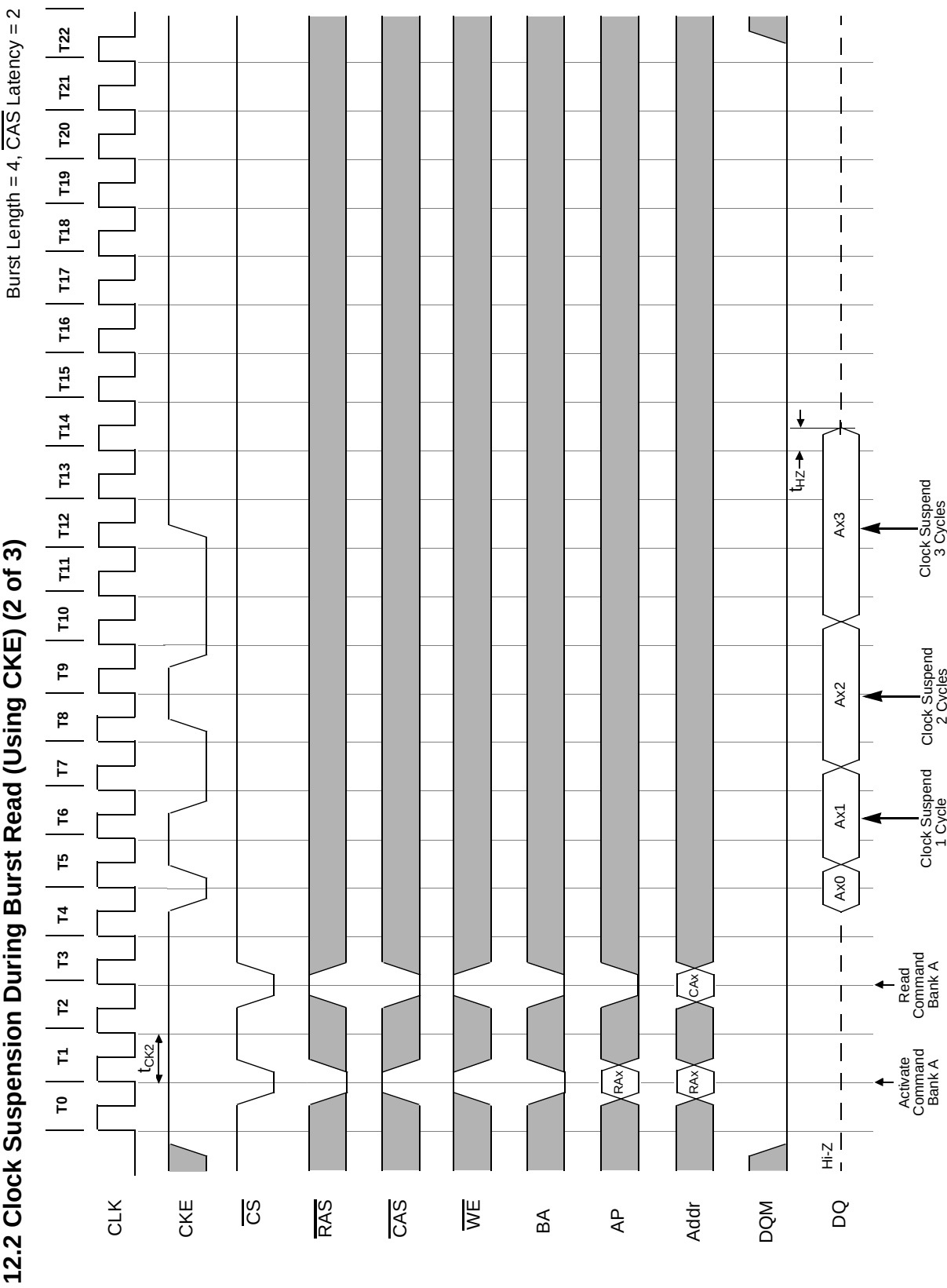


11. Power on Sequence and Auto Refresh (CBR)

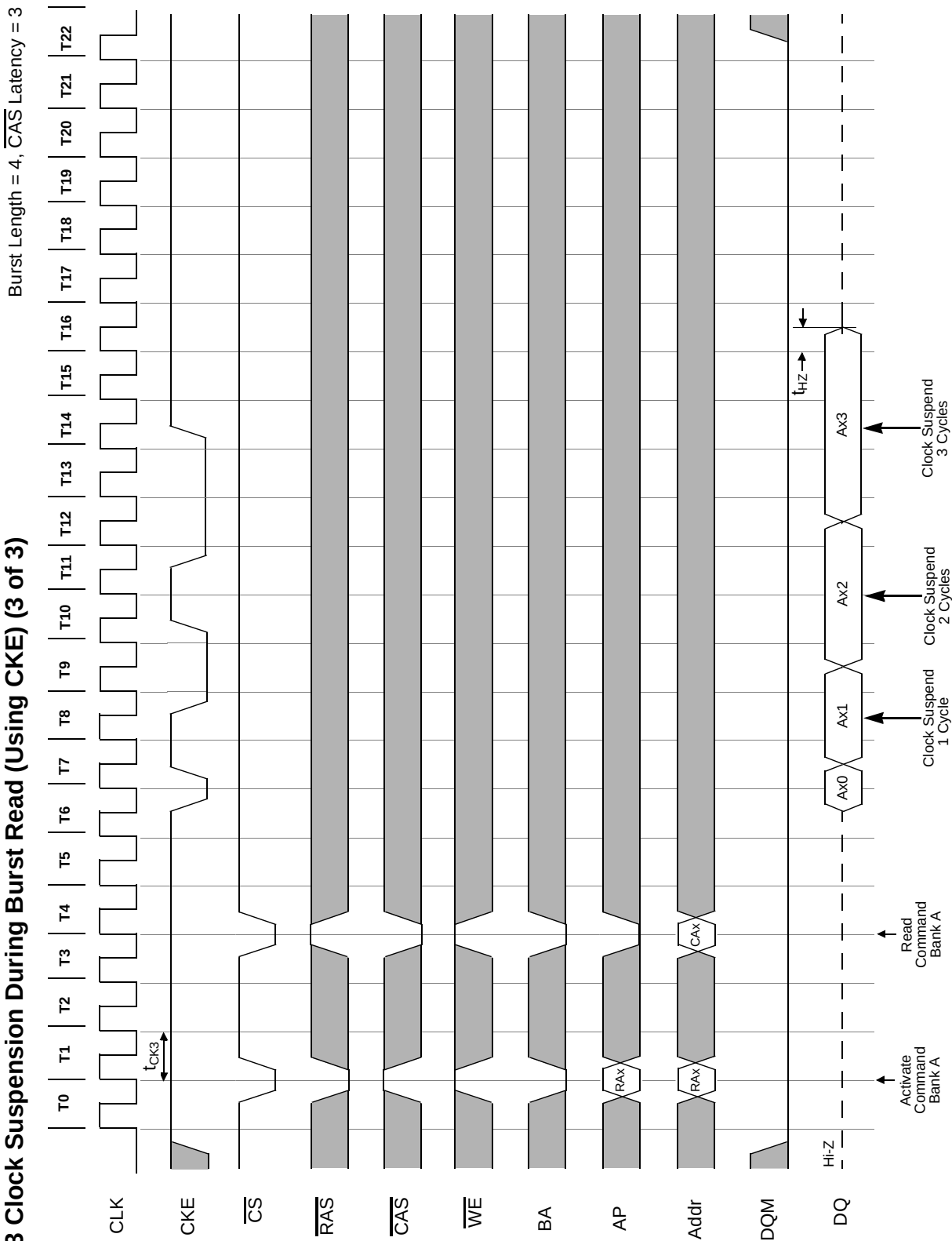


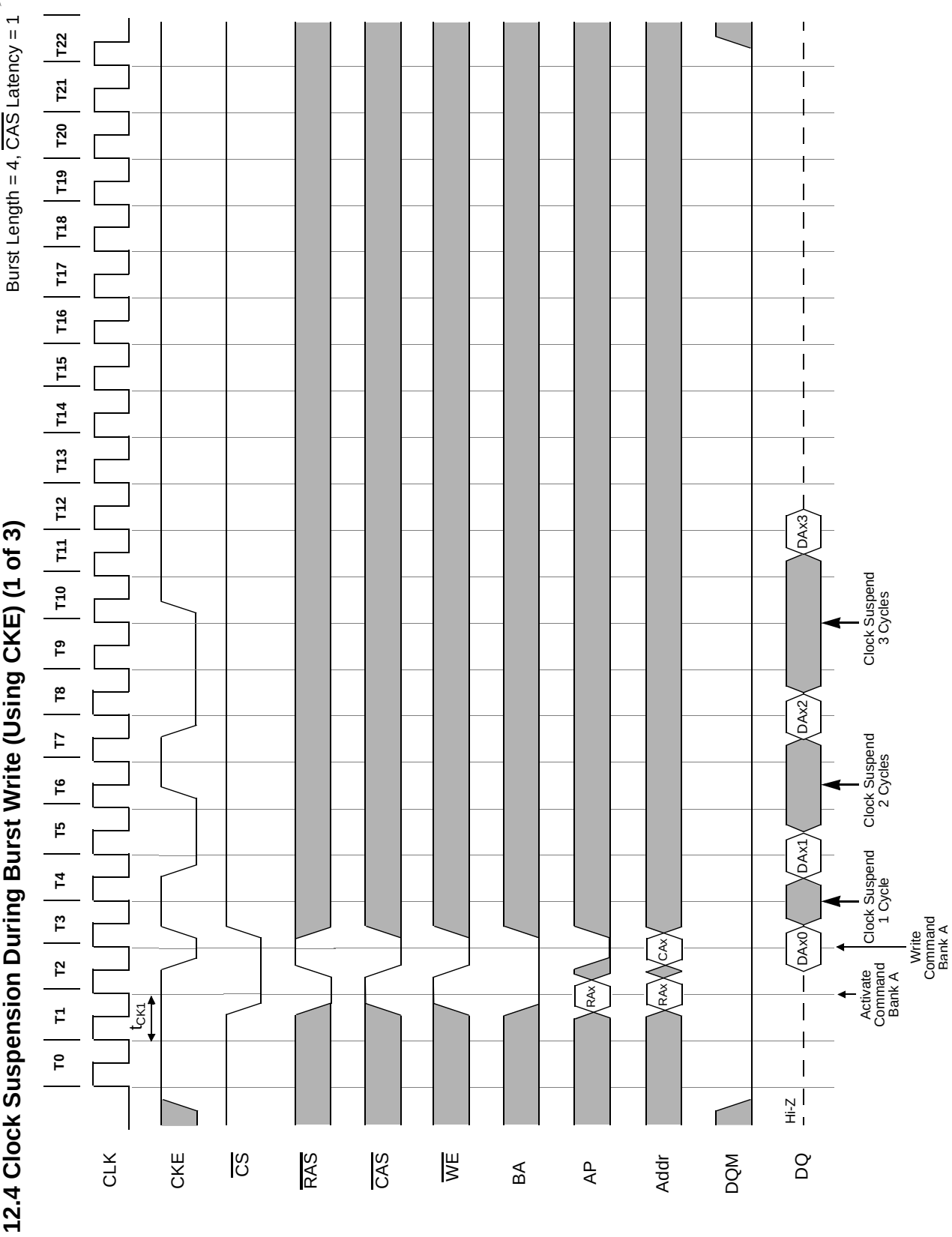
12.1 Clock Suspension During Burst Read (Using CKE) (1 of 3)



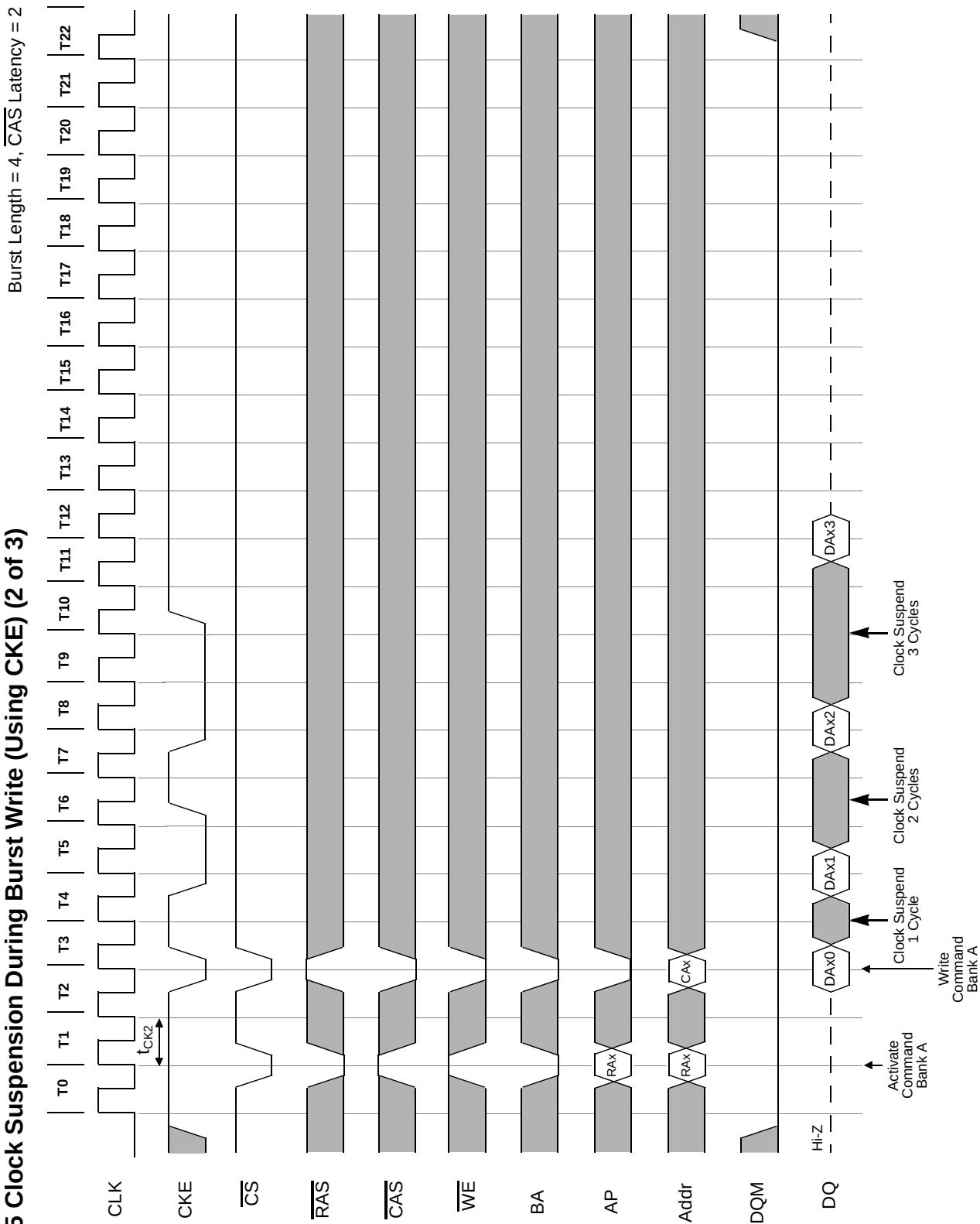


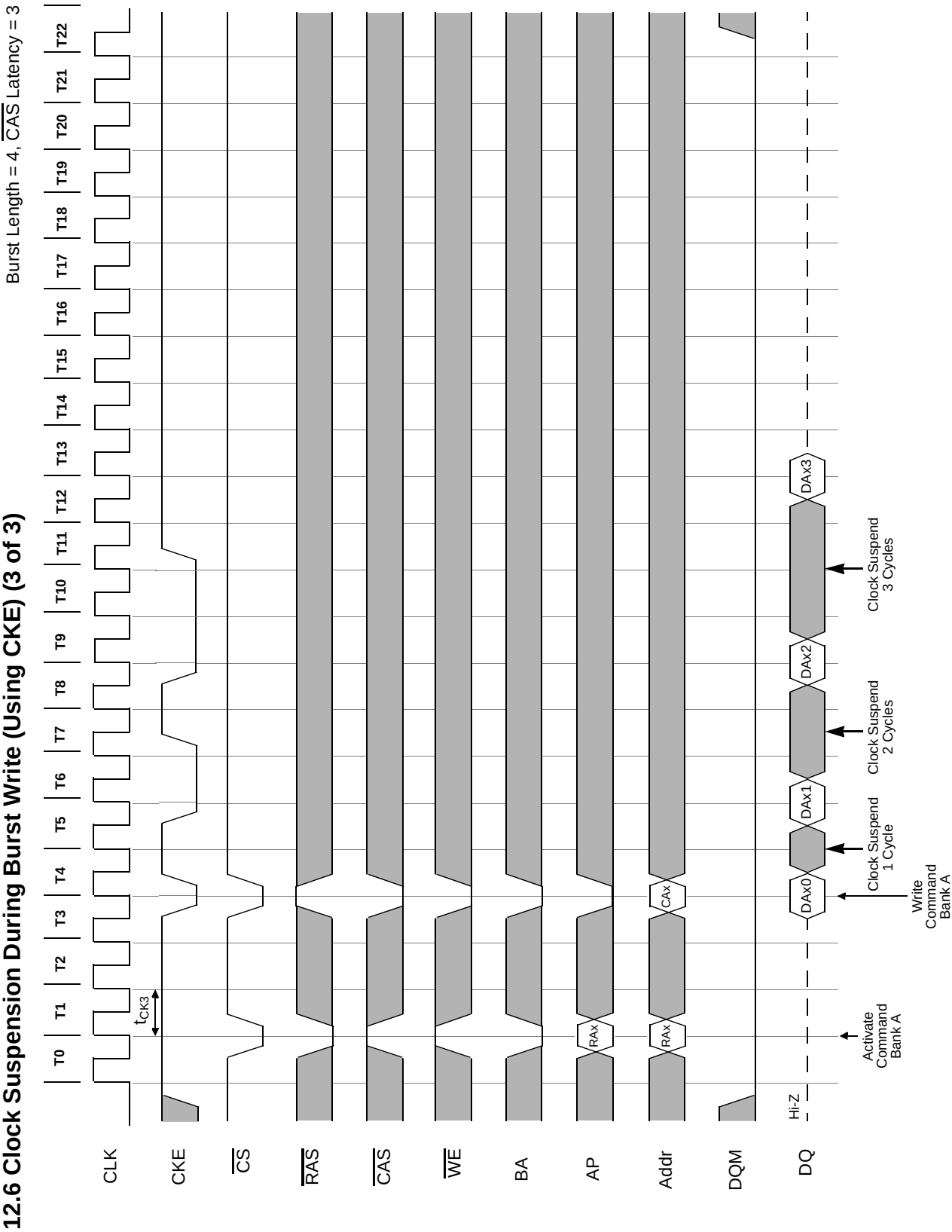
12.3 Clock Suspension During Burst Read (Using CKE) (3 of 3)



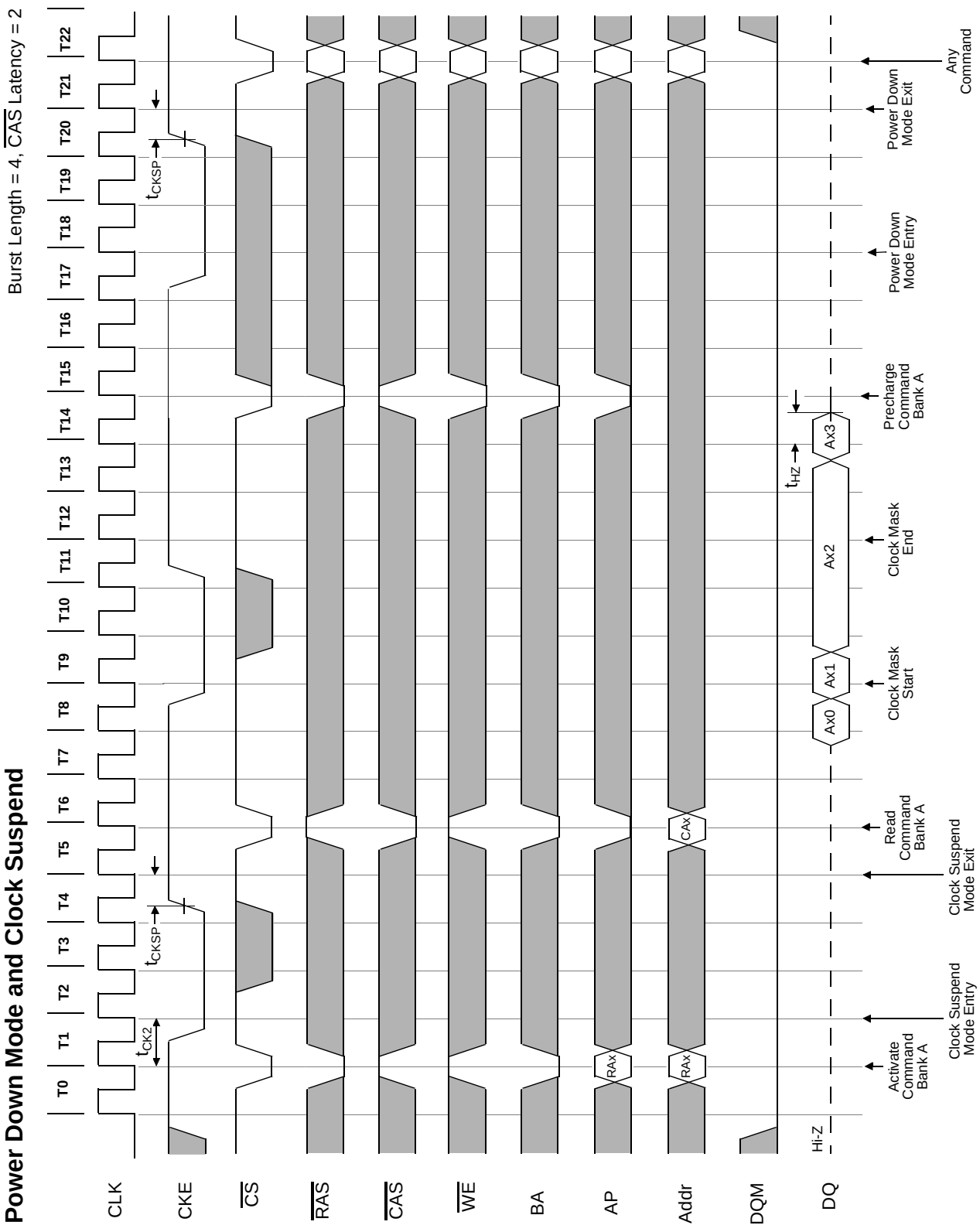


12.5 Clock Suspension During Burst Write (Using CKE) (2 of 3)

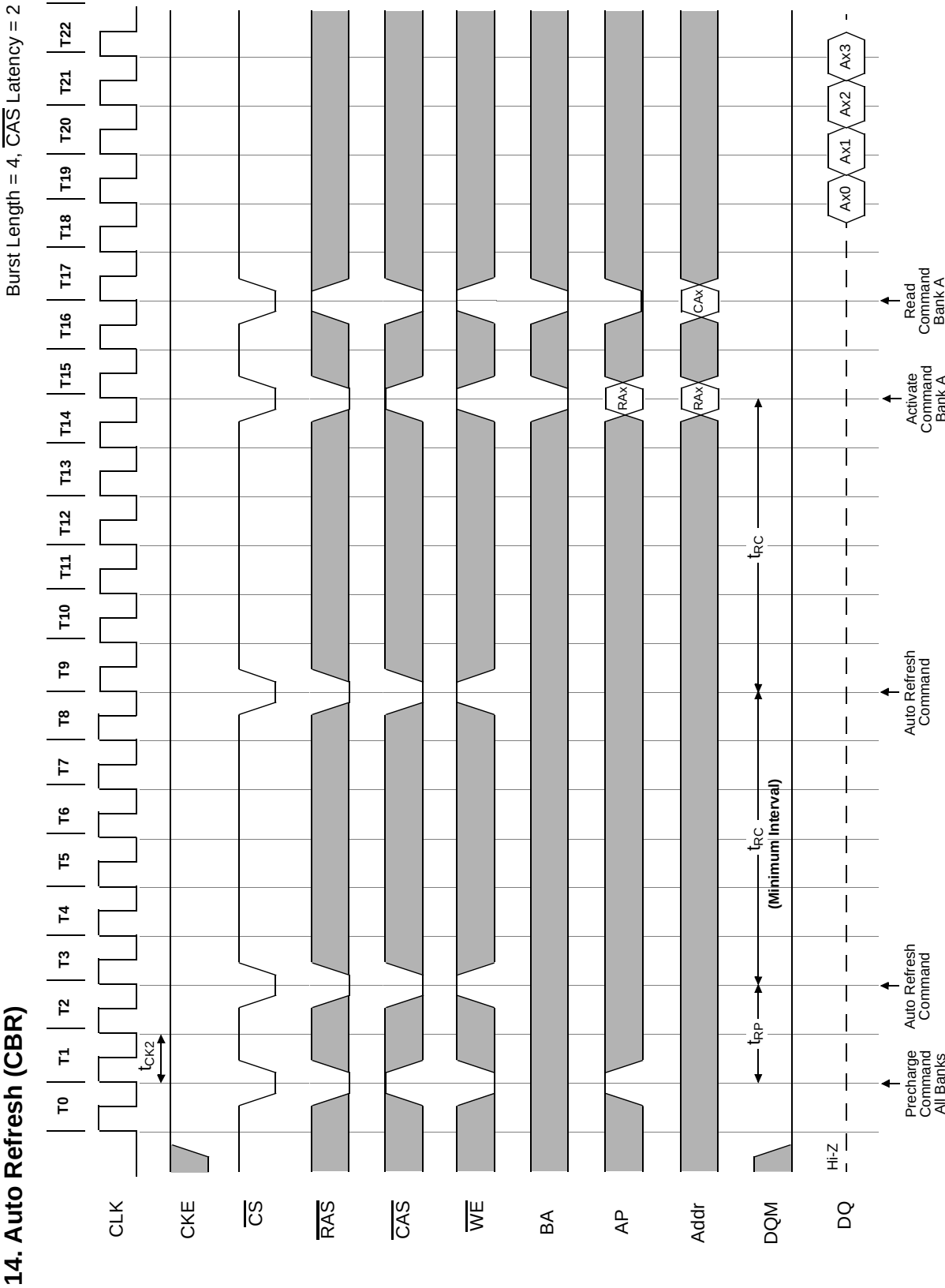




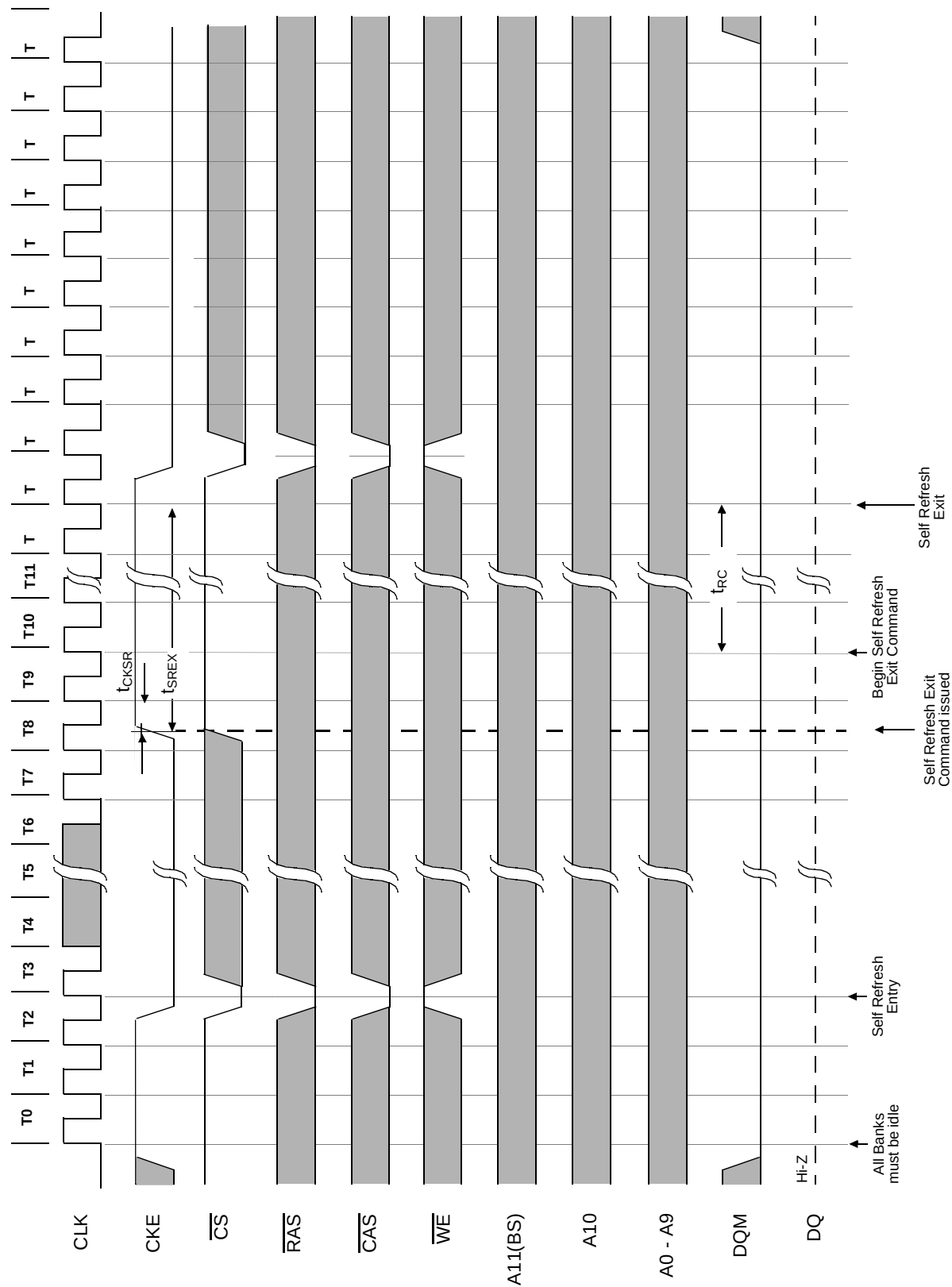
13. Power Down Mode and Clock Suspend

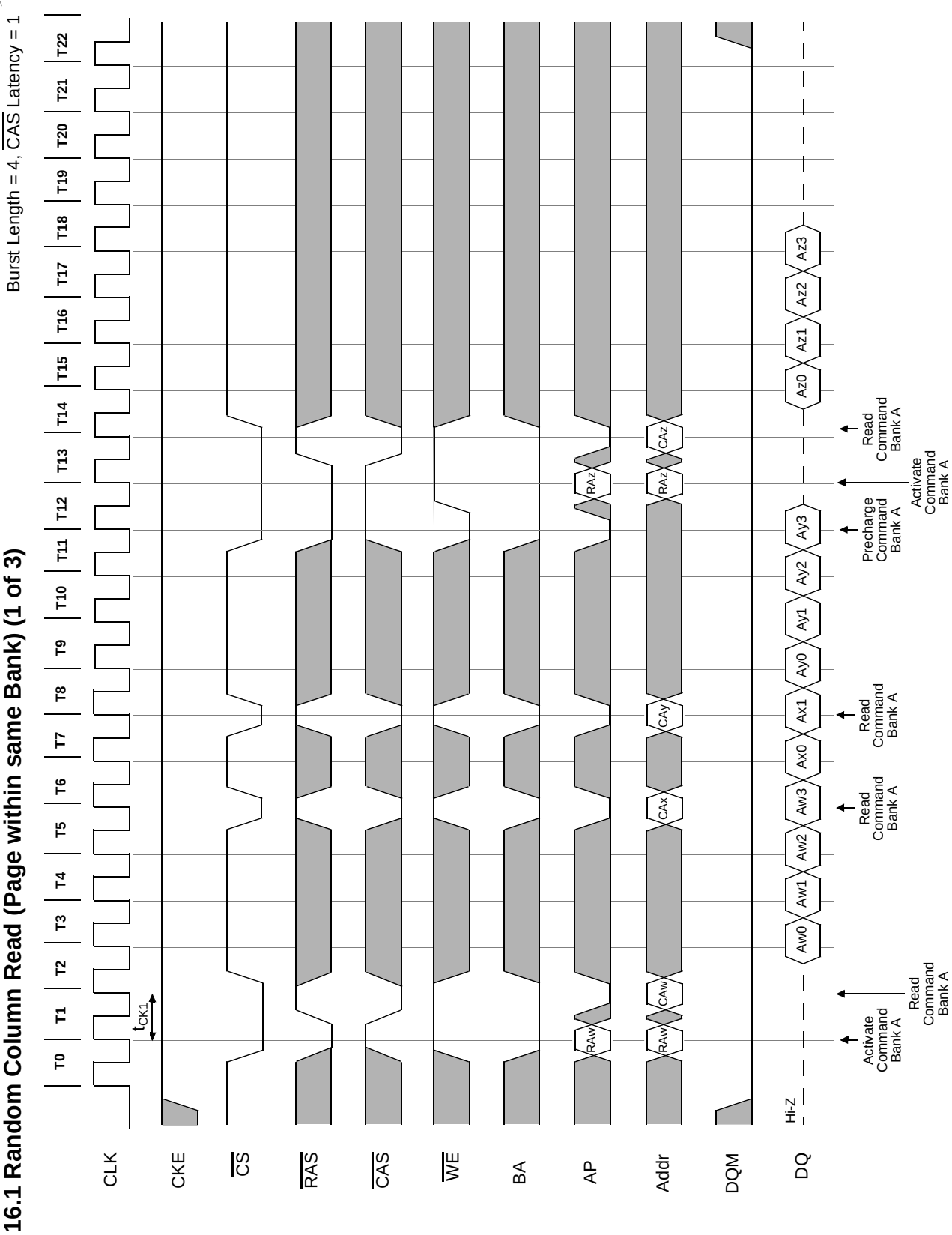




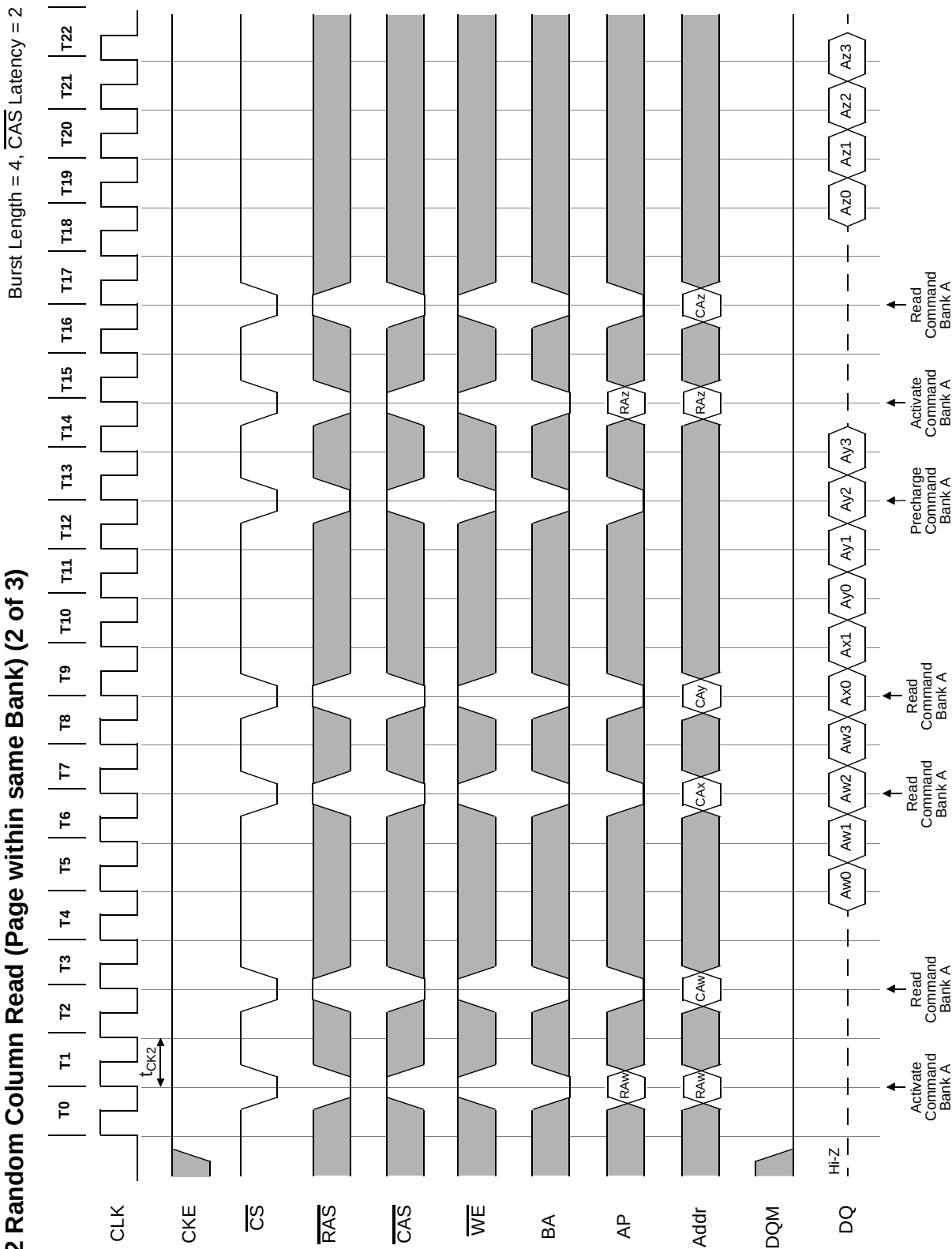


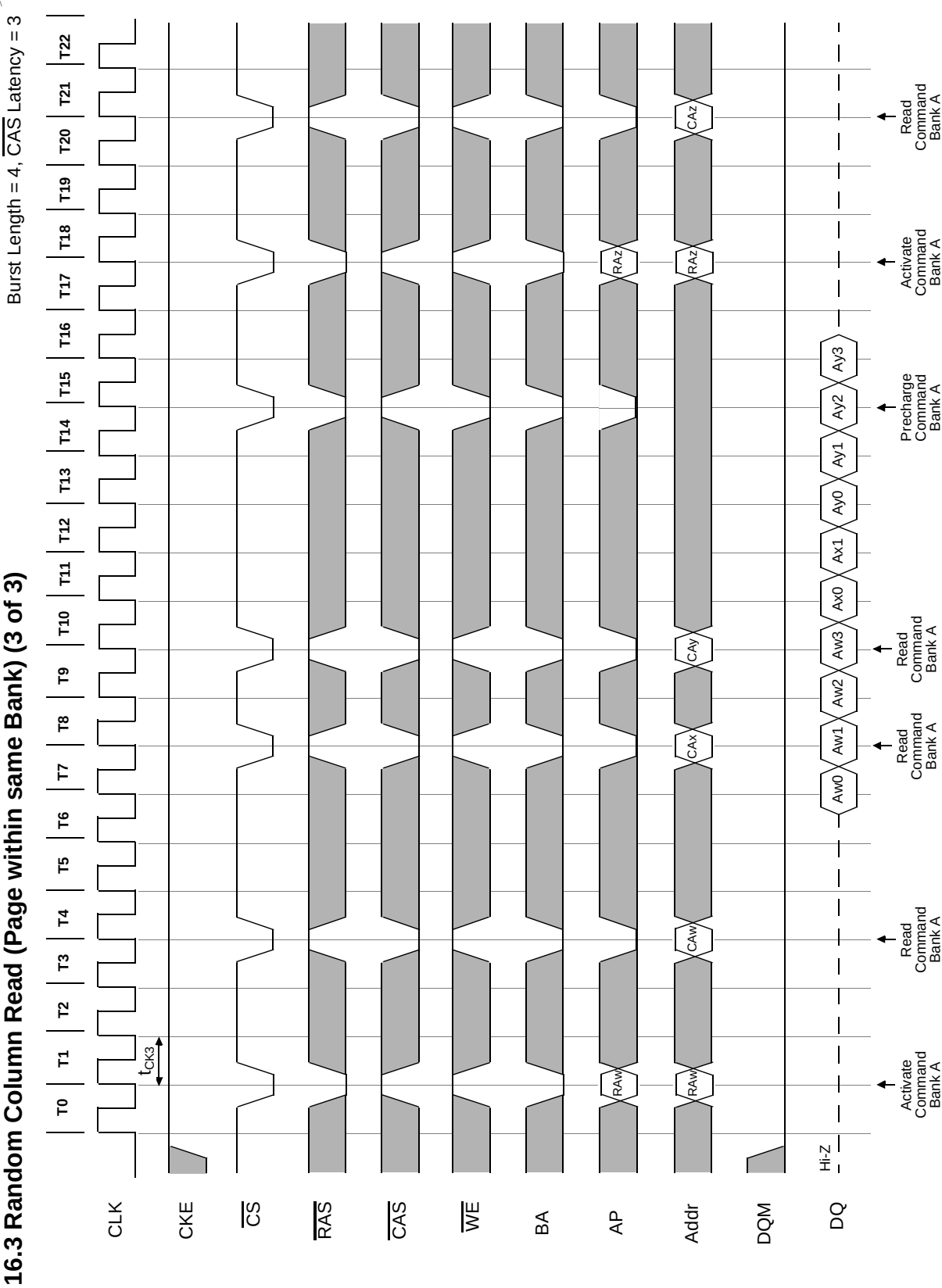
15. Self Refresh (Entry and Exit)



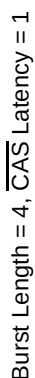


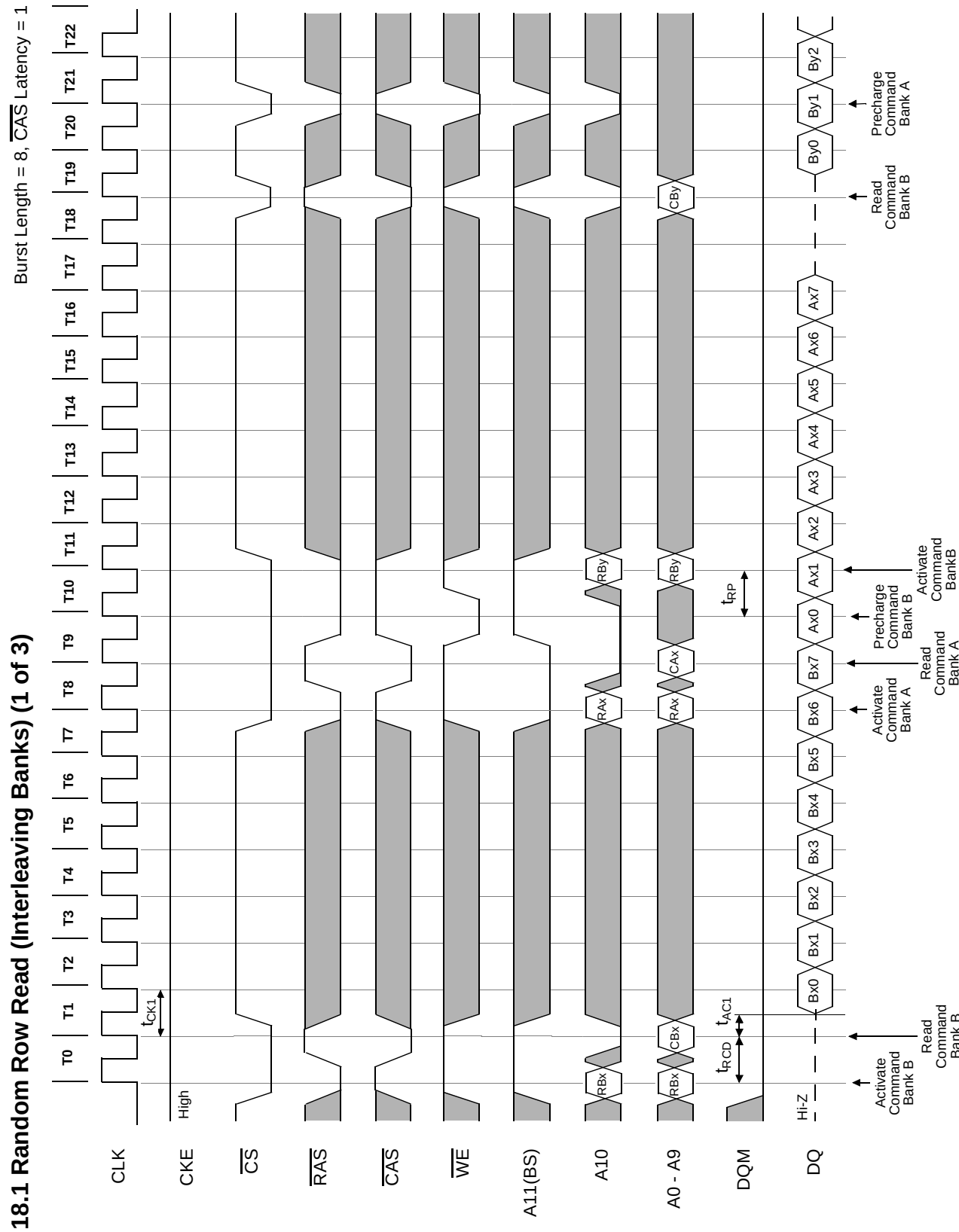
16.2 Random Column Read (Page within same Bank) (2 of 3)

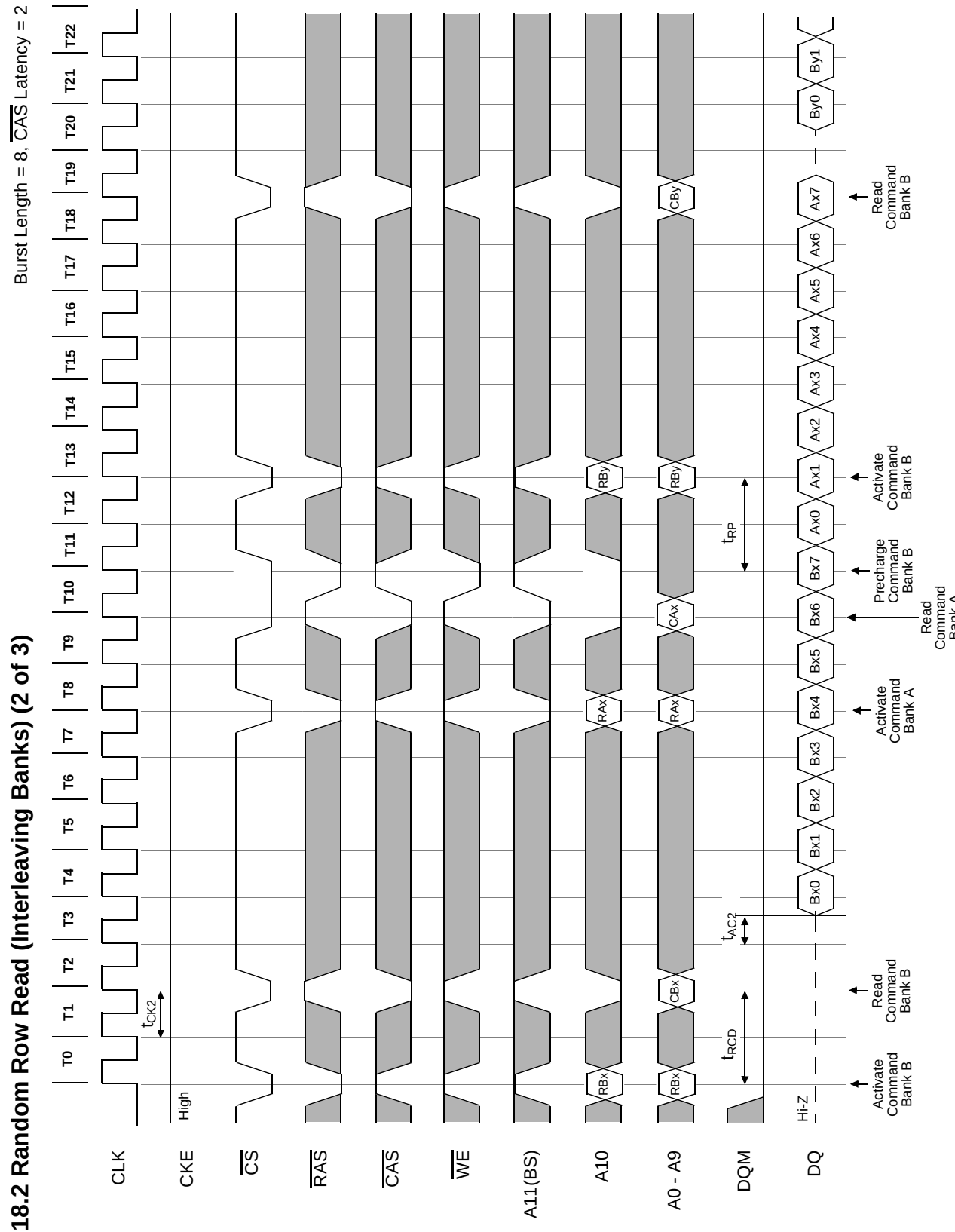




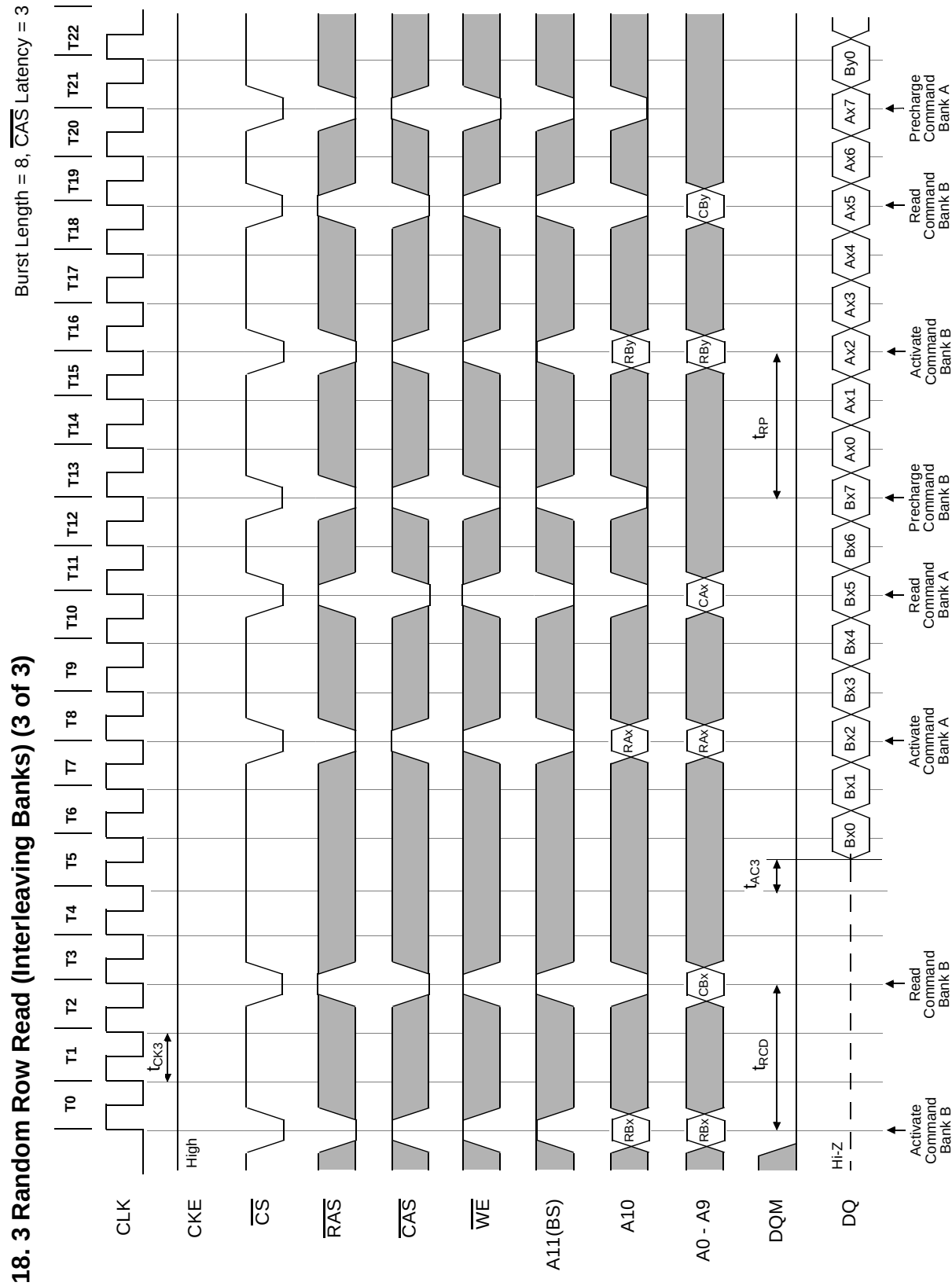
Burst Length = 4,  $\overline{\text{CAS Latency}} = 1$

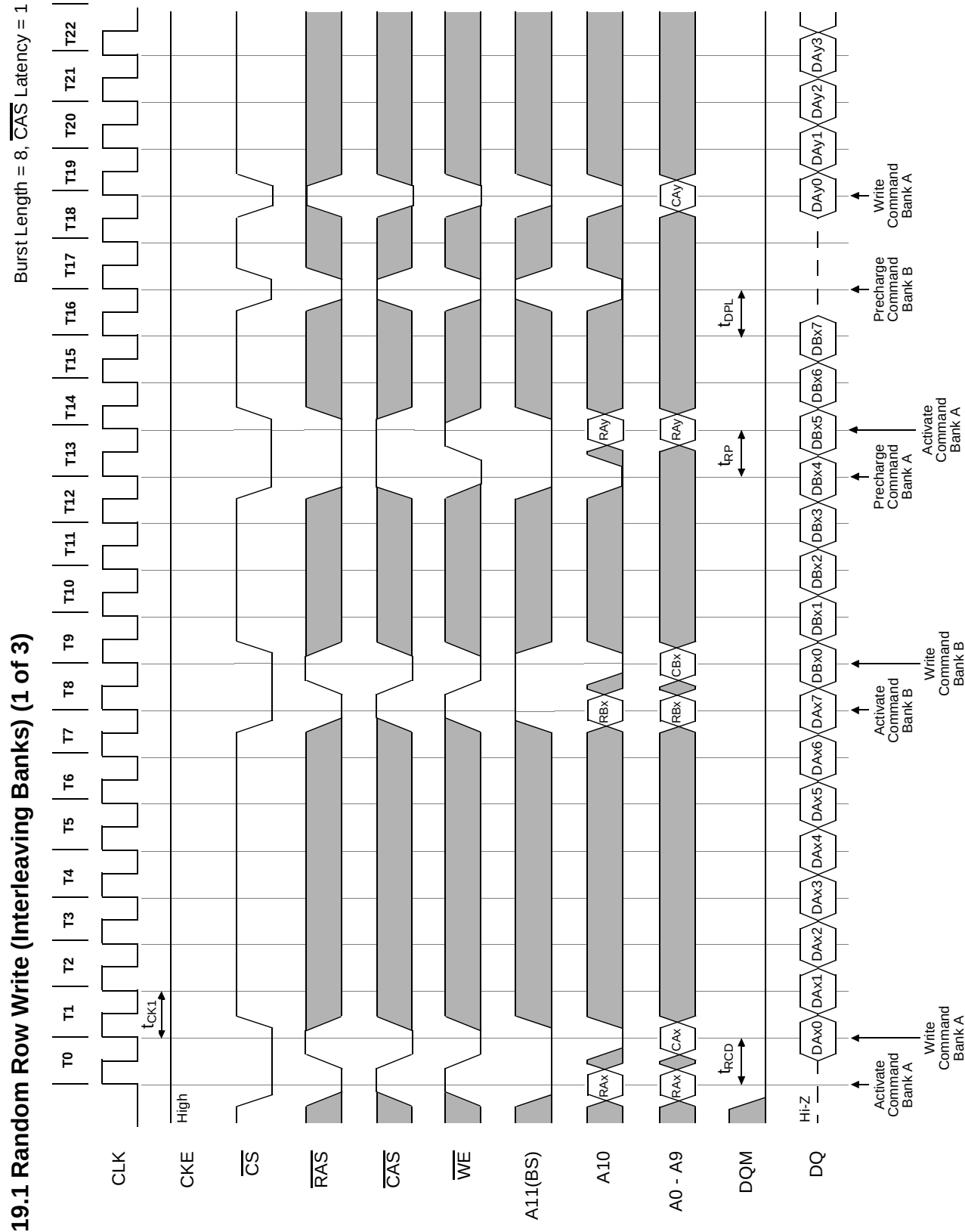


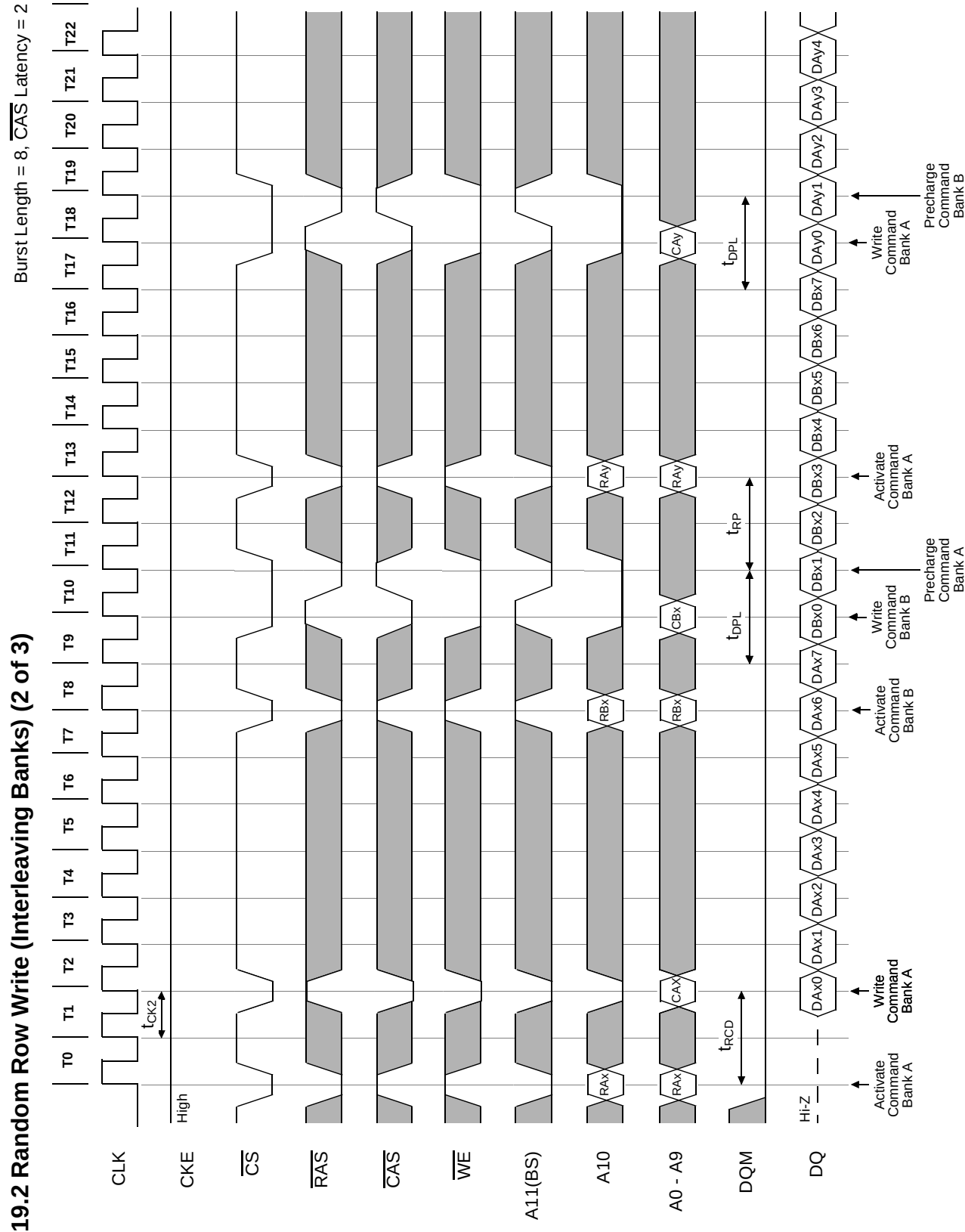


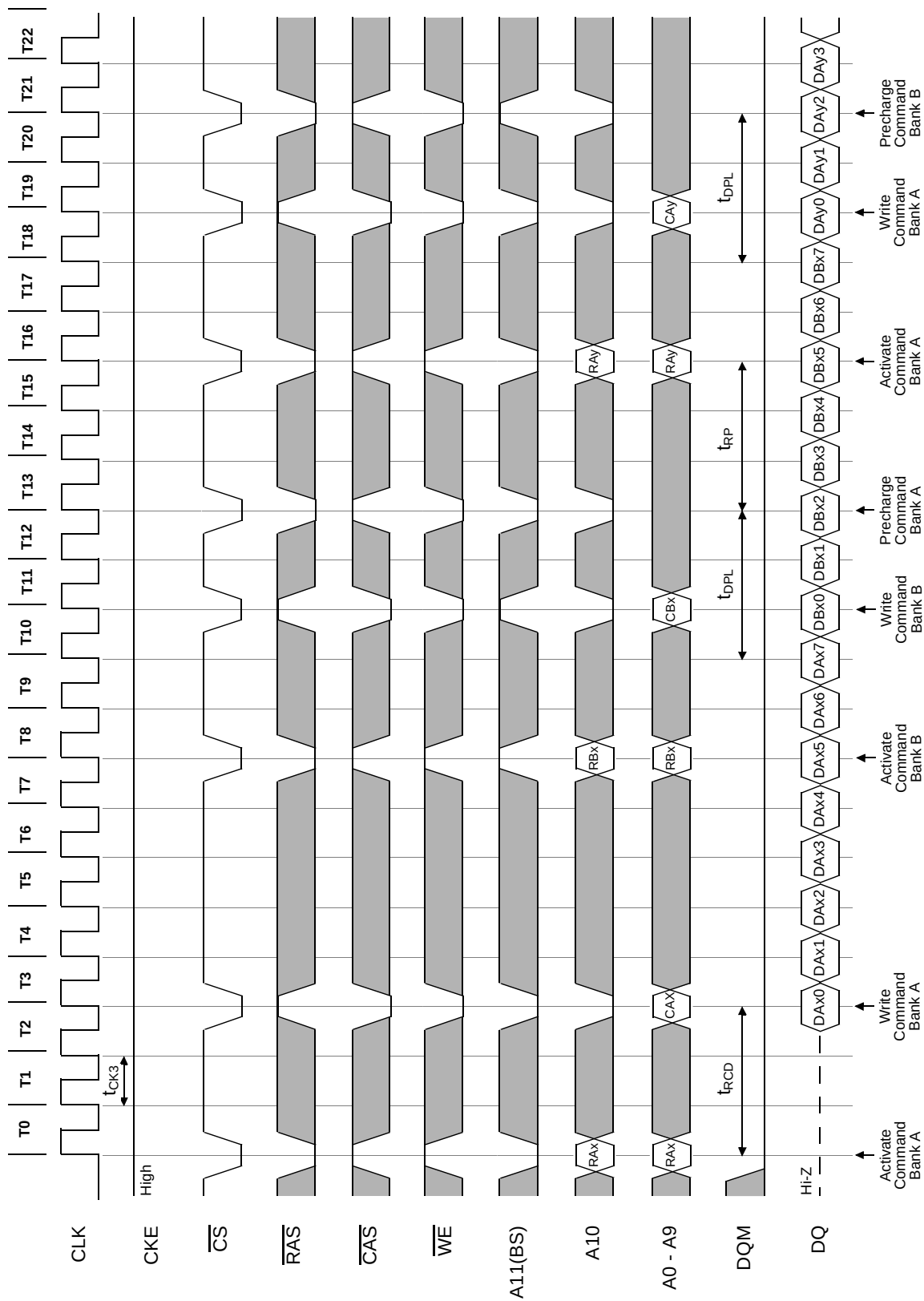


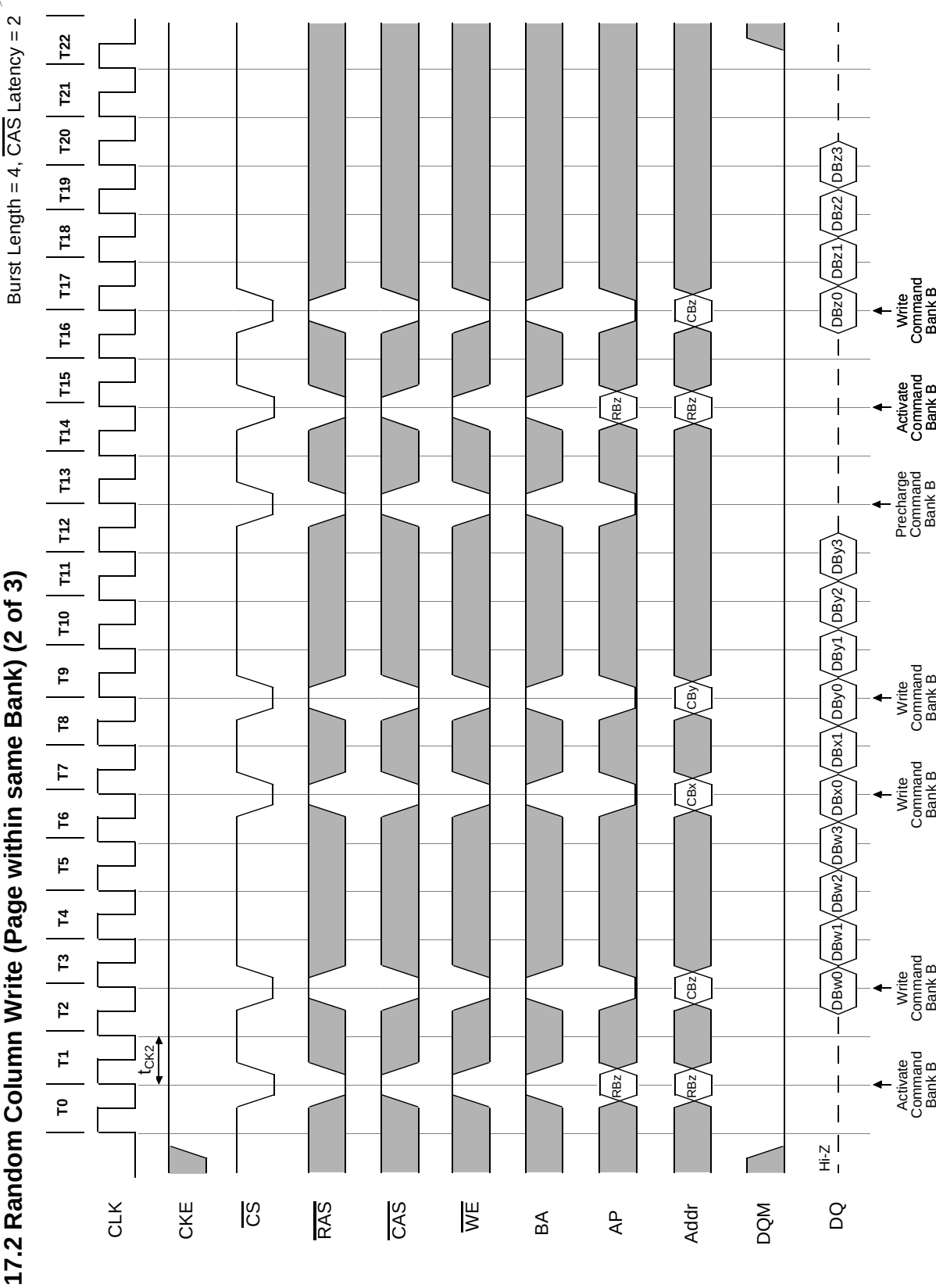


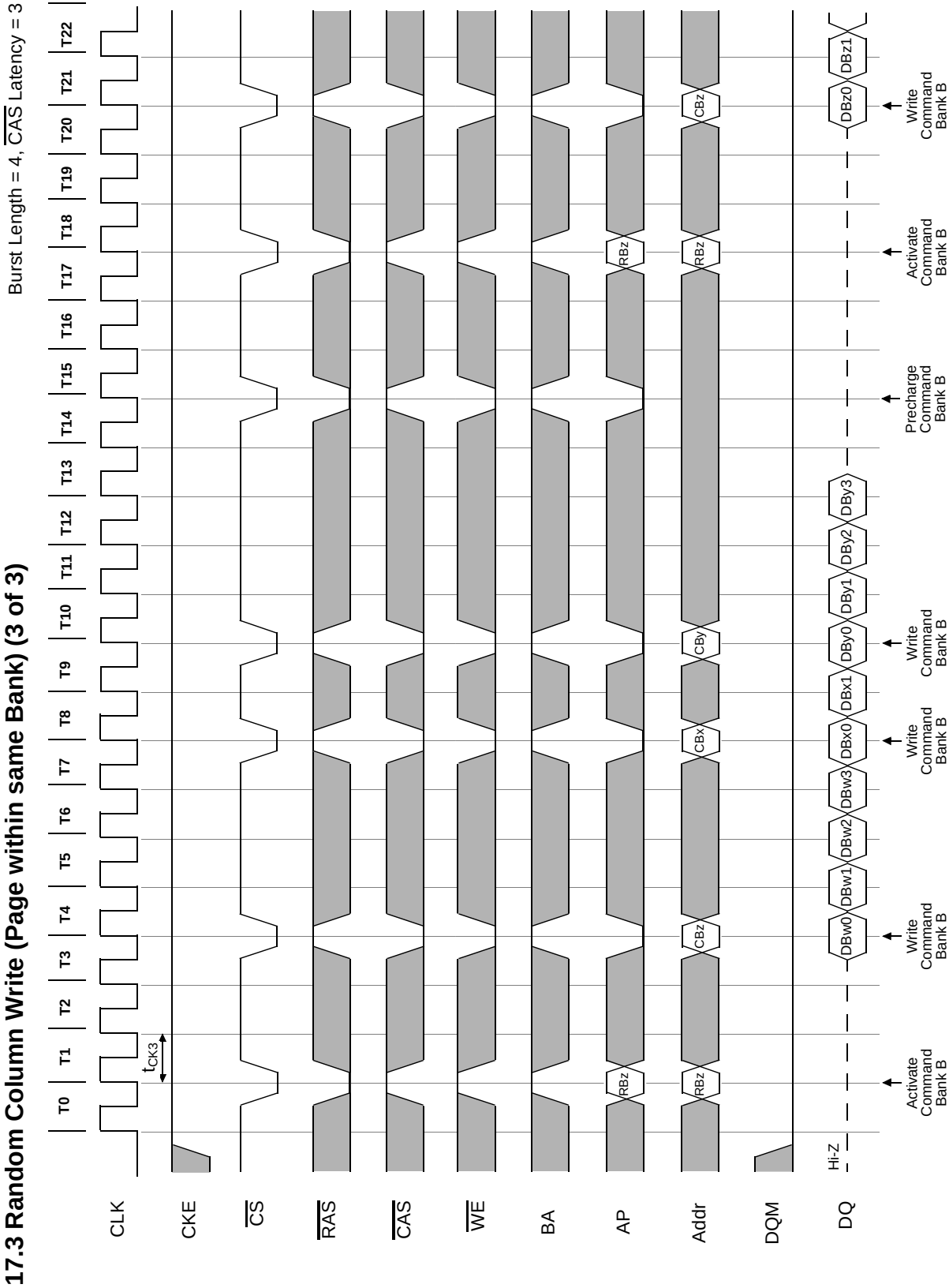


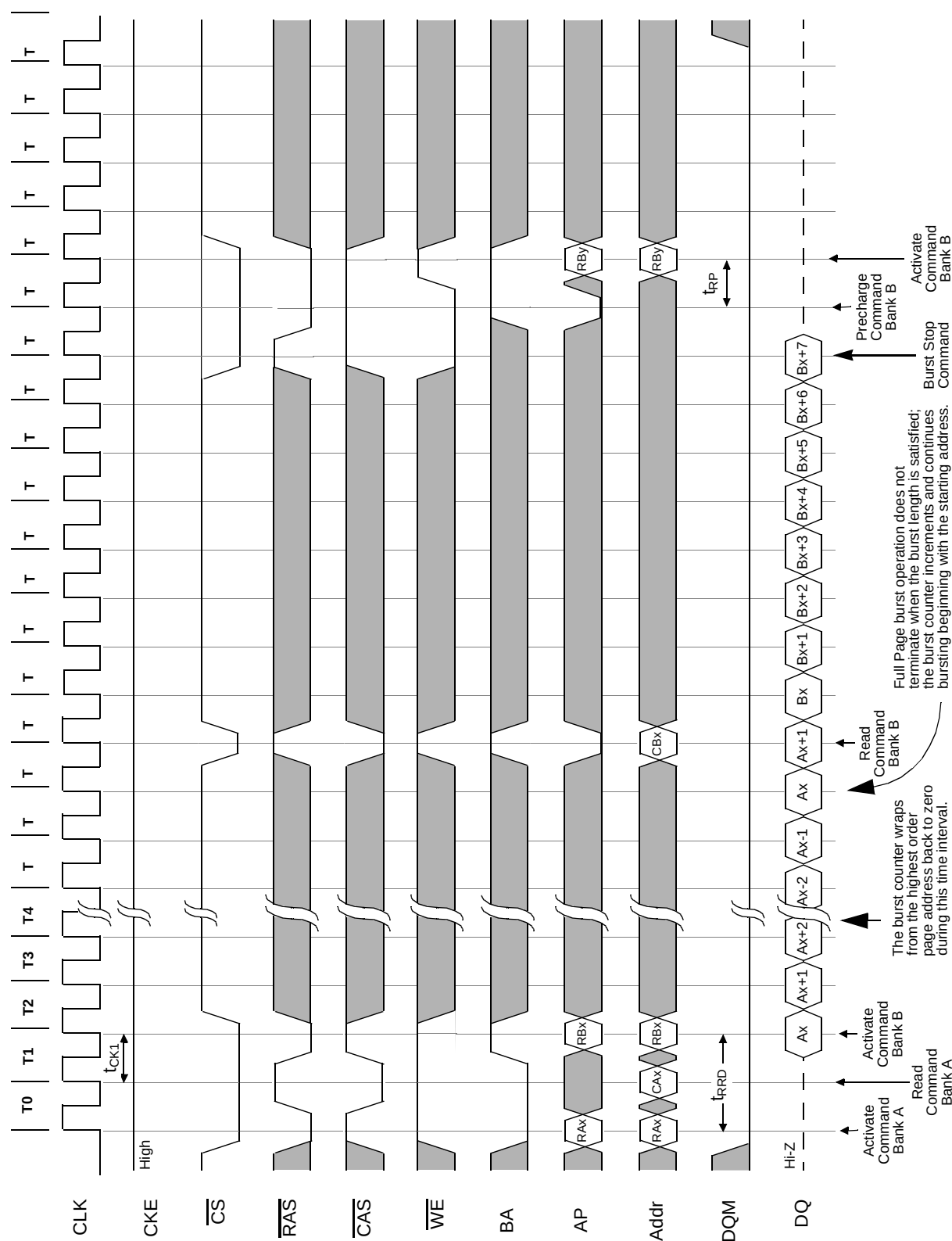




Burst Length = 8, CAS Latency = 3

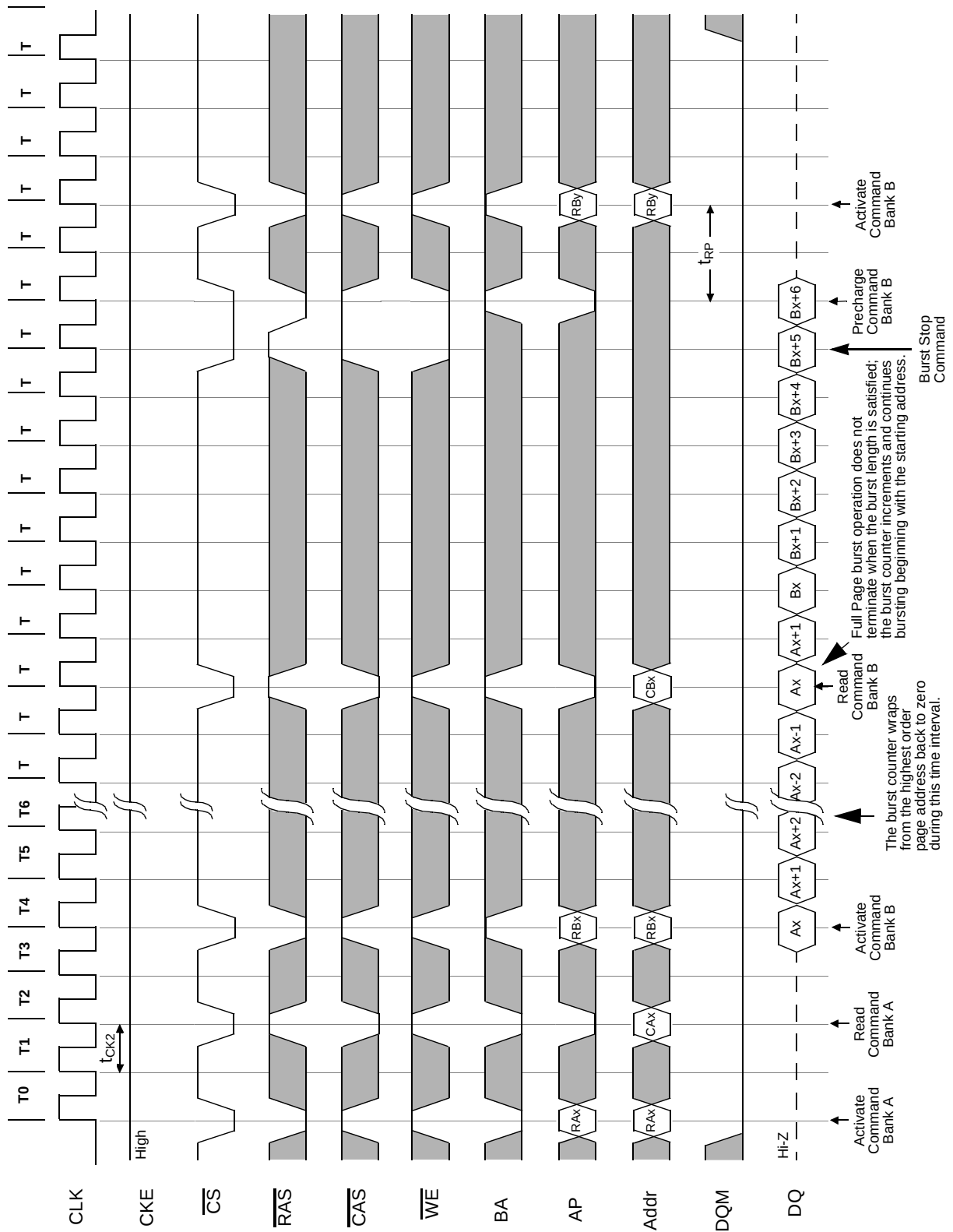




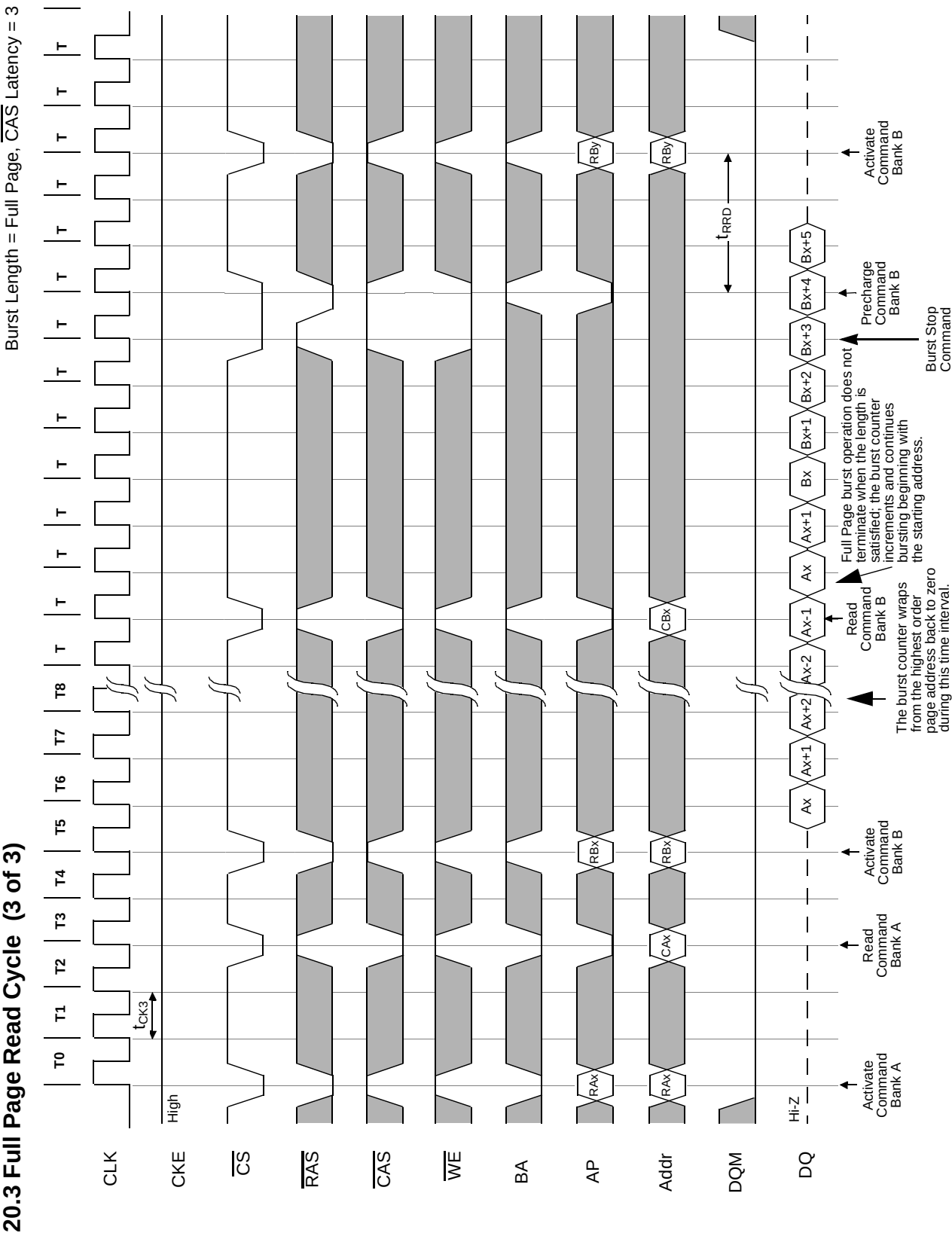
Burst Length = Full Page, CAS Latency = 1

## 20.2 Full Page Read Cycle (2 of 3)

Burst Length = Full Page,  $\overline{\text{CAS}}$  Latency = 2

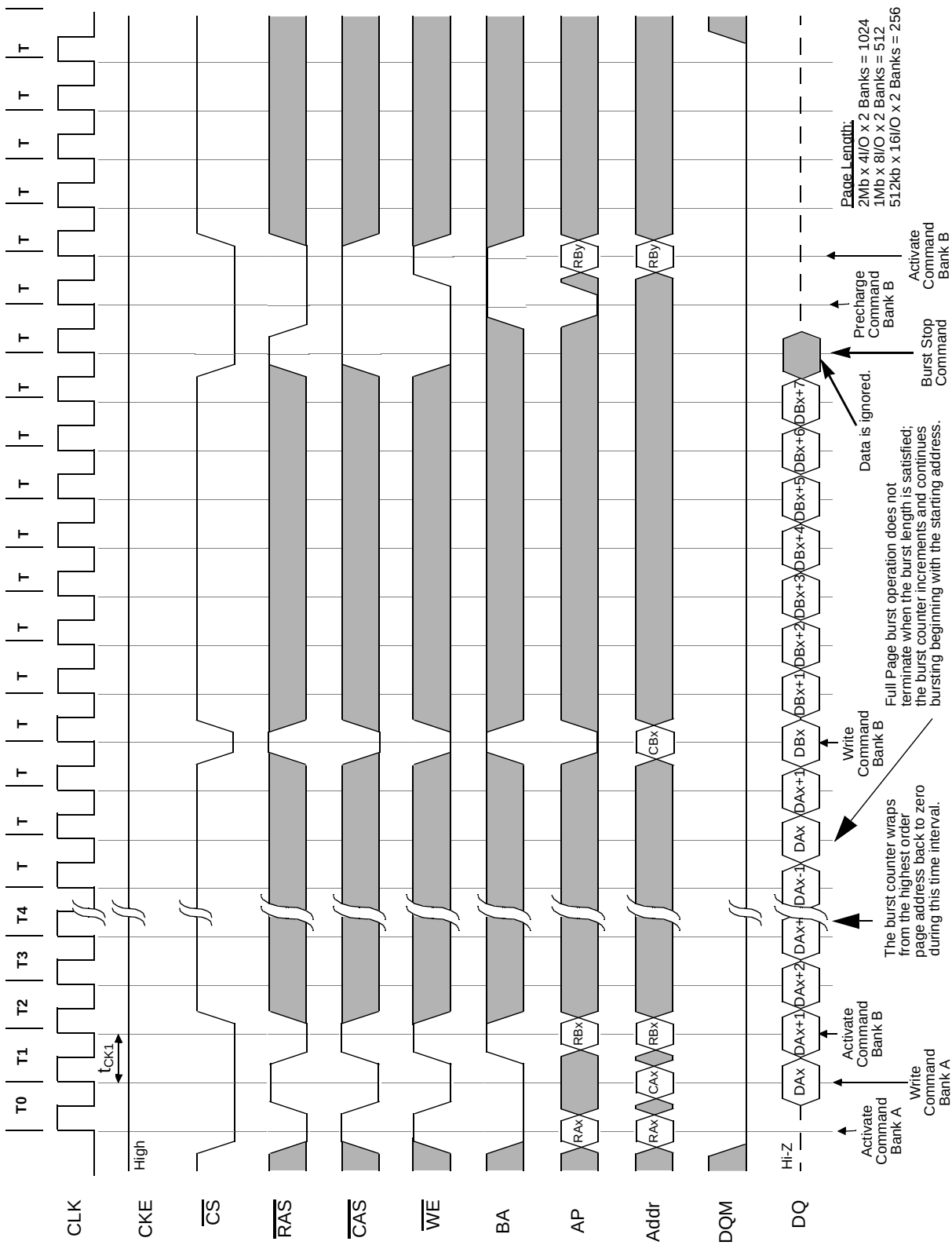






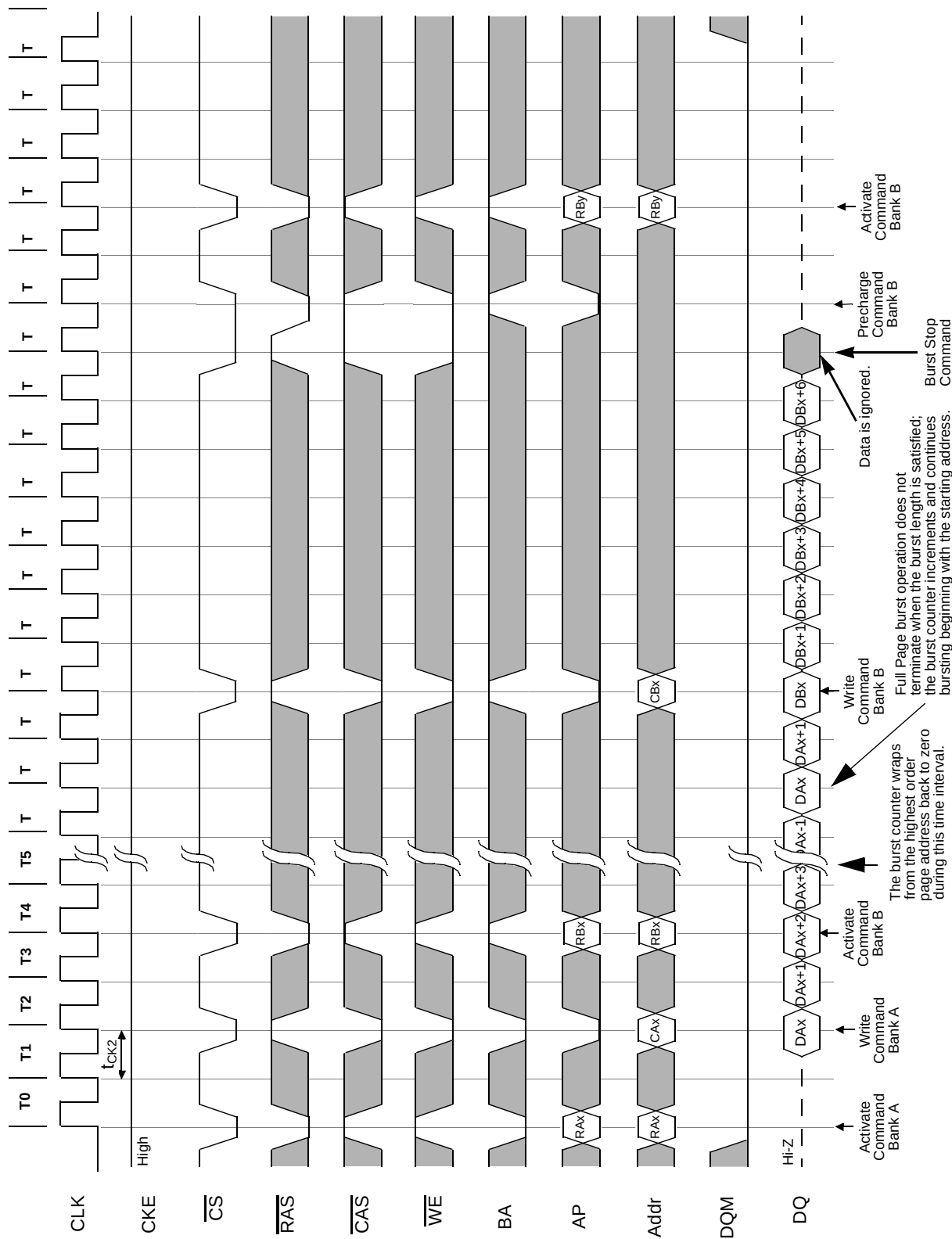
21.1 Full Page Write Cycle (1 of 3)

Burst Length = Full Page,  $\overline{\text{CAS}}$  Latency = 1



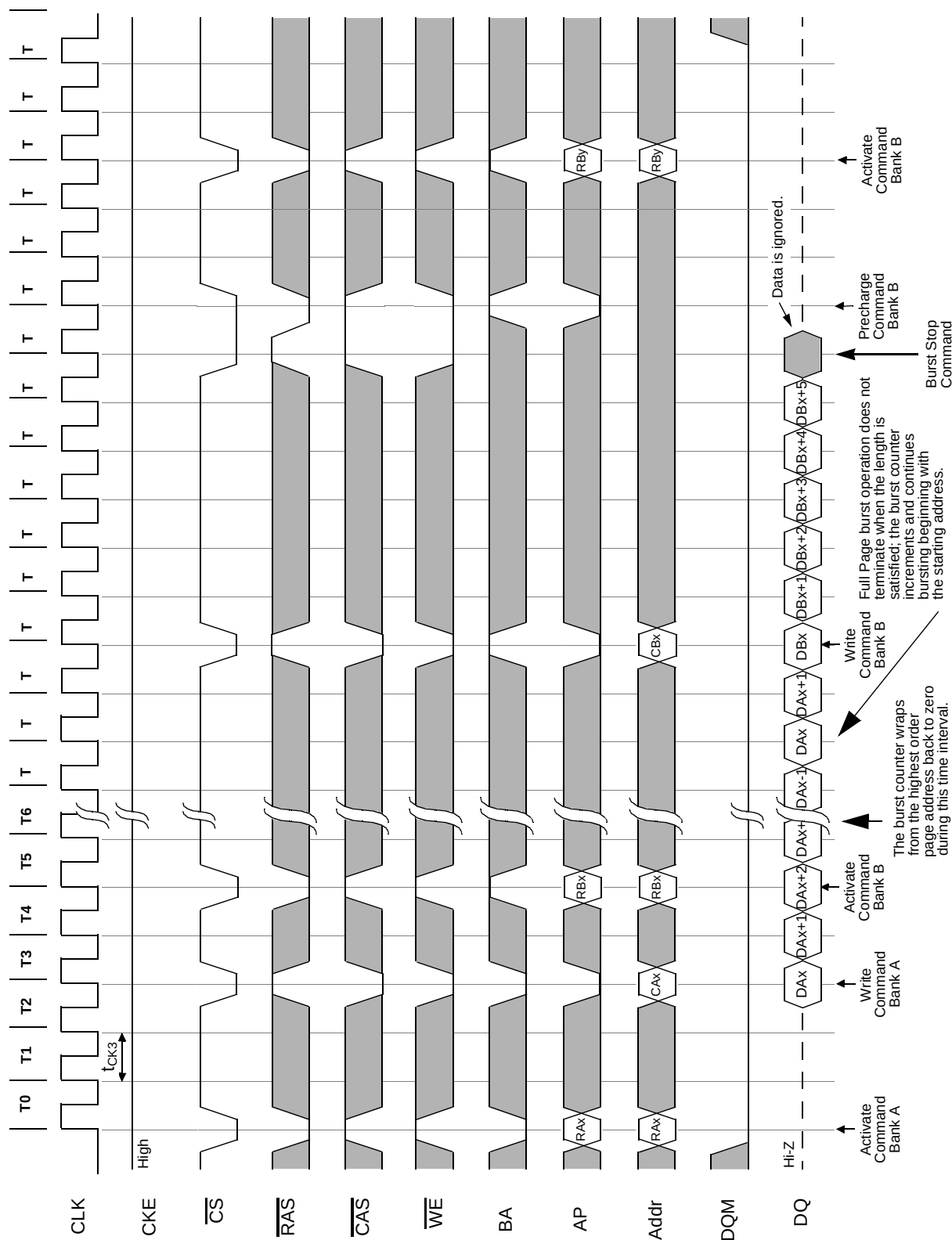
Burst Length = Full Page, CAS Latency = 2

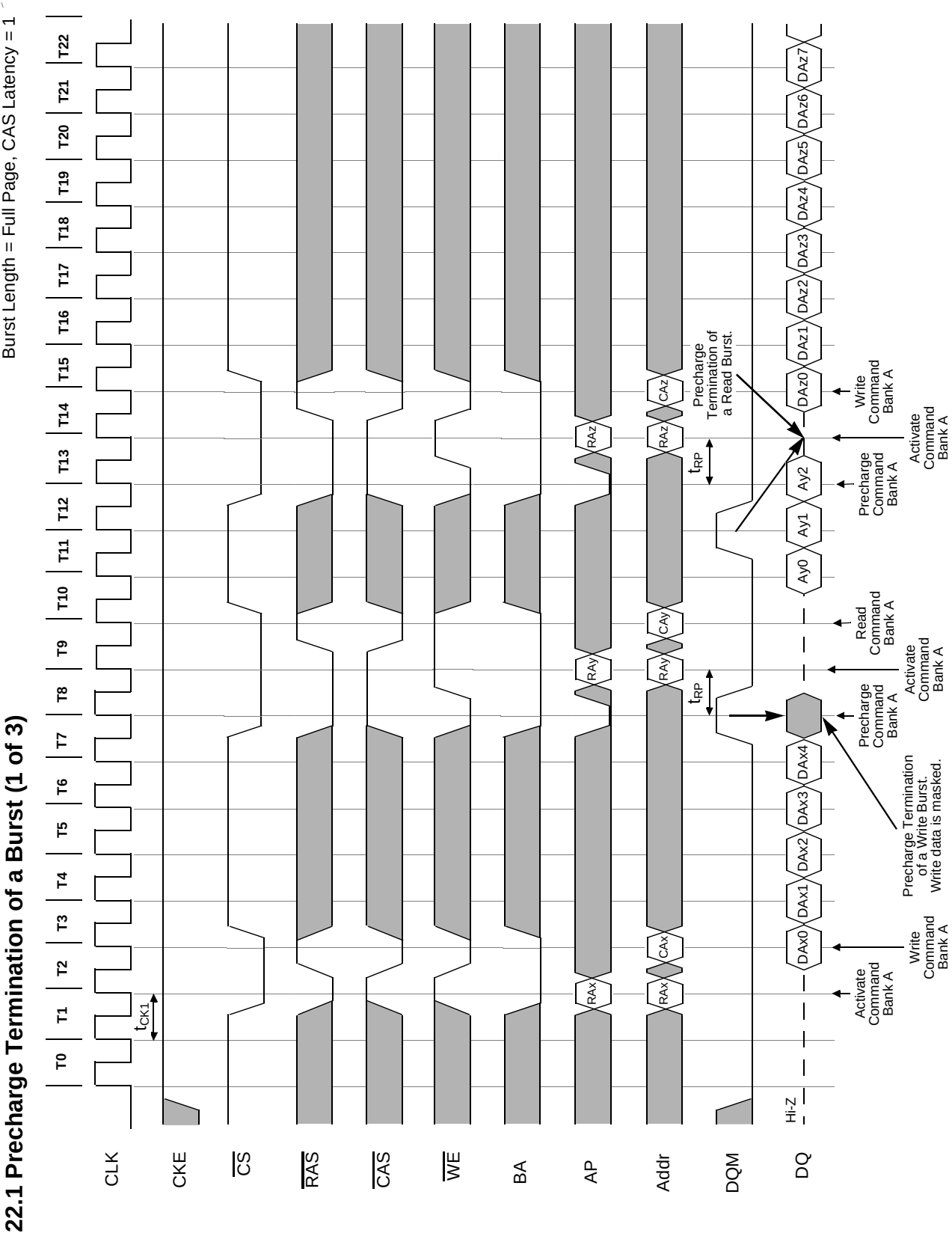
21.2 Full Page Write Cycle (2 of 3)



### 21.3.3 Full Page Write Cycle (3 of 3)

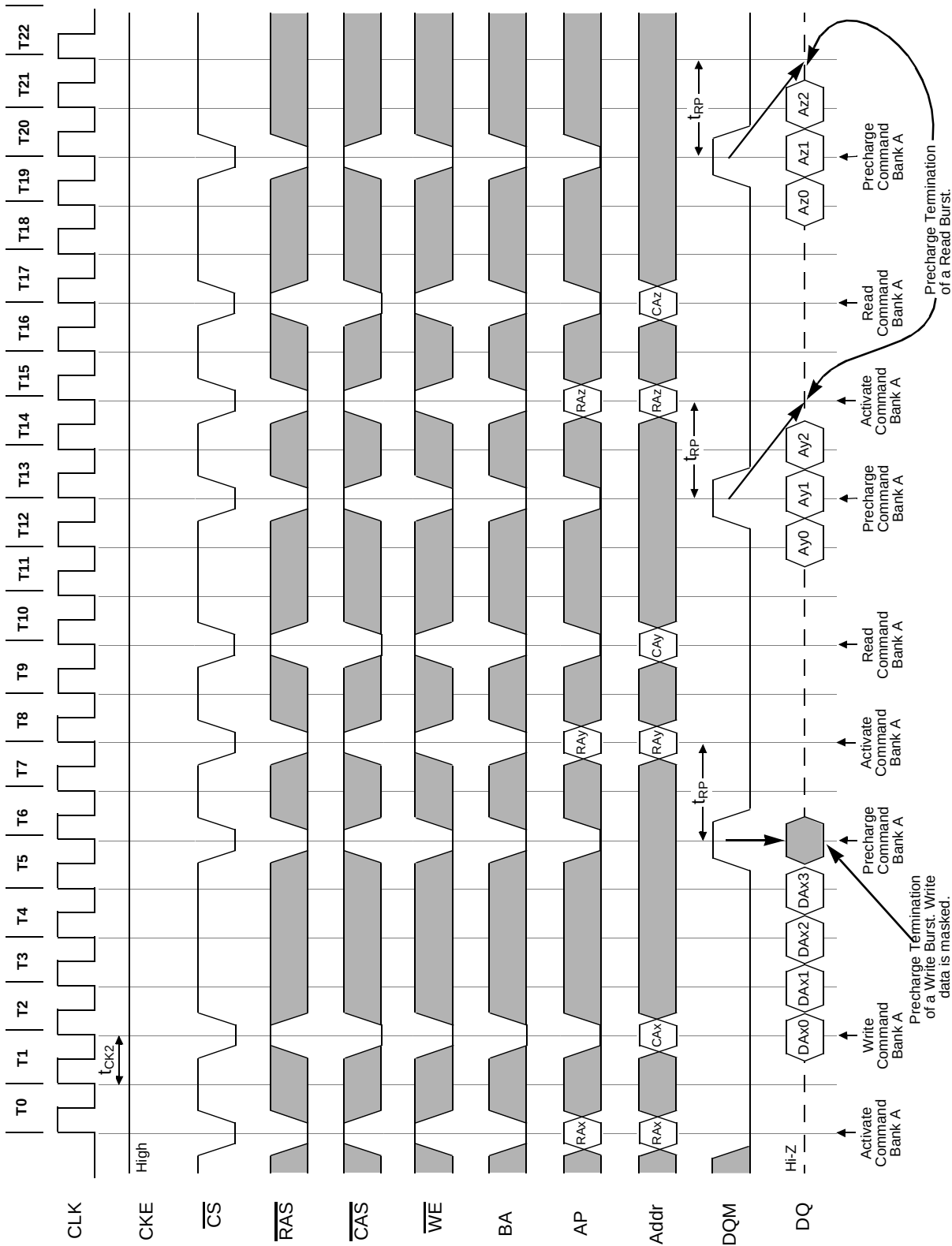
Burst Length = Full Page, CAS Latency = 3

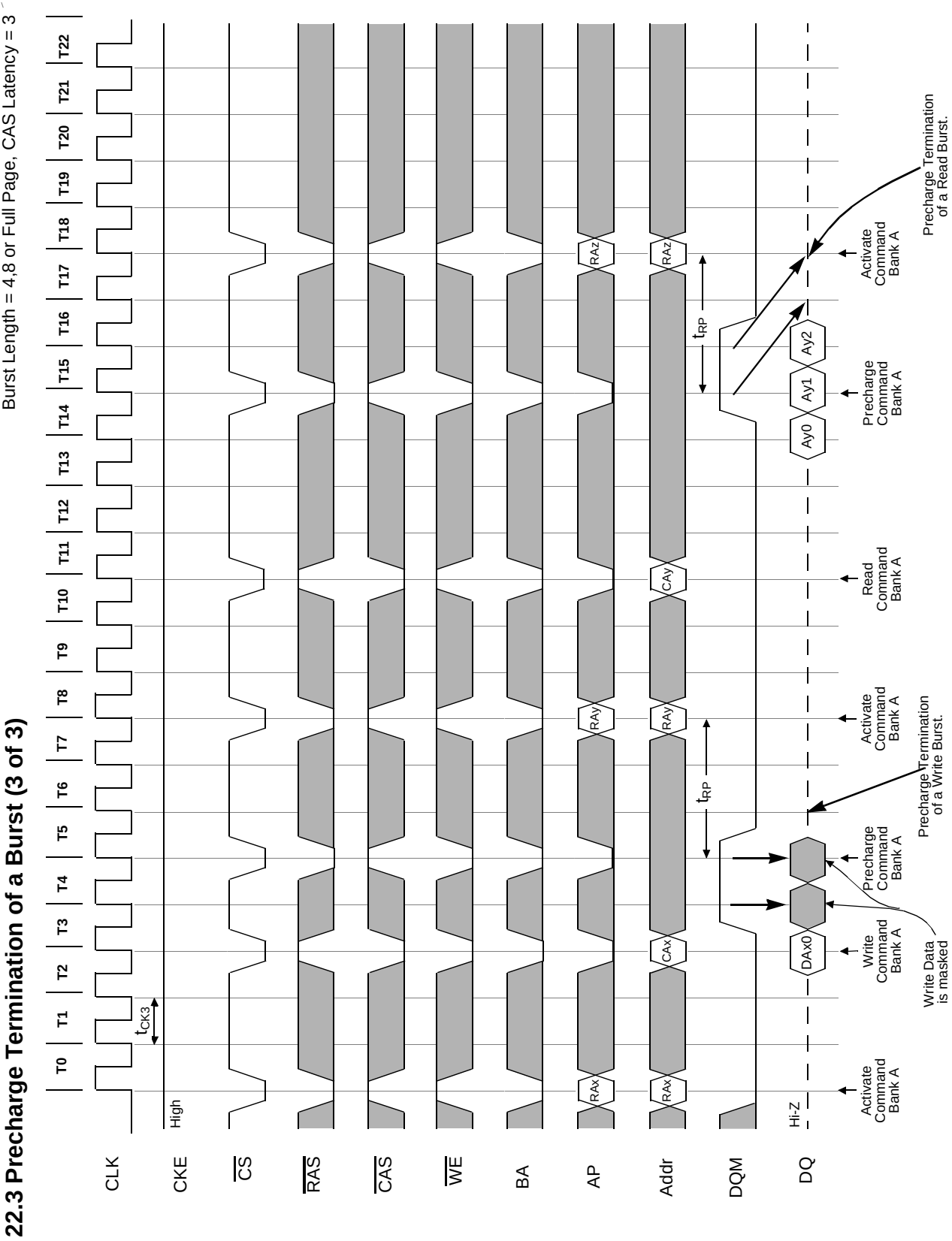




22.2 Precharge Termination of a Burst (2 of 3)

Burst Length = 8 or Full Page, CAS Latency = 2





### Complete List of Operation Commands

#### SDRAM FUNCTION TRUTH TABLE

| CURRENT STATE <sup>1</sup> | $\overline{CS}$ | $\overline{RAS}$ | $\overline{CAS}$ | $\overline{WE}$ | BS  | Addr  | ACTION                                             |
|----------------------------|-----------------|------------------|------------------|-----------------|-----|-------|----------------------------------------------------|
| Idle                       | H               | X                | X                | X               | X   | X     | NOP or Power Down                                  |
|                            | L               | H                | H                | H               | X   | X     | NOP                                                |
|                            | L               | H                | H                | L               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | H                | L                | X               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | H                | H               | BS  | RA    | Row (&Bank) Active; Latch Row Address              |
|                            | L               | L                | H                | L               | BS  | AP    | NOP <sup>4</sup>                                   |
|                            | L               | L                | L                | H               | X   | X     | Auto-Refresh or Self-Refresh <sup>5</sup>          |
|                            | L               | L                | L                | L               | Op- | Code  | Mode reg. Access <sup>5</sup>                      |
| Row Active                 | H               | X                | X                | X               | X   | X     | NOP                                                |
|                            | L               | H                | H                | X               | X   | X     | NOP                                                |
|                            | L               | H                | L                | H               | BS  | CA,AP | Begin Read; Latch CA; Determine AP                 |
|                            | L               | H                | L                | L               | BS  | CA,AP | Begin Write; Latch CA; Determine AP                |
|                            | L               | L                | H                | H               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | H                | L               | BS  | AP    | Precharge                                          |
|                            | L               | L                | L                | X               | X   | X     | ILLEGAL                                            |
| Read                       | H               | X                | X                | X               | X   | X     | NOP (Continue Burst to End;>Row Active)            |
|                            | L               | H                | H                | H               | X   | X     | NOP (Continue Burst to End;>Row Active)            |
|                            | L               | H                | H                | L               | BS  | X     | Burst Stop Command > Row Active                    |
|                            | L               | H                | L                | H               | BS  | CA,AP | Term Burst, New Read, Determine AP <sup>3</sup>    |
|                            | L               | H                | L                | L               | BS  | CA,AP | Term Burst, Start Write, Determine AP <sup>3</sup> |
|                            | L               | L                | H                | H               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | H                | L               | BS  | AP    | Term Burst, Precharge                              |
|                            | L               | L                | L                | X               | X   | X     | ILLEGAL                                            |
| Write                      | H               | X                | X                | X               | X   | X     | NOP (Continue Burst to End;>Row Active)            |
|                            | L               | H                | H                | H               | X   | X     | NOP (Continue Burst to End;>Row Active)            |
|                            | L               | H                | H                | L               | BS  | X     | Burst Stop Command > Row Active                    |
|                            | L               | H                | L                | H               | BS  | CA,AP | Term Burst, Start Read, Determine AP <sup>3</sup>  |
|                            | L               | H                | L                | L               | BS  | CA,AP | Term Burst, New Write, Determine AP <sup>3</sup>   |
|                            | L               | L                | H                | H               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | H                | L               | BS  | AP    | Term Burst, Precharge <sup>3</sup>                 |
|                            | L               | L                | L                | X               | X   | X     | ILLEGAL                                            |
| Read with Auto Precharge   | H               | X                | X                | X               | X   | X     | NOP (Continue Burst to End;> Precharge)            |
|                            | L               | H                | H                | H               | X   | X     | NOP (Continue Burst to End;> Precharge)            |
|                            | L               | H                | H                | L               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | H                | L                | H               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | H                | L                | L               | X   | X     | ILLEGAL                                            |
|                            | L               | L                | H                | H               | BS  | X     | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | H                | L               | BS  | AP    | ILLEGAL <sup>2</sup>                               |
|                            | L               | L                | L                | X               | X   | X     | ILLEGAL                                            |



**SDRAM FUNCTION TRUTH TABLE(continued)**

| CURRENT STATE <sup>1</sup> | $\overline{CS}$ | $\overline{RAS}$ | $\overline{CAS}$ | $\overline{WE}$ | $\overline{BS}$ | Addr | ACTION                                  |
|----------------------------|-----------------|------------------|------------------|-----------------|-----------------|------|-----------------------------------------|
| Write with Auto Precharge  | H               | X                | X                | X               | X               | X    | NOP (Continue Burst to End;> Precharge) |
|                            | L               | H                | H                | H               | X               | X    | NOP (Continue Burst to End;> Precharge) |
|                            | L               | H                | H                | L               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | H                | L                | H               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | H                | L                | L               | X               | X    | ILLEGAL                                 |
|                            | L               | L                | H                | H               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | L               | BS              | AP   | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | L                | X               | X               | X    | ILLEGAL                                 |
| Precharging                | H               | X                | X                | X               | X               | X    | NOP;> Idle after tRP                    |
|                            | L               | H                | H                | H               | X               | X    | NOP;> Idle after tRP                    |
|                            | L               | H                | H                | L               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | H                | L                | X               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | H               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | L               | BS              | AP   | NOP <sup>4</sup>                        |
|                            | L               | L                | L                | X               | X               | X    | ILLEGAL                                 |
| Row Activating             | H               | X                | X                | X               | X               | X    | NOP;> Row Active after tRCD             |
|                            | L               | H                | H                | H               | X               | X    | NOP;> Row Active after tRCD             |
|                            | L               | H                | H                | L               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | H                | L                | X               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | H               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | L               | BS              | AP   | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | L                | X               | X               | X    | ILLEGAL                                 |
| Write Recovering           | H               | X                | X                | X               | X               | X    | NOP                                     |
|                            | L               | H                | H                | H               | X               | X    | NOP                                     |
|                            | L               | H                | H                | L               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | H                | L                | X               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | H               | BS              | X    | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | H                | L               | BS              | AP   | ILLEGAL <sup>2</sup>                    |
|                            | L               | L                | L                | X               | X               | X    | ILLEGAL                                 |
| Refreshing                 | H               | X                | X                | X               | X               | X    | NOP;> Idle after tRC                    |
|                            | L               | H                | H                | X               | X               | X    | NOP;> Idle after tRC                    |
|                            | L               | H                | L                | X               | X               | X    | ILLEGAL                                 |
|                            | L               | L                | H                | X               | X               | X    | ILLEGAL                                 |
|                            | L               | L                | L                | X               | X               | X    | ILLEGAL                                 |
| Mode Register              | H               | X                | X                | X               | X               | X    | NOP                                     |
|                            | L               | H                | H                | H               | X               | X    | NOP                                     |
| Accessing                  | L               | H                | H                | L               | X               | X    | ILLEGAL                                 |
|                            | L               | H                | L                | X               | X               | X    | ILLEGAL                                 |
|                            | L               | L                | X                | X               | X               | X    | ILLEGAL                                 |

### CLOCK ENABLE (CKE) TRUTH TABLE:

| STATE(n)                                | CKE<br>n-1 | CKE<br>n | $\overline{CS}$ | $\overline{RAS}$ | $\overline{CAS}$ | $\overline{WE}$ | Addr | ACTION                                       |
|-----------------------------------------|------------|----------|-----------------|------------------|------------------|-----------------|------|----------------------------------------------|
| Self-Refresh <sup>6</sup>               | H          | X        | X               | X                | X                | X               | X    | INVALID                                      |
|                                         | L          | H        | H               | X                | X                | X               | X    | EXIT Self-Refresh, Idle after tRC            |
|                                         | L          | H        | L               | H                | H                | H               | X    | EXIT Self-Refresh, Idle after tRC            |
|                                         | L          | H        | L               | H                | H                | L               | X    | ILLEGAL                                      |
|                                         | L          | H        | L               | H                | L                | X               | X    | ILLEGAL                                      |
|                                         | L          | H        | L               | L                | X                | X               | X    | ILLEGAL                                      |
|                                         | L          | L        | X               | X                | X                | X               | X    | NOP (Maintain Self-Refresh)                  |
| Power-Down                              | H          | X        | X               | X                | X                | X               | X    | INVALID                                      |
|                                         | L          | H        | H               | X                | X                | X               | X    | EXIT Power-Down, > Idle.                     |
|                                         | L          | H        | L               | H                | H                | H               | X    | EXIT Power-Down, > Idle.                     |
|                                         | L          | H        | L               | H                | H                | L               | X    | ILLEGAL                                      |
|                                         | L          | H        | L               | H                | L                | X               | X    | ILLEGAL                                      |
|                                         | L          | H        | L               | L                | X                | X               | X    | ILLEGAL                                      |
|                                         | L          | L        | X               | X                | X                | X               | X    | NOP (Maintain Low-Power Mode)                |
| All. Banks<br>Idle <sup>7</sup>         | H          | H        | X               | X                | X                | X               | X    | Refer to the function truth table            |
|                                         | H          | L        | H               | X                | X                | X               | X    | Enter Power- Down                            |
|                                         | H          | L        | L               | H                | H                | H               | X    | Enter Power- Down                            |
|                                         | H          | L        | L               | H                | H                | L               | X    | ILLEGAL                                      |
|                                         | H          | L        | L               | H                | L                | X               | X    | ILLEGAL                                      |
|                                         | H          | L        | L               | L                | H                | X               | X    | ILLEGAL                                      |
|                                         | H          | L        | L               | L                | L                | H               | X    | Enter Self-Refresh                           |
|                                         | H          | L        | L               | L                | L                | L               | X    | ILLEGAL                                      |
|                                         | L          | L        | X               | X                | X                | X               | X    | NOP                                          |
| Any State<br>other than<br>listed above | H          | H        | X               | X                | X                | X               | X    | Refer to the function truth table            |
|                                         | H          | L        | X               | X                | X                | X               | X    | Begin Clock Suspend next cycle <sup>8</sup>  |
|                                         | L          | H        | X               | X                | X                | X               | X    | Exit Clock Suspend next cycle <sup>8</sup> . |
|                                         | L          | L        | X               | X                | X                | X               | X    | Maintain Clock Suspend.                      |

#### ABBREVIATIONS:

RA = Row Address

BS = Bank Address

CA = Column Address

AP = Auto Precharge

#### Notes for SDRAM function truth table :

1. Current State is state of the bank determined by BS. All entries assume that CKE was active (HIGH) during the preceding clock cycle.
2. Illegal to bank in specified state; Function may be legal in the bank indicated by BS, depending on the state of that bank.
3. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
4. NOP to bank precharging or in Idle state. May precharge bank(s) indicated by BS (and AP).
5. Illegal if any bank is not Idle.
6. CKE Low to High transition will re-enable CLK and other inputs asynchronously. A minimum setup time must be satisfied before any command other than EXIT.
7. Power-Down and Self-Refresh can be entered only from the All Banks Idle State.
8. Must be legal command as defined in the SDRAM function truth table.